Industrial PC Solutions

OASEM.





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MORE THAN 40 YEARS OF INNOVATION MADE IN ITALY

Since 1979, ASEM is a pioneer in the digital technology integrations between Information & Communication Technology and Industrial Automation. The performance, configurability, robustness, design and the high number of software features of ASEM products and systems, are the result of 40 years of experience in designing and producing solutions for the most demanding industrial applications. Exploring from the very

SOLUTIONS FOR THE OPEN AUTOMATION

Thanks to a constant focus on innovation and quality, combined with investments in human resources, technology and manufacturing assets, ASEM is one of the European emerging companies in the industrial automation market, providing systems and solutions that are entirely designed, engineered and produced inhouse. The company has been committed to anticipate customers' needs, convinced that machine builders should leave proprietary technologies, to embrace "Open & Standard" platforms, focusing on software application development. The integration of Information & Communication Technologies understood as an advanced, universal and non-proprietary digital system into machineries is know a need and it is no longer conceivable producing automatic machines that cannot be integrated into larger and more complex computer networks in which data and information can be

beginning the potential of Open & Standard technologies into Factory Automation, and leveraging the first-class know-how in developing hardware, firmware and software, ASEM has strengthen its leading position in Italy in the Industrial PCs, HMIs, remote assistance and control systems market.

shared. In Industry 4.0, digitalization and connectivity, together with a constantly changing demand for production and adaptability to the customised requirements of end users, find strong applicability in the concepts of smart factories, increasingly fast time-to-market, modelling and simulation of the entire production process. The revolution we are currently experiencing represents the transition from the paradigm of centralised to decentralised production enabled by technological evolution, which has overturned the conventional logic of production, with smart machines and/ or objects that communicate and manage processes independently, interacting with the real and virtual worlds.

LEADING THE INDUSTRY 4.0 REVOLUTION

ASEM has long been a leading player in Italy in the Industry 4.0 and it is now one of the few medium European companies, if not the only one, able of mastering on its own all driver technologies of the current 4th Industrial Revolution, from x86 (PC) and ARM hardware platforms, to the most widespread operating systems, to the most advanced software and communication technologies for the development of its own HMI and remote assistance platforms, data acquisition from the field (Industrial IoT) and their storage and management on databases cloud based, as well as having the skills and full knowledge of control platforms based on SoftPLC and SoftMotion. Designing UBIOUITY, an Internet-based software solution provinding remote access to automated machines and plants, ASEM was one the first companies understanding the value of Information and

VISION

Constantly innovating Factory Automation by combining the latest IT and automation technologies to provide "Open & Standard" technologies that simplify programming, monitoring and information exchange between machines, plants, and factories.

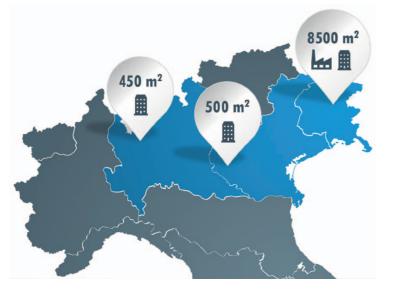




Communication Technologies applied to the Automation. In fact, ASEM was the first manufacturer that has integrated a remote assistance solution in operator panels, PACs systems based on ARM architecture, and later also in IPCs. The initiative, highly appreciated by the market, has allowed ASEM to create a new standard in Italy and Europe to which all competitors have adapted or are adapting. In 2013 ASEM also decided to face the most important multi-year investment in its history with the development of UNIQO, the crossplatform software platform "Full OPC UA" for the development of modern and responsive HMI and Industry 4.0 solutions.



ASEM A ROCKWELL **AUTOMATION COMPANY**



CONTINUITY IN TECHNOLOGICAL IDENTITY, FLEXIBILITY AND SALES APPROACH IN A **GLOBAL CONTEXT**

On April 30th 2020 100% of the ASEM shares were acquired by Rockwell Automation S.r.l., a company belonging to the American group Rockwell Automation Inc., primary player operating in the industrial automation sector with headquarters in Milwaukee, Wisconsin (USA), with over 23,500 employees worldwide, customers in over 100 countries and a 2020 turnover of 6,3 billion US Dollars. Given the complementarity in terms of products / systems and

in terms of commercial approach, ASEM will have the opportunity to grow faster and spread its products and solutions all over the world through the global network of the Rockwell Automation group. Within the group, all synergy possibilities will be deepened and implemented, and in addition to supplying its products in brandlabel to Rockwell Automation, ASEM will continue operating in the market independently, with its own team, its management and its sales organization in Italy

and abroad, keeping in absolute continuity the characteristics that you appreciated until today, such as flexibility, a wide range of configurable and customizable products / systems and software solutions based on "Open & Standard" technologies, fast delivery times and after-sales support.

200 + employees in 3 locations

ASEM Artegna - Headquarters Hardware/Software R&D

30% dedicated to **R&D**

System assembling

After Sales Services Board & System assembling

Testing Warehouse **ASEM Verona**

Sales

Software R&D Sales

ASEM Giussano

Software & System assembling Software & System Support

Testing e Warehouse Sales and Finance

Accounting and Control

A

A

A

ASEM WITH ROCKWELL AUTOMATION. FROM LOCAL NETWORK TO GLOBAL NETWORK



Rockwell Automation connect the imaginations of people with the potential of technology to expand what is humanly possible, making the world more productive and more sustainable.





MILESTONES



ASEM A ROCKWELL AUTOMATION COMPANY In April 2020, Rockwell Automation, a world leader in automation and control solutions, formalised the acquisition of ASEM in order to strengthen its product portfolio.

UNIQO

THE 4.0 HMI REVOLUTION IS A REALITY

ASEM releases the revolutionary UNIQO software platform, developed with cross-platform technologies compatible with ARM and x86 architectures and with Windows and Linux operating systems, always guaranteeing maximum performance. UNIQO fully supports the specification of the OPC UA standard and for this reason, it can be defined as a software platform "FULL OPC UA", for the development of modern, responsive HMI and Industry 4.0 solutions.

SPECIALIZING IN ELECTRONIC ENGINEERING

Founded in 1979 by Renzo Guerra, ASEM (Automazione Sistemi Elettronici Microcomputer) started as an engineering company designing and producing microprocessor-based industrial automation systems.



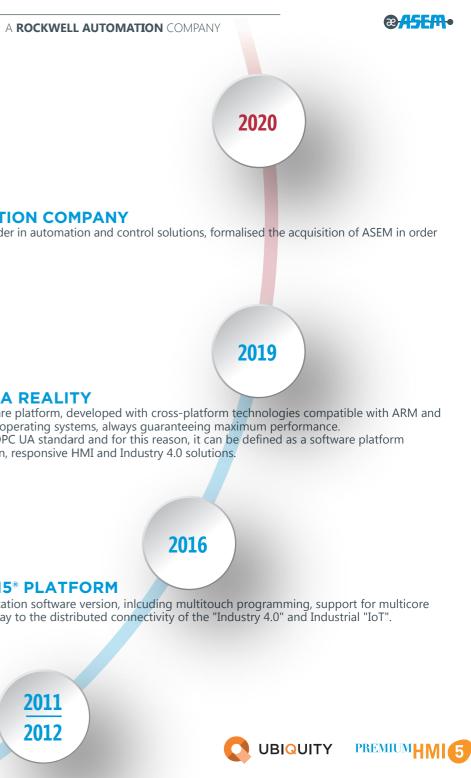
PLAYER OF THE IT WORLD

ASEM enters the IT market by designing and manufacturing interfaces and accessories for Personal Computers. As the only Italian company besides Olivetti[®], ASEM manufactures MS-DOS compatible PCs, gaining in the latest 80's the 6% of the Italian PC market, more than global companies like Apple® and Compaq®.

OPC UA IN THE PREMIUM HMI5® PLATFORM

ASEM releases the new Premium HMI 5 visualization software version, inlcuding multitouch programming, support for multicore processors and OPC UA protocol leading the way to the distributed connectivity of the "Industry 4.0" and Industrial "IoT".





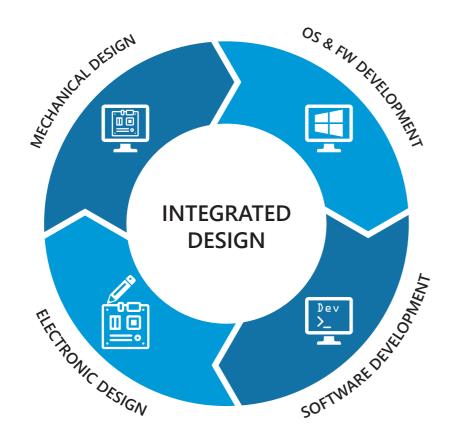
THE ERA OF SOFTWARE AND REMOTE ASSISTANCE

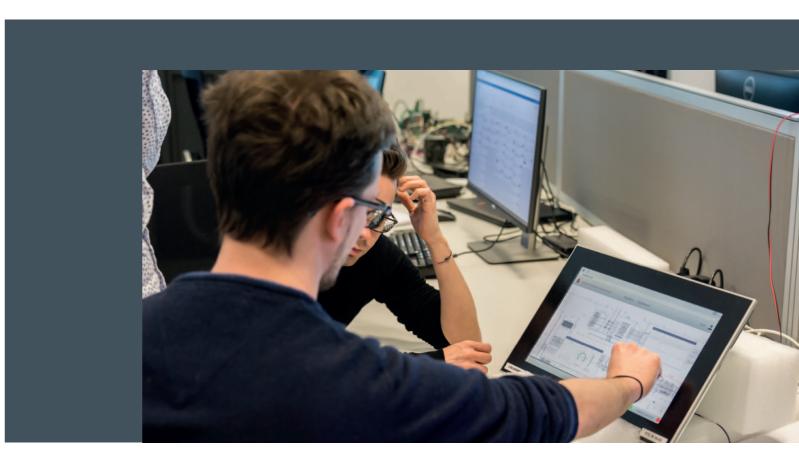
ASEM releases Premium HMI 3, the first visualization software with new features developed in-house. The company introduces the remote assistance platform UBIQUITY to remotely access automation devices via VPN. ASEM opens a second manufacturing facility dedicated to assembly and test of electronic boards and systems. ASEM opens a local software R&D office in Verona. ASEM starts designing and producing ARM-based HMIs, remote assistance and PAC systems.

THE SEAMLESS INTEGRATION **OF HARDWARE AND** SOFTWARE TECHNOLOGIES **IS KEY TO SUCCESS**

30% of ASEM human resources are dedicated to R&D. The team includes highly specialized engineers with complementary skills that cover all the electronic and mechanical design needs, as well as firmware and software development. The close collaboration with leading technology trendsetters and the continuous dialogue with customers drive the specifications of hardware, firmware, software and systems engineering for each single product. Thanks to the technological mastery of all system components and their perfect integration, ASEM designs performant, configurable, easy-to-use and reliable products for the most demanding industrial

environments. The different R&D teams work in synergy during the design process to ensure that hardware requirements and software features of each solution can be implemented in an integrated way. The long experience and the high skills of the R&D engineers make ASEM a reliable technological partner to support machine builders and system integrators in the fastchanging industrial automation market.





R&D SKILLS - HARDWARE, FIRMWARE AND OS IMAGES

MECHANICAL DESIGN

- 3D modeling and assembling simulation and mechanical couplings
- Analysis and thermal simulations for dissipation dimensioning
- Connected mechanics and electronics CAD for integrated engineering
- Close cooperation with the mechanical parts manufacturers
- Complete know how for each mechanical detail and production phase
- Easily customizable mechanical design

ELECTRONIC DESIGN

- Design of:
- Intel x86 based boards
- NXP ARM based boards
- Creation of PCB masters
- Internal EMC testing
- PCB design
- Signal integrity test through CAD simulation
- In-house laboratory for EMC compatibility testing



OPERATING SYSTEMS AND FIRMWARE DEVELOPMENT

- IPC Operating system engineering, testing and
- customization (Windows and Linux)
- Development, customisation and testing of BSPs for ARM platforms (Windows CE and Linux)
- IPC device drivers developement and testing
- IPC BIOS development and testing
- Real time system configuration and testing
- CODESYS SoftPLC device drivers and libraries development

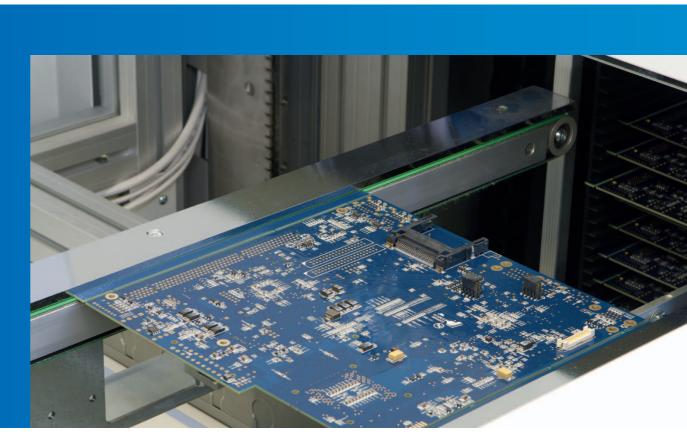
AGILE SOFTWARE DEVELOPMENT

- Automatic testing at all levels (Unit, Component, Integration, API, GUI)
- Automatic update of the latest released versions on dedicated websites with changelog and help
- Use of pair programming and coding standards
- Test driven development (TDD)
- Continuous Integration (CI)
- Frequent feature release on the market
- Kanban board for planning activities
- Eliminate waste and optimize processes

HIGH QUALITY PRODUCTION

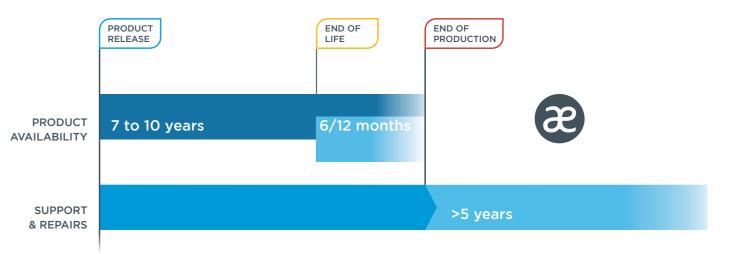
ASEM manufacturing plants comprise two modern industrial facilities covering a total area of 8.500 sqm. ASEM designs, engineers and manufactures electronic boards, products and systems internally. The decision to assemble electronic boards in its own Italian facility is in contrast with the industry trend to relocate electronics production activities in Eastern Europe and Far East, but the results in terms of quality and in terms of flexibility confirm the accuracy of the company's strategic decision, much appreciated by customers.





LONG-TERM AVAILABILITY

The full control of design and production processes and the close cooperation with technology trendsetters allow ASEM to ensure a 7/10 years life cycle of its systems and reparability of the same for at least 5 further years, with availability of spare parts. ASEM guarantees End of Life procedures lasting from 6 to 12 months for the Last Buy Order and deliveries.



The in-house assembly of electronic boards and a constant dialogue between operations' managers and the R&D engineers increase the sensitivity of electronics and mechanical designers towards production and test phases, with a consequent advantage of an increased reliability of the overall system. The electronic components are supplied by the major global manufacturers and are specifically selected to ensure a long life cycle of products. Mechanical parts are purchased from European suppliers selected with rigorous qualification procedures.

BOARD ASSEMBLY

- Admitting and warehouse control (Kardex)
- B.O.M. (Component Selection & Management)
- Pick & Place machine programming
- 3 complete SMT lines
- Pick & Place
- Re-melting furnaces (Ersa)
- Screen printers with integrated Post Print AOI (Ersa)
- Selective soldering machine for "Through Hole" technology
- Visual board inspection
- X-Ray Inspection
- Functional Tests
- Bed-of-nails board supply voltage test
- Functional testing of boards for eight hours (3 cycles)
- Active burn-in test (0°- 50° / 24H cycles)

SYSTEM ASSEMBLY

- B.O.M. (Component Selection & Management)
- System assembly (mechanical and electronic)
- Imaging of the operating system on mass storage
- Full functional test of final system
- Run-in TEST (8H)
- Final Control & Packaging



SOLUTIONS FOR A CONNECTED AND SMART FACTORY

ASEM designs and manufactures innovative and flexible solutions that enable the transformation of industrial plants into connected and Smart Factories, successfully meeting the challenges posed by the on going revolution. The use of Open & Standard, ARM and x86 technologies integrated with flexible and easy-to-use software development tools ensure maximum flexibility in the implementation of distributed automation architecture.

ASEM provides:

- Complete IPC portfolio and ARM embedded systems available in all form factor, high-performance, configurable and expandable to meet the needs of each application in the industrial automation field
- Visualisation systems based on innovative software UNIOO and Premium HMI, for the development of modern, responsive, ergonomic and and intuitive interfaces, conforming to the OPC UA standard and suitable for any automation device, significantly reducing development time
- Web Panel for HMI applications based on web thin clients
- Control systems based on the SoftPLC CODESYS, the modular, object-oriented, flexible development tool with which automation projects can be realised using IEC 61131 programming languages and support from real-time simulations The systems are equipped with 512kB of MRAM for saving the retentive variables and microtamping system in case of a power failure

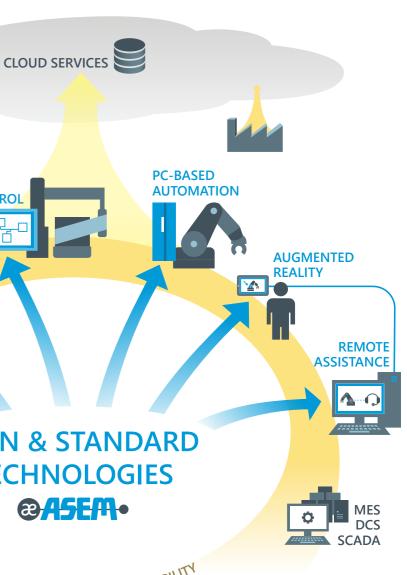
- Remote assistance solutions based on UBIQUITY, the software platform that enables the access to remote supervision and control systems (PLCs, inverters (PLCs, inverters, drives, etc.) through a VPN optimised for industrial communications UBIOUITY is included in all HMIs, PACs and IPCs with Microsoft Windows O.S. Nowadays UBIQUITY is one of the most complete and tested solutions in terms of architecture and functionality. It is also available as all-in-one router version
- IIoT Gateway for data colleting and sending them to public or private cloud infrastructures also available with integrated UBIQUITY remote assistance software
- Robust, reliable and well refined design industrial monitors, also with integrated RVL technology for the remotation of DVI-D and 2.0 USB signals

CONTROL VISUALIZATION EDGE COMPUTING **OPEN & STANDARD TECHNOLOGIES** @ASEM• OPC UA - INDUSTRIAL INTEROPERABILITY

> ASEM's integrated systems enable factories to become smart and adapt themselves to changing operating conditions and to sudden changes in planning. ASEM systems allow to:

- Collecting and monitoring production data thanks to full compatibility with the most popular fieldbus protocols and the OPC UA standard
- Sharing data within the factory (M2M, MES) through internet connectivity (also wireless)





- Processing data and optimising production processes at the edge of the network (Edge Computing)
- Cloud connection through IIoT Gateway for storing and sending data collected and and processed, managing communication interruptions (store and forward) and bidirectional communication between the cloud and the field system.

Industrial PC Solutions

ASEM IPCs The only IPCs with remote assistance solution integrated







Industrial PC & Monitor features



More than 25 years of æ Industrial PCs

The "x86" (PC) and ARM Cortex platform technologies represent the evolution towards open and standard platforms, replacing systems based on proprietary technology. These "Open & Standard" technologies are driving the process of technological convergence and digital

integration between ICT (Information and Communications Technology) and Industrial Automation. Since the 80's ASEM has been designing x86 technology and since more than 20 years has been leading the "Open Automation" in Italy designing, engineering and manufacturing "Open & Standard" systems for the Industrial Automation market.



A complete product range To satisfy different market needs, ASEM offers a wide range of industrial PCs including Panel IPCs with LCDs from 4.3" to 24" in 4:3

and Wide 16:9 aspect ratios, Arm Mounting IPCs with 15.6", 18.5", 21.5" and 24" Wide LCDs, Box IPCs with wall or DIN rail mounting and a complete range of Industrial

Panel Monitors with LCDs from 8.4" to 24" in 4:3 and 16:9 aspect ratios and Arm Mounting Monitors with LCDs from 15.6" to 24" in 16:9 aspect ratio.

Quality, reliability and performances

The mastery of hardware, firmware and system technologies and the long experience in mechanical design and engineering

steel or casted aluminium

have enabled ASEM to manufacture high quality and extremely reliable Industrial PCs and Monitors with strong attention to details and excellent value for money.

The expertise on heat dissipation methods has allowed ASEM to manufacture fanless systems integrating high performance and high power consumption quad core processors.



Chassis and Front Panels

Over the years, ASEM has gained considerable experience on materials and surface treatments to ensure electrical conductivity, shielding optimization and protection from external agents to its industrial PCs and monitors' chassis.

Chassis are made of galvanized

and are the result of an industrialization based on thermodynamic and fluid dynamic analysis aimed at a seamless integration of electronic boards and mechanical components. To meet the specific needs of food, chemical and pharmaceutical industries, some systems are designed and manufactured with stainless steel frames and chassis. One of the most important

details of Panel IPCs and Monitors are the front panels, designed to meet aesthetic, ergonomic and robustness requirements and at the same time ensure a protection grade up to IP69K or, with USB interfaces on the front, up to **IP66**

The ASEM standards include four front panel variants for Panel IPCs and monitors: Aluminium with resistive touchscreen, True Flat Aluminium with resistive

touchscreen, Stainless Steel True Flat with resistive touchscreen and Aluminuim True Flat with glass projected capacitive (P-CAP) Multi-touchscreen. Furthermore, for Aluminium and Aluminium True Flat Multitouch front panels, two new versions with minimized frame are available, in order to reduce encumbrance and

improve aesthetic results.



With a product life cycle of at least 7/10 years, ASEM designs Panel IPCs and monitors with the same cut-out (hole size needed for the installation) for each different LCD size to ensure interchangeability, without mechanical changes, among different families and compatibility with future families allowing to upgrade the Panel IPC or monitor even on machines on the field since many years.



Motherboards

The IPC's motherboards have microprocessors included in Intel® embedded roadmap, with a long life cycle guaranteed by the manufacturer. ASEM motherboards use different platform technologies with scalable



Operating Systems

Depending on microprocessor platform, ASEM ensures full compatibility of x86 systems with Win 32/64 Standard/ Embedded and Windows Embedded Compact 7 Pro operating systems and full



Fieldbuses

All x86 systems released by ASEM have the possibility to install fieldbuses (NETcore X)

boards, Master and Slave versions, that support the most spread industrial fieldbuses such as EtherCAT,





UPS and Power Supply Systems

To prevent noise and overvoltage, IPCs and monitors' power supplies have galvanic isolation. Industrial PCs based on x86 processors have the option to integrate on the power supply unit the UPS (Uninterruptible Power Supply) function with an external battery pack. The ARM based systems can integrate the MicroUPS function with supercapacitors.

Lake[™] series and ARM-based systems equipped with dual and guad core iMX6 processors.

Motherboards are designed to provide "all-in-one" integration of every possible function (for instance the touchscreen controller) and minimize cables and connectors in order to make systems more resistant to possible vibrations and shocks in industrial environments. 100% of the motherboards are subject to burn-in and functional tests, for 12 consecutive hours, in

dedicated climate chambers. All motherboards feature the ASEM System Identity, a nonvolatile storage for system identification data, as well as other useful customers' data for system traceability. One of the R&D teams is dedicated to BIOS and low level driver development for x86 platforms and to BSP (Board Support Package), boot loader and low-level drivers development for ARM Cortex platforms.

compatibility with the most popular Linux distributions. ARM Cortex A8 and A9 platforms support Windows Embedded Compact 7 Pro and Linux distributions assembled by ASEM. ASEM specialists can also

give support to implement a custom made image or develop customized embedded Win 32/64 and Linux images on specific customers request.

CANopen, Profibus, Profinet, MODBUS and EhterNet / IP.



Systems testing and certication

100% of the electronic boards are subject to burn-in and functional tests at a temperature range from systems are comply with UL 0° to 50° C for a minimum of 12 hours in special designed climatic chambers. All ASEM products are

compliant with EMC directives for emissions and immunity, the low voltage directive and the RoHS directive. Most products and certification and specific products are compliant with the ATEX directive.

Custom Solutions

The complete control of hardware, firmware and software technologies allows ASEM to realize custom systems for specific customer needs.



Light custom Solutions Custom-light services provide different levels of customization of ASEM standard products:

 \rightarrow removal or substitution of the ASEM trademark with a label showing the brand and/or logo of the customer; → customization of front film with silkscreen printing of client brands and/or logotype;

Mechanical light custom, such as: \rightarrow personalization of the shape and / or thickness of the front panel; → Customization of the layout Aesthetic light custom, such as: of the keyboard on the front panel;

> Electronic light custom, such as: solutions can be made in a → addition of communication relatively short time and low interfaces and / or modification of the standard configuration.

The customizations described do not involve any structural changes to standard products and meet the typical needs of OEMs and System Integrators who want to offer their own solutions to the market with a homogeneous representation of the brand. Custom-light volume production.

ASEM has set the electronic

ASEM Standards

and mechanical design standards for Panel IPC, Box **IPC and Monitor families** to guarantee maximum flexibility, higher safety and continuity to customers.



Power supply with integrated UPS (uninterruptible power supply)

 \rightarrow With external battery pack on the back of the system → With external standalone wall mounting battery pack

Specific standards for HT and MH/MHR families

Front panel available in four different variants

- → Aluminium with USB port → True Flat Aluminium with USB port
- → Stainless Steel True Flat → True Flat Aluminium with glass projected capacitive Multitouch screen



Full custom solutions

Custom-full services include the creation of new platforms and solutions based on customer specifications. ASEM does not normally sell the intellectual property of custom projects, as their realization is solely dedicated to ASEM serial production. Custom full services include the following development activities:

Mechanical custom-full, such

 \rightarrow creation of a new mechanical solution, also with plastic parts, that uses existing includes the design of electronic cards and/or motherboards:

Electronic custom full, such as: \rightarrow development of new motherboards and/or electronic cards:

Complete custom-full, such as:

 \rightarrow development of a new system or solution that

mechanical components as well as electronic boards.

Four variants of the front panel

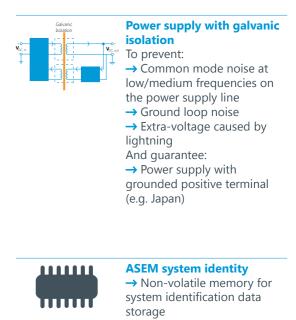


Aluminium with USB

True Flat Aluminium with USB port

as:

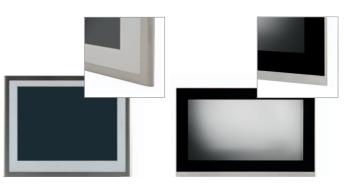






Cut-Out

A single cut-out for every LCD size to ensure interchangeability among HT panel IPCs families and the MH/MHR monitors family



Specific standars for QT and MQ families



Front panel available in two variants → Aluminium with resistive touchscreen

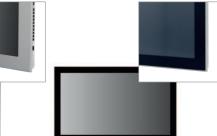




A single cut-out for every LCD size to ensure interchangeability among QT panel IPCs families, the MQ/ MOR monitors family and HMI Q, LP Q and RT Q ARM based families.

Two variants of the front panel





Aluminium

Aluminium & glass P-CAP Multitouch

Cut-out standard

The following grid includes the measures of the three different cut-out sets: "A" Cut-Out refers to ARM based HMIs, LPs and RTs; "HT" Cut-Out refers to panel IPC families HT, panel x86 PAC families LP and the industrial monitor family MH/MHR; the new "QT" Cut-Out refers to ARM based HMI Q, LP Q and RT Q families, to panel IPC families QT, panel x86 PAC families LP Q and the industrial monitor family MQ/MQR.

		"A" Cut-Out		"НТ" С	"HT" Cut-Out		"QT" Cut-Out	
	Ratio	L	н	L	н	L	н	
4.3"	16:9	131	86	-	-	-	-	
5.7"	4:3	164	134	-	-	-	-	
6.5"	4:3	-	-	192	167	-	-	
7" A	15:10	204	144	207	159	-	-	
7" B	15:10	197	140.5	197	141	197	141	
8.4"	4:3	243	179	230	190	-	-	
10.1"	16:10	285	193.5	277	196	256	174	
10.4"	4:3	283	219	280	225	-	-	
12.1"	4:3	313	249	315	250	-	-	
12.1"	16:10	313	215	315	218	301	203	
15"	4:3	378	294	370	295	-	-	
15.6"	16:9	410	255	410	255	388	238	
17"	5:4	-	-	435	335	-	-	
18.5"	16:9	-	-	480	300	453	275	
19"	5:4	-	-	470	368	-	-	
21.5"	16:9	-	-	559	347	520	312	
24"	16:9	-	-	620	382	576	345	

Software solutions for the industrial automation

Remote Assistance: UBIQUITY



In 2011 ASEM presented **UBIQUITY**, the innovative software platform for remote assistance. Designed for machine builders, the remote assistance solution UBIQUITY enables access to remote systems and their subnetworks as if they were connected with a cable. The software solution UBIQUITY enables the access to remote supervision and control systems and to the automation devices (PLC,

drive, etc), connected to the Ethernet and Serial subnetworks of the IPC/ operator terminal/controller, through a VPN (Virtual Private Network) based on proprietary technology optimized for industrial communication. UBIQUITY does not require

additional hardware and allows to operate in remote plants as if they were directly connected to your enterprise network.

Control: CODESYS



ASEM Programmable Automation Controllers base their PLC functionalities on the consolidated and widespread CODESYS SoftPLC of the German 3S, with a highly

efficient implementation of version 3.5 which guarantees the deterministic execution of PLC control logic with WinCE and Win 32/64 operating systems.



It enables technical support teams to solve any issue, eliminating the need for onsite assistance, dramatically reducing post-sale service costs.

This solution is particularly useful during machine setup and commissioning, to monitor remote applications, to modify and update software applications and remotely debug PLCs and other automation devices.



Starting from March 2016. **UBIQUITY** is installed on all ASEM IPCs, enhancing the value of every IPC with an integrated remote assistance solution.

CODESYS let the projects to be transferred between various operating systems and hardware platforms without the need to change the project code.

Visualization and Industry 4.0: UNIQO HMI



The UNIQO HMI platform is based on cross-platform technologies, allowing crosssectional applications on Windows and Linux operating systems. Also Android and iOS mobile operating systems will be supported in future, which run on x86 or ARM based hardware, always ensuring top performance. UNIQO HMI fully supports

the OPC UA standard specification, that allows to create dynamic client/server architectures, in which HMI systems alternately take the role of generator and user of a large range of information. In fact, with UNIQO HMI OPC UA can be used to acquire field data, for horizontal information exchange between machine and machine, for interfacing with MES/ERP business management systems and for interfacing with the cloud.

On a UNIQO HMI based system it is possible to share not only data, but also applications functionalities allowing an external OPC UA client to actively interact with all the project functions, such as user authorizations, recipes or even graphic resources of the screens.

UNIQO HMI projects are totally dynamic since everything that can be done at design time with the "Q STUDIO" environment, can also be done at runtime through default commands and/or through application logics written in C#. The "Q STUDIO" design environment also supports a so-called "Connected-Mode" function, that allows to connect to a running HMI, download the project and apply changes in "live", without arresting HMI operations. The changes made to the project are immediately updated, with no need for cost intensive machine stop or

cumbersome redesign of the project. They are saved with a sophisticated mechanism that allows at any time to turn back to previous conditions in complete safety.

With UNIQO HMI it is possible to create responsive interfaces with innovative graphic design tools that take advantage of the "container" concept, allowing to automatically arrange the objects inside in rows, columns, matrices, with full support to the gestures of multitouch interface. In UNIQO HMI, everything that is designed becomes an object, with immediate advantages in terms of modularity and reusability of applications that were developed according to these criteria.

Visualization: Premium HMI and PHMI Mobile



With Premium HMI software platform, ASEM has been providing valuable visualization systems appreciated for the quantity and quality of the functionalities available and the transversality of the platform, which makes it possible to use the sameproject both on HMI

solutions based on ARM or x86 hardware platforms (also with multicore architecture support), with WinCE or Win 32/64 Runtimes without any need to modify or change settings in the 'Premium HMI Studio' development tool.

Industrial IoT: IIoT Cloud Connector



IIoT Cloud Connector is the software solution specifically designed to **securely publish** relevant field data on cloud

databases for later analysis. IIoT Cloud Connector comes as an optional service of the ASEM HMI software



Multitouch and OPC UA

Premium HMI 5 supports Multitouch programming for Win 32/64 and WEC 7 systems with multicore processors and supports OPC UA protocol, leading the way to the distributed connectivity of the "Industry 4.0" and Industrial "IoT".

Premium HMI Mobile is

the App to view and interact with Premium HMI projects, via mobile devices (iOS and Android) connected to the enterprise Wi-Fi network. The new app provides mobile and multitouch support to the HMI project running on Machine Operator Panels/ Panel IPCs.

Premium HMI to extend the datalogging capabilities by easily interfacing with the cloud storage technology,

aiming to provide a secure and effective solution to the modern IIoT and Industry 4.0 application scenarios.

Product Portfolio

1. ARM based panel

The ARM based Panels, with Cortex A8 and A9 processors, are available with Microsoft Windows Embedded Compact 7 Pro or Linux operating systems. They include a wide range of 16 million colours TFT LED Backlight LCD screens, from 4.3" up to 18.5" with resistive touchscreen and Aluminium/True Flat Aluminium front Panels and True Flat Aluminium with glass projected capacitive Multitouch screen.

2. Panel IPCs

ASEM Panel IPCs are low consumption and high computing performance systems, with or without fans, based on Celeron and Core[™] i3, i5, i7 dual and quad core processors.

Available with TFT LCDs from 6.5" to 24" and aluminium, True Flat aluminium, True Flat stainless steel front panels and resistive touchscreen or True Flat aluminium front panels with glass projected capacitive Multitouch screen.





4. Box IPCs

ASEM provides a full range of Box IPCs based on Celeron, Core[™] i3, i5, i7 dual and quad core processors of the Intel® Bay Trail[™], Broadwell[™], Skylake[™] and Kaby Lake[™] platforms, and and they are suitable for wall or DIN rail mounting.



5. Arm Mounting IPCs

The Arm Mounting IPCs are compact, fanless, ergonomic and easy to install systems with a stylish design, that are easy to install and compatible with the most common mounting standards. Based on Intel[®] Bay Trail[™] platform with 15" TFT LCD or Intel[®] Broadwell[™] platform available with 15.6", 18.5", 21.5" and 24" TFT LED Backlight LCDs in a Full IP65 aluminium chassis.



6. Rack IPCs

19" 4U rack solutions with a wide range of configurations, motherboards, expansion slots and Intel[®] Xeon[™] and Core[™] i3, i5, i7 dual, quad and exa core processors up to Intel[®] Coffee Lake[™] platform.



3. Book Mounting IPCs

ASEM recently completed its Box IPC portfolio with a complete range of book mounting systems, combining performances, design, ergonomics and configurability. Based on ARM Cortex A9 or Intel[®] Apollo Lake[™], Bay Trail[™], Skylake[™] and Kaby Lake[™] platforms, they are supplied with a sturdy aluminium or plastic chassis, highly refined in every aesthetic and ergonomic detail.

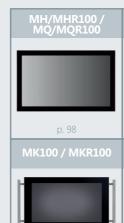


7. Industrial Monitors

The panel Industrial Monitors are available with LCDs from 8.4" to 24", with 4:3, 5:4 or Wide format, and four front panel variants.

Arm Mounting Monitors are compact, fanless, ergonomic and easy to install solutions, compatible with the most common mounting standards and are available with 15.6", 18.5", 21.5" and 24" TFT LCDs in a full IP65 aluminium chassis

MX200 features a stainless steel chassis and FullI IP69K protection grade. All the monitors are also available with integrated RVL technology which allows the transmission of DVI-D and USB 2.0 signals up to 100 meters.











Panel ARM based

ARM based Panels

The ARM based Panels, with Cortex A8 and A9 processors, are available with Microsoft Windows Embedded Compact 7 Pro or Linux operating systems.

They include a wide range of 16 million colours TFT LED Backlight LCD screens, from 4.3" up to 18.5" with resistive touchscreen and Aluminium or True Flat Aluminium front Panels and True Flat Aluminium with glass projected capacitive Multitouch screen.

RT25 Entry level ARM based Panels





USB 2.0 port, one serial RS232/422/485 interface with rear access, 1 GB DDR3 RAM, 256MB Nand-Flash and 4GB pseudo-SLC eMMC memory to save and manage application and project data.



• Highlights

- → "All in one" motherboard
- → ARM Cortex A8 processor (i.MX535)
- \rightarrow 4.3" and 7" LCDs in Wide aspect ratio
- \rightarrow 24 VDC power supply input
- → CE, cULus LISTED (508) certifications





The RT25 family is available with 16 million colours LED Backlight TFT LCDs, 4.3" and 7" in Wide aspect ratio, with aluminium or aluminium True flat front panels and 4 wires resistive touchscreen. RT25 systems have a 24 VDC power supply input.

→ Microsoft Windows Embedded Compact 7 Pro or Linux Yocto operating system → Fanless ARM based panel IPC with 0°C÷50°C operating temperature

RT30 ARM Cortex A8 based panel from 5.7" to 15.6"W



The ARM based Panel IPC family RT30 is based on the ARM Cortex A8 1GHz/800MHz project data and a removable processor (i.MX535/i.MX537). The "all in one" motherboard provides one Ethernet 10/100Mbps port, one Ethernet 100Mbps port, two USB 2.0 ports, one serial RS232/422/485 interface with rear access, 1 GB DDR3 RAM, 256MB Nand-Flash for the operating system and the runtimes, 4GB pseudo-SLC

eMMC memory to save and manage application and SDHC memory slot. The RT30/31 family is available with 16 million colours LED Backlight TFT LCDs from 5.7" to 15.6", in 4:3 supercapacitors. and Wide aspect ratio, with aluminium or aluminium True flat front panels and 4 or 5 wires resistive touchscreen. All version with Wide LCDs are also available with aluminium

and glass TrueFlat Capacitive front panels, with projected capacitive touchscreen. RT30/31 systems have a 24 VDC power supply input and optionally an integrated MicroUPS based on

- Highlights → "All in one" motherboard
- → Microsoft Windows Embedded Compact 7 Pro or Linux Yocto operating system
- → ARM Cortex A8 processor (i.MX535/i.MX537)
- \rightarrow Fanless ARM based panel IPC with 0°C÷50°C operating temperature
- → 5.7", 8.4", 10.4", 12.1" and 15" LCDs in 4:3 aspect ratio, 7", 10.1", 12.1" and 15.6" LCDs in Wide aspect ratio
- → Integrated MicroUPS with supercapacitors (optional)
- → CE, cULus LISTED (508) certifications
- → ATEX area 2/22 certification (only RT30)

Technical Data

	RT25	RT25-TF	RT30	RT30-TF	RT30-TFC				
O.S. AVAILABLE		Micro	osoft Windows Er	mbedded Compa	ct 7 Pro with Datalight Reliance Nitro file system				
		Embedded Linux distribution based on Yocto Project							
LED backlight TFT LCD	4.3" W - 480x272 7" W - 800x480				7" W - 800x480 10.1" W - 1280x800 12.1" W - 1280x800 15.6" W - 1366x768				
TOUCHSCREEN	Resisti	ve 4 wires	Resistive 4 wires for 5.7" and 7" Resistive 5 wires for other sizes		P-CAP Projective Capacitive				
FRONT PANEL	Aluminium	True Flat Aluminium	Aluminium		True Flat Aluminium				
PROTECTION GRADE				IP65, Enclos	sure type 4x - frontal				
PROCESSOR		ARM Cortex A8 processor i.MX535 1 GHz							
SYSTEM MEMORY - RAM				1 GB wit	h DDR3 soldered				
MASS STORAGE		4			ash for operating system and runtime n organization for projects and applications				
		-			1 x Slot SD/SDHC v2.0				
LAN		rnet 100 Mbps RJ45)			LAN1 Ethernet 100 Mbps (RJ45) LAN2 Ethernet 10/100 Mbps (RJ45)				
USB	1 x USB 2.0	0 rear (Type-A)			2 x USB 2.0 rear (Type-A)				
SERIAL				1 x RS-232	2/422/485 (DB15M)				
FIELDBUS					-				
POWER				24VD0	C (18 ÷ 36VDC)				
SUPPLY INPUT		-	Backup for microinterruption, max 500ms, with supercapacitors (optional)						
OPERATING TEMPERATURE		0°C÷50°C							
APPROVALS	CE, cULus	LISTED (508)	CE, cULus LISTED (508), ATEX zone 22, cat 3D		CE, cULus LISTED (508), ATEX zone 2/22, cat 3D				





RT35 / RT35Q Panel ARM Cortex A9 multicore based



The ARM based Panel IPC family RT35-RT35Q is based on the ARM Cortex A9 1GHz multicore processor (i.MX6 DualLite). The "all in one" motherboard provides one Gigabit Ethernet port, one USB 2.0 ports and a serial RS232/422/485 interface with rear access, 1 GB DDR3 RAM

and 4 GB Pseudo-SLC eMMC memory. The RT35Q family is available

with the new front panels with minimized frame, 16 million colours LED Backlight TFT LCDs from 7" to 12.1", in Wide aspect ratio, with aluminium front panel and a 4 or 5 wires resistive touchscreen, or

aluminium and glass TrueFlat Multitouch front panels, with projected capacitive touchscreen. The RT35 family is available with 16 million colours LED Backlight TFT LCDs from 7" to 12.1", in 4:3 and Wide aspect ratio, with aluminium or aluminium True flat front

panels, 4 or 5 wires resistive touchscreen.

All versions with Wide LCDs are also available with aluminium and glass TrueFlat Multitouch front panels, with projected capacitive touchscreen. RT35-RT35Q systems have an isolated 24 VDC power supply input.

→ "All in one" motherboard

• Highlights

- → Microsoft Windows Embedded Compact 7 Pro or Linux Yocto operating system
- → ARM Cortex A9 (i.MX6 DualLite) processor
- \rightarrow Fanless IPC with 0°C÷50°C operating temperature
- → 8.4", 10.4", 12.1" LCDs in 4:3 aspect ratio and 7", 10.1" and 12.1" LCDs in Wide aspect ratio
- → Isolated 24 VDC power supply input
- → CE, cULus LISTED (61010) certifications
- → ATEX area 2/22 certification (only RT35)

Gallery



Technical data

	RT35Q	RT35Q-TFM	RT35	RT35-TF	RT35-TFM			
O.S. AVAILABLE	1	Vindows Embedded Con	npact 7 Pro with Datalight	t Reliance Nitro file syste	m			
		Embedded Linux distribution based on Yocto Project						
PROCESSOR		ARM Cortex A9 1GHz i.MX6 DualLite						
SYSTEM MEMORY - RAM		1 GB DDR3 soldered on board						
MASS STORAGE			4 GB eMMC pseudo-SLC					
LED backlight TFT LCD	7" W - 800x480 10.1" W - 1280x800 12.1" W- 1280x800		7" W - 800x480 8.4" - 800x600 10.1" W - 1280x800 10.4" - 800x600 12.1" - 800x600 12.1" - 1024x768 12.1" W- 1280x800		7" W - 800x480 10.1" W - 1280x800 12.1" W- 1280x800			
CUT-OUT	(ΣŢ		А				
TOUCHSCREEN	Resistive 4 / 5 wires	P-CAP Multitouch	Resistive 4	4 / 5 wires	P-CAP Multitouch			
FRONT PANEL	Aluminium	True Flat Aluminium	Aluminium	True Flat	Aluminium			
PROTECTION GRADE		IP	65, Enclosure type 4x - fro	ont				
INTERFACES		1 x l	LAN 10/100/1000 Mbps (I	RJ45)				
			1 x USB 2.0 rear (Type-A)	1				
		1	1 x RS232/422/485 (DB9N	1)				
POWER SUPPLY INPUT		2	4VDC (18÷32VDC) isolate	ed				
OPERATING TEMPERATURE			0°C÷50°C					
APPROVALS	CE, cULus L	ISTED 61010	CE, cULus LISTED CE, cULus LISTED 6100 61010, ATEX zone 2/22, cat 3 ATEX zone 22, cat 3D					





RT40 / RT40Q Panel ARM Cortex A9 multicore based



The ARM based Panel IPC family RT40-RT40Q is based on the ARM Cortex A9 1GHz multicore processor (i.MX6 DualLite). The "all in one" motherboard provides two Gigabit Ethernet ports, two USB 2.0 ports, a serial RS232/422/485 interface with rear access, 1 GB DDR3 RAM, 8GB Pseudo-SLC eMMC memory and a slot

for a removable MicroSD with rear access. Optionally, an additional RS485 or CAN serial port is available. The RT40Q family is available with the new front panels with minimized frame, 16 million colours LED Backlight TFT LCDs from 7" to 18.5", in Wide aspect ratio, with aluminium aspect ratio, with aluminium front panel and a 4 or 5 wires resistive touchscreen, or

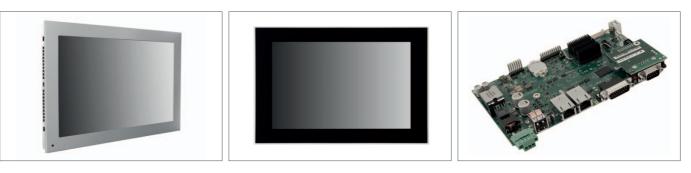
aluminium and glass TrueFlat Multitouch front panels, with projected capacitive touchscreen.

The RT40 family is available with 16 million colours LED Backlight TFT LCDs from 7" to 15.6", in 4:3, 5:4 and Wide or aluminium True flat front panels, 4 or 5 wires resistive touchscreen.

All versions with Wide LCDs are also available with aluminium and glass TrueFlat Multitouch front panels, with projected capacitive touchscreen. RT40 systems have an isolated

24 VDC power supply input.

Gallery



Technical data

	RT40Q	RT40Q-TFM	RT40	RT40-TF	RT40-TFM			
O.S. AVAILABLE	١	Vindows Embedded Con	edded Compact 7 Pro with Datalight Reliance Nitro file system					
		Embedded Li	inux distribution based or	n Yocto Project				
PROCESSOR		ARM Cortex A9 1GHz i.MX6 DualLite						
SYSTEM MEMORY - RAM		1 GB DDR3 soldered on board						
MASS STORAGE			8 GB eMMC Pseudo-SLC	•				
		1x micros	SD slot onboard with exte	rnal access				
LED backlight TFT LCD	7" W - 800x480 10.1" W - 1280x800 12.1" W- 1280x800 15.6" W - 1366x768 18.5" W - 1366x768		7" W - 800x480 8.4" - 800x600 10.1" W - 1280x800 10.4" - 800x600 12.1" - 800x600 12.1" - 1024x768 12.1" W - 1280x800 15.0" - 1024x768 15.6" W - 1366x768		7" W - 800x480 10.1" W - 1280x800 12.1" W- 1280x800 15.6" W - 1366x768			
CUT-OUT	(2T		А				
TOUCHSCREEN	Resistive 4 / 5 wires	P-CAP Multitouch	Resistive	4 / 5 wires	P-CAP Multitouch			
FRONT PANEL	Aluminium	True Flat Aluminium	Aluminium	True Flat	Aluminium			
PROTECTION GRADE		IP	65, Enclosure type 4x - fro	ont				
INTERFACES		2 x	LAN 10/100/1000 Mbps (I	RJ45)				
			2 x USB 2.0 rear (Type-A))				
		1	x RS232/422/485 (DB15)	(IV				
ADDITIONAL INTERFACES		1 x RS48	5 isolated (DB9M) with ter	rminations				
		1 x CAN isol	ated channel (DB9M) and	terminations				
		1	x Wireless/Modem adapt	ter				
POWER SUPPLY INPUT	24VDC (18 ÷ 36VDC) isolated							
OPERATING TEMPERATURE	0°C÷50°C							
APPROVALS	CE, cULus LI	STED (61010)	CE, cULus LISTED (61010), ATEX zone 22, cat 3D		ISTED (61010), 2/22, cat 3D			



• Highlights

- → "All in one" motherboard
- → Microsoft Windows Embedded Compact 7 Pro or Linux Yocto operating system
- → ARM Cortex A9 (i.MX6 DualLite) processor
- \rightarrow Fanless IPC with 0°C÷50°C operating temperature
- → 8.4", 10.4", 12.1" and 15" LCDs in 4:3 aspect ratio, 17" and 19" LCDs in 5:4 aspect ratio, 7", 10.1", 12.1", 15.6", 18.5", 21.5" and 24" LCDs in Wide aspect ratio
- → Isolated 24 VDC power supply input
- → CE, cULus LISTED (61010) certifications
- \rightarrow ATEX area 2/22 certification (only RT40)



Panel IPCs

ASEM Panel IPCs are low consumption and high computing performance systems, with or without fans, based on Celeron and Core™ i3, i5, i7 dual and quad core processors. Available with TFT LCDs from 6.5" to 24" and aluminium, True Flat aluminium, True Flat stainless steel front panels and resistive touchscreen or True Flat aluminium front panels with glass projected capacitive Multitouch screen.



HT2150 / QT2150 Entry level Intel[®] Bay Trail[™] based fanless panel IPCs



The fanless Panel IPC families HT2150 and QT2150 are entry-level systems, available with small LCD sizes, that offer mSATA connector for SATA an excellent performance/ price ratio. They are based on the Celeron J1900 2GHz guad core 64 bit processor of the Intel[®] Bay Trail[™] System On Chip (SoC) platform. The "all in one" motherboard provides two Ethernet 10/100/1000Mbps ports, that support "Jumbo Frame" and "Wake on Lan" functionalities,

a USB 3.0 port, a USB 2.0 port and a SATA II CFast slot with rear external access, an II SSD, up to 8 GB RAM with one DDR3 SODIMM module and an internal connector for additional interfaces. The QT2150 family is available with the new front panels with aspect ratio, with aluminium minimized frame, 16 million colours LED Backlight TFT LCDs from 7" to 15.6", in 4:3 and Wide aspect ratio, with aluminium front panel and a 5 versions with Wide LCDs are

wires resistive touchscreen, or aluminium and glass TrueFlat Multitouch front panels, with projected capacitive touchscreen. The HT2150 family is available with 16 million colours LED Backlight TFT LCDs from 6.5" to 15.6", in 4:3 and Wide or aluminium True flat front panels, 5 wires resistive touchscreen and an additional USB 2.0 port on front. All

also available with aluminium and glass TrueFlat Multitouch front panels, with projected capacitive touchscreen. HT2150/QT2150 systems have an isolated 24 VDC power supply input and optionally an integrated UPS with external battery pack. The systems are available in two versions, the SL with a reduced depth and the S0 with the possibility to install additional interfaces.



Add-On boards



Position A

- → 2 x RS232 → 1/2 x USB 2.0
- → Wi-Fi/Bluetooth/Modem

Technical data

	QT2150	QT2150-TFM	HT2150	HT2150-TF	HT2150-TFM		
LED backlight TFT LCD	10.1" W - 12.1" W -	300x480 1280x800 1280x800 1366x768	6.5" - 6 7" W - 4 8.4" - 8 10.1" W - 10.4" - 1 12.1" - 1 12.1" W - 15.0" - 1 15.6" W -	7" W - 800x480 10.1" W - 1280x800 12.1" W - 1280x800 15.6" W - 1366x768			
CUT-OUT	C	2T		HT			
FRONT USB		-	1 x USB 2.0, front,	protected (Type-A)	-		
TOUCHSCREEN	Resistive 5 wires	P-CAP Multitouch	Resistive	e 5 wires	P-CAP Multitouch		
FRONT PANEL	Aluminium	True Flat Aluminium	Aluminium	True Flat	Aluminium		
PROTECTION GRADE			IP65 - frontal				
PROCESSOR		Intel [®] Celeron J1900 2.0)Ghz, 4 cores / 4 threads,	2MB L2 cache, soldered			
VIDEO CONTROLLER	Intel [®] HD Graphic	s integrated in microproce	essor, 688MHz Clock 854N	/Hz Turbo, LVDS 8bit/colo	our digital interface		
SYSTEM MEMORY - RAM		1GB or 2GB or	4GB or 8GB (1 x SODIMM	DDR3 module)			
MASS STORAGE	1 bootable CFast SATA II slot onboard with external access 1 x onboard connector for direct insertion of mSATA SSD SATA II						
LAN	2 x LAN 10/100/1000Mbps (RJ45 - 2 x Intel [®] I210)						
USB			1 x USB 3.0 rear (Type-A) 1 x USB 2.0 rear (Type-A)				
ADD-ON INTERFACES		1 x RS232/42	22/485 (DB15M)+ 1 x USB	3 2.0 (Type-A)			
(only for S0, max 1)		1 x RS232/422/48	35 (DB15M) isolated + 1 x	uSB 2.0 (Type-A)			
			2 x RS232 (DB9M)				
			1 x USB 2.0 (Type-A)				
			2 x USB 2.0 (Type -A)				
			.000Mbps (RJ45 - Intel® I2	,			
	1 x NETcor	e X fieldbus boards for Etl			n protocols		
			i and Bluetooth/Modem /	I			
POWER SUPPLY INPUT			4VDC (18÷32VDC) isolate				
POWER SUPPLY OPTIONS	UPS with external battery pack Kit for ATX mode power supply						
O.S. CERTIFIED	Microsoft Windows 7 Pro/Ultimate 32/64 bit, Microsoft Windows Embedded Standard 7E/7P 32/64 bit, Microsoft Windows 8.1 Industry Pro 32/64 bit, Microsoft Windows 10 IoT Enterprise 2016/2019 64 bit						
OPERATING TEMPERATURE	0°C÷50°C						
APPROVALS			CE, cULus LISTED (61010)				



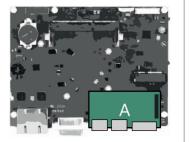
• Highlights

- → UBIQUITY remote assistance software providing remote access to the system
- → Support to 32 or 64 bit operating systems
- → "All in one" motherboard
- → High performance Intel[®] Bay Trail[™] SoC platform
- → Fanless panel IPC with 0°C÷50°C operating temperature
- → 6.5", 8.4", 10.4", 12.1" in 4:3 aspect ratio, 7", 10.1", 12.1" and 15.6" LCDs in Wide aspect ratio
- → Isolated 24 VDC power supply input
- → Onboard connector for NETcore X fieldbus boards
- → Integrated UPS with external battery pack (optional)
- \rightarrow SL version with reduced depth
- → CE, cULus LISTED (61010) certifications



→ 1 x RS232/422/485 + 1 x USB 2.0 → 1 x RS232/422/485 isol. + 1 x USB 2.0

 \rightarrow 1 x LAN Gigabit + 1 x USB 2.0 \rightarrow 1 x NETcore X fieldbus board



HT2200 / QT2200 Intel[®] Bay Trail[™] based fanless panel IPCs



The fanless Panel IPC families HT2200 and QT2200 are based on the Celeron J1900 2GHz quad core 64 bit processor of the Intel[®] Bay Trail[™] System On Chip (SoC) platform.

The "all in one" motherboard provides two Ethernet 10/100/1000Mbps ports, that support "Jumbo Frame" and "Wake on Lan" functionalities, one USB 3.0 port, two USB 2.0 ports, a serial RS232 interface, a DVI-I (DVI-D + VGA) video output and a SATA II CFast slot with rear external access, an

mSATA connector for SATA II SSD, one SATA II connector for touchscreen. the installation of 2.5" HDD/ SSD, up to 8 GB RAM with one with 16 million colours LED DDR3 SODIMM module and two internal connectors for additional interfaces. The QT2200 family is available with the new front panels with minimized frame, 16 million colours LED Backlight TFT LCDs from 12.1" to 24", in 4:3 and Wide aspect ratio, with aluminium front panel and a 5 wires resistive touchscreen, or aluminium and glass TrueFlat Multitouch front panels,

with projected capacitive The HT2200 family is available Backlight TFT LCDs from 10.1" to 24", in 4:3, 5:4 and Wide aspect ratio, with aluminium or aluminium True flat front panels, 5 wires resistive touchscreen and an additional USB 2.0 port on front. As an alternative, the systems with 12.1", 15", 17" and 19" LCD can have a Stainless Steel True Flat front panel. All version with Wide LCDs are also available with aluminium

and glass TrueFlat Multitouch front panels, with projected capacitive touchscreen. HT2200/QT2200 systems have an isolated 24 VDC power supply input and optionally an integrated UPS with external battery pack. The systems are available in three versions, the SL with a reduced depth, the S0 with the possibility to install additional interfaces and the S1 with a PCI or PCIe x1 slot.

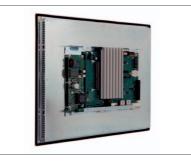
INSIDE

• Highlights

- → UBIQUITY remote assistance software providing remote access to the system
- \rightarrow Support to 32 or 64 bit operating systems
- \rightarrow "All in one" motherboard
- → High performance Intel[®] Bay Trail[™] SoC platform
- \rightarrow Fanless panel IPC with 0°C÷50°C operating temperature
- → 10.4", 12.1" LCDs in 4:3 aspect ratio, 17" and 19" LCDs in 5:4 aspect ratio, 10.1", 12.1", 15.6", 18.5", 21.5" and 24" LCDs in Wide aspect ratio
- → Isolated 24 VDC power supply input
- \rightarrow Integrated UPS with external battery pack (optional)
- \rightarrow Onboard connector for NETcore X fieldbus boards
- \rightarrow SL version with reduced depth
- \rightarrow S1 version with one PCI or PCIe x1 expansion slot
- → CE, cULus LISTED (508) certifications

Gallery

Add-On boards



Position A → 2 x RS232 → 2 x USB 2.0 **Position B** \rightarrow 1 x LAN Gigabit

→ Wi-Fi/Bluetooth/Modem

Technical data

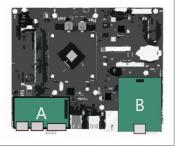
	QT2200	QT2200-TFM	HT2200	HT2200-TF	HT2200-TFX	HT2200-TFM		
LED backlight TFT LCD	15.6" W - 18.5" W - 18.5" W - 18.5" W -	1366x768 1920x1080 1366x768 1920x1080 1920x1080	10.4" - 12.1" - 12.1" W 15.0" - 15.6" W 15.6" W 15.6" W 17" - 1 18.5" W 18.5" W 19" - 1 21.5" W-	L280x800 (SL) 800x600 1024x768 - 1280x800 1024x768 - 1366x768 - 1366x768 - 1920x1080 280x1024 - 1366x768 - 1920x1080 280x1024 1920x1080	12.1" - 800x600 12.1" - 1024x768 15.0" - 1024x768 17" - 1280x1024 19" - 1280x1024	10.1" W - 1280x800 (SL) 12.1" W - 1280x800 15.6" W - 1366x768 15.6" W - 1920x1080 18.5" W - 1366x768 18.5" W - 1920x1080 21.5" W- 1920x1080 24" W- 1920x1080		
CUT-OUT	Ç	2T		F	IT			
FRONT USB		-	1 x USB 2.0, front,	, protected (Type-A)		-		
TOUCHSCREEN	Resistive 5 wires	P-CAP Multitouch		Resistive 5 wires		P-CAP Multitouch		
FRONT PANEL	Aluminium	True Flat Aluminium	Aluminium	True Flat Aluminium	True Flat Stainless Steel	True Flat Aluminium		
PROTECTION GRADE				- frontal				
PROCESSOR	Intel®	Celeron J1900 2.00G	nz (2.42Ghz Burst) a	64 bit, 4 cores / 4 threa	ads, 2MB L2 cache, so	Idered		
VIDEO CONTROLLER	Intel [®] HD Gra	phics integrated in m	icroprocessor, 688MHz Clock 854MHz Turbo, LVDS 8bit/colour digital interface					
SYSTEM MEMORY - RAM		1GB of	r 2GB or 4GB or 8GB (1 x SODIMM DDR3 module)					
MASS STORAGE SL/S0/S1		1 x onboar	d connector for dire	ot on board with extern ct insertion of mSATA	SSD SATA II			
S0/S1			table CFast SATA II slot on board with external access ector for 2,5" SSD/HDD 24x7 SATA II with internal installation kit					
LAN		2 x	LAN 10/100/1000Mbps (RJ45 - 2 x Intel® I210)					
USB			1 x USB 3.0 rear (Type-A) 2 x USB 2.0 rear (Type-A)					
SERIAL			1 x RS2	32 (DB9M)				
VIDEO OUTPUT			1 x DVI-I (DVI-D -	+ VGA with adapter)				
ADD-ON INTERFACES (only for S0/S1)				.5M)+ 1 x USB 2.0 (Typ				
Position A		1 x RS23		isolated + 1 x USB 2.0	(Туре-А)			
(max 1)			2 x RS232 (DB9M)					
		1	2 x USB 2.0 (Type-A)					
Position B	1 v NF		x LAN 10/100/1000Mbps (RJ45 - Intel® I210) ds for EtherCAT, EtherNet IP, PROFINET, PROFIBUS, CANopen protocols					
(max 1)	1 X INE				OFIBOS, CANOPEII pro	JUCCOIS		
EXPANSION SLOTS S1	1 x Wi-Fi/Bluetooth/Modem adapter							
POWER SUPPLY INPUT	1 x PCI or 1 x PCIe x1 24VDC (18÷32VDC) isolated							
POWER SUPPLY				rnal battery pack				
OPTIONS								
O.S. CERTIFIED	Kit for ATX mode power supply Microsoft Windows 7 Pro/Ultimate 32/64 bit, Microsoft Windows Embedded Standard 7E/7P 32/64 bit, Microsoft Windows 10 IoT Enterprise 2016/2019 64 bit							
OPERATING			0°C	÷50°C				
TEMPERATURE				vith 24x7 HDD				
APPROVALS			CE, cULus	LISTED (508)				





→ 1 x RS232/422/485 + 1 x USB 2.0 → 1 x RS232/422/485 isol. + 1 x USB 2.0

 \rightarrow 1 x NETcore X fieldbus board



@ASEA+

Entry-level compact panel fanless IPCs based on Intel[®] Apollo Lake[™] platform



The fanless Panel IPC families HT2250 and QT2250 are based M.2 connector for a SATA III on the Intel® Atom[™] x5-3930 1.3GHz (1.80GHz Burst) or x7-3950 1.6GHz (2.00GHz Burst) processors of the Intel® Apollo Lake[™] System on Chip (SoC) platform. The "all in one" motherboard

provides two Gigabit Ethernet ports, that support "Jumbo Frame" and "Wake on Lan" functionalities, three USB 3.0 ports and a SATA III CFast slot with rear external access, an SSD, up to 8 GB RAM LPDDR4 and one internal connector for additional interfaces. The QT2250 family is available with the new front panels with minimized frame, 16 million colours LED Backlight TFT LCDs from 7" to 24", in Wide aspect ratio, with aluminium front panel and a 5 wires resistive touchscreen, or aluminium and glass TrueFlat

Multitouch front panels, with projected capacitive touchscreen. The HT2250 family is available with 16 million colours LED Backlight TFT LCDs from 7" to 24", in 4:3, 5:4 and Wide aspect ratio, with aluminium or aluminium True flat front panels, 5 wires resistive touchscreen and an additional USB 2.0 port on front. All versions with Wide LCDs are also available with aluminium

and glass TrueFlat Multitouch front panels, with projected capacitive touchscreen. HT2250/QT2250 systems have an isolated 24 VDC power supply input and optionally an integrated UPS with external battery pack. The systems are available in two versions, the SL with a

reduced depth and the S0 with the possibility to install additional interfaces.



Ð	н	q	hl	q	hts
		-		-	

- → UBIQUITY remote assistance software providing remote access to the system
- → Intel Apollo Lake[™] SoC platform
- \rightarrow "All in one" motherboard
- \rightarrow Fanless panel IPC with 0°C÷50°C operating temperature
- → 8.4", 10.4", 12.1" and 15" LCDs in 4:3 aspect ratio, 17" and 19" LCDs in 5:4 aspect ratio, 7", 10.1", 12.1", 15.6", 17", 18.5", 21.5" and 24" LCDs in Wide aspect ratio
- → Isolated 24 VDC power supply input
- \rightarrow Integrated UPS with external battery pack (optional)
- → Onboard connector for NETcore X fieldbus boards
- \rightarrow SL version with reduced depth
- → CE, cULus LISTED (61010) certifications

Gallery

Add-On boards



→ 2 x RS232/422/485 → 2 x RS232/422/485 isol. → 2 x RS232 \rightarrow 1 x LAN Gigabit + 1 x USB 2.0 → 2 x USB 2.0 \rightarrow 1 x NETcore X fieldbus board

Technical data

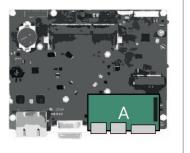
	QT2250	QT2250-TFM	HT2250	HT2250-TF	HT2250-TFM	
LED backlight TFT LCD	7" W - 800x480 10.1" W - 1280x800 12.1" W - 1280x800 15.6" W - 1366x768 15.6" W - 1920x1080 18.5" W - 1920x1080 21.5" W - 1920x1080 24" W - 1920x1080		7" W - 800x480 8.4" - 800x600 10.1" W - 1280x800 10.4" - 800x600 12.1" - 800x600 12.1" - 1024x768 12.1" W - 1280x800 17" - 1280x1024	15.0" - 1024x768 15.6" W - 1366x768 15.6" W - 1920x1080 17" - 1280x1024 18,5" W - 1366x768 18.5" W - 1366x768 18.5" W - 1920x1080 21.5" W - 1920x1080 24" W - 1920x1080	7" W - 800x480 10.1" W - 1280x800 12.1" W - 1280x800 15.6" W - 1366x768 15.6" W - 1920x1080 18,5" W - 1366x768 18.5" W - 1920x1080 21.5" W - 1920x1080 24" W - 1920x1080	
CUT-OUT	Ç	Ĩ		HT		
FRONT USB		-	1 x USB 2.0, front,	protected (Type-A)	-	
TOUCHSCREEN	Resistive 5 wires	P-CAP Multitouch	Resistiv	e 5 wires	P-CAP Multitouch	
FRONT PANEL	Aluminium	True Flat Aluminium	Aluminium	True Flat A	luminium	
PROTECTION GRADE			IP65 - frontal			
PROCESSOR	Intel®	Atom™ x5-E3930 1.3GHz	(1.8GHz Burst), 2 cores /	2 threads, 2MB L2 cache,	14nm	
	Intel®	Atom™ x7-E3950 1.6GHz	(2.0GHz Burst), 4 cores /	4 threads, 2MB L2 cache,	14nm	
CHIPSET		Intel® Apollo La	ake - Included into proce	ssor chip (SoC)		
VIDEO CONTROLLER			s 500 integrated in x5-E3 s 505 integrated in x7-E3			
SYSTEM MEMORY RAM (soldered)						
with x5-E3930			4GB LP-DDR4			
with x7-E3950			4GB or 8GB LP-DDR4			
MASS STORAGE			t SATA III slot onboard wi tor for direct insertion of			
LAN		2 x LAN 10/10	00/1000Mbps (RJ45 - 2 x	Intel® I210)		
USB		3	8 x USB 3.0 rear (Type-A)			
ADD-ON INTERFACES		1 x RS232/422	2/485 (DB15M)+ 1 x USB	2.0 (Type-A)		
(only for S0, max 1)		1 x RS232/422/48	5 (DB15M) isolated + 1 x	USB 2.0 (Type-A)		
		2	x RS232/422/485 (DB9M))		
		2 x RS	232/422/485 (DB9M) iso	lated		
			2 x RS232 (DB9M)			
			2 x USB 2.0 (Type-A)			
			00Mbps (RJ45 - Intel® I2	,		
	1 x NETcore			NET, PROFIBUS, CANoper	n protocols	
			less/Bluetooth/Modem a	1		
POWER SUPPLY INPUT			VDC (18÷32VDC) isolate			
POWER SUPPLY OPTIONS	UPS with external battery pack Kit for ATX mode power supply					
O.S. CERTIFIED	Microsoft Windows 10 IoT Enterprise 2016/2019 64 bit					
OPERATING TEMPERATURE			0°C÷50°C			
APPROVALS		(E, cULus LISTED (61010)			





→ 1 x RS232/422/485 + 1 x USB 2.0 → 1 x RS232/422/485 isol. + 1 x USB 2.0

→ Wireless/Bluetooth/Modem



HT3200 / QT3200 Intel[®] Broadwell[™] U based fanless panel IPCs



The fanless Panel IPC families HT3200 and QT3200 are based on the fifth generation Core i3, i5, i7 and Celeron of the Intel[®] Broadwell[™] U platform.

The "all in one" motherboard provides three Ethernet 10/100/1000Mbps ports, that support "Jumbo Frame" and "Wake on Lan" functionalities, two USB 3.0 ports, one USB 2.0 port, a serial RS232 interface, a DVI-I (DVI-D + VGA) video output and a SATA III CFast slot with rear external access, an mSATA connector

for SATA III SSD, one SATA III connector for the installation of 2.5" HDD/ SSD, up to 16 GB RAM with one DDR3 SODIMM module and two internal connectors for additional interfaces.

The QT3200 family is available with the new front panels with minimized frame, 16 million colours LED Backlight TFT LCDs from 15.6" to 24", in 4:3 and Wide aspect ratio, with aluminium front panel and a 5 can have a Stainless Steel wires resistive touchscreen, or aluminium and glass TrueFlat Multitouch front panels,

with projected capacitive touchscreen. The HT3200 family is available with 16 million colours LED Backlight TFT LCDs from 12.1" to 24", in 4:3, 5:4 and Wide aspect ratio, with aluminium or aluminium True flat front panels, 5 wires resistive touchscreen and an additional USB 2.0 port on front. As an alternative, the systems with 12.1", 15", 17" and 19" LCD True Flat front panel. All version with Wide LCDs are also available with aluminium

and glass TrueFlat Multitouch front panels, with projected capacitive touchscreen. HT3200/QT3200 systems have an isolated 24 VDC power supply input and optionally an integrated UPS with external battery pack. The systems are available in three versions, the SL with a reduced depth, the SO with the possibility to install additional interfaces and the S1 with a PCI or PCIe x4 slot.



• Highlights

- → UBIQUITY remote assistance software providing remote access to the system
- → "All in one" motherboard
- → 15W processors Intel[®] Broadwell[™] U platform
- \rightarrow Fanless panel IPC with 0°C÷50°C operating temperature
- → 12.1" in 4:3 aspect ratio, 17" and 19" LCDs in 5:4 aspect ratio, 12.1", 15.6", 18.5", 21.5" and 24" LCDs in Wide aspect ratio
- → Isolated 24 VDC power supply input
- \rightarrow Integrated UPS with external battery pack (optional)
- → Onboard connector for NETcore X fieldbus boards
- \rightarrow SL version with reduced depth
- \rightarrow S1 version with one PCI or PCIe x4 expansion slot
- → CE, cULus LISTED (61010) certifications

Gallery

Add-On boards



Technical data

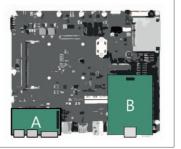
IECHINCA	Tuata					
	QT3200	QT3200-TFM	HT3200	HT3200-TF	HT3200-TFX	HT3200-TFM
LED backlight TFT LCD	15.6" W - 1366x768 15.6" W - 1920x1080 18.5" W - 1366x768 18.5" W - 1920x1080 21.5" W - 1920x1080 24"W - 1920x1080		12.1" - 800x600 12.1" - 1024x768 12.1" W - 1280x800 15.0" - 1024x768 15.6" W - 1366x768 15.6" W - 1320x1080		12.1" - 800x600 12.1" - 1024x768 15.0" - 1024x768 17" - 1280x1024 19" - 1280x1024	12.1" W - 1280x800 15.6" W - 1366x768 15.6" W - 1920x1080 18.5" W - 1366x768 18.5" W - 1366x768 21.5" W - 1920x1080 24" W - 1920x1080
CUT-OUT	Ç	Ţ		Н	Т	
FRONT USB		-	1 x USB 2.0, front,	protected (Type-A)	-	-
TOUCHSCREEN	Resistive 5 wires	P-CAP Multitouch		Resistive 5 wires		P-CAP Multitouch
FRONT PANEL	Aluminium	True Flat Aluminium	Aluminium	True Flat Aluminium	Stainless Steel True Flat	True Flat Aluminium
PROTECTION GRADE				frontal		
PROCESSOR (soldered)	Inte	Intel [®] Core™ i3-: el [®] Core™ i5-5350U 1 el [®] Core™ i7-5650U 2	5010U 2,1Ghz, 2 cores .,8Ghz (2,9GHz Turbo) 2,2Ghz (3,1GHz Turbo)	- 2 threads - 2MB sm s - 4 threads - 3MB sn , 2 cores - 4 threads - , 2 cores - 4 threads -	nart cache - 15W 3MB smart cache - 1 4MB smart cache - 1	5W
CHIPSET	Inte			lub - Low Power) • Inc		chip
VIDEO CONTROLLER		Intel [®] HD Graphics integrated in microprocessor Celeron 3765U, 850MHz Clock Intel [®] HD Graphics 5500 integrated in microprocessor i3, 900MHz Clock Intel [®] HD Graphics 6000 integrated in microprocessor i5, i7, 1GHz Clock with LVDS 8bit/color digital interface				
SYSTEM MEMORY - RAM		2GB or 4GB or 8GB or 16GB (1 x SODIMM DDR3 module)				
MASS STORAGE		1 x bootable CFast SATA III slot onboard with external access 1 x onboard connector for direct insertion of mSATA SSD SATA III				
S0/S1	1 x bootable CFast SATA III slot onboard with external access 1 x onboard connector for direct insertion of mSATA SSD SATA III 1 x onboard connector for 2.5" SSD/HDD SATA III with internal installation kit					
LAN		3 x LAN 10/100	· · · · · ·	2 x Intel® I210-AT, 1 x	Intel® I218-LM)	
USB			1 x USB 2.0	rear (Type-A) rear (Type-A)		
SERIAL				2 (DB9M)		
VIDEO OUTPUT				OVI-D	• •	
ADD-ON INTERFACES (only S0/S1)				5M) + 1 x USB 2.0 (Typ		
Position A		I X N323		solated + 1 x USB 2.0 2 (DB9M)	(туре-А)	
(max 1)				0 (Type-A)		
		1		lbps (RJ45 - Intel® I21	0)	
Position B	1 x NE	Tcore X fieldbus boar	ds for EtherCAT, Ether	Net IP, PROFINET, PRO	OFIBUS, CANopen pro	otocols
(max 1)			1 x Wi-Fi/Bluetoot	h/Modem adapter		
EXPANSION SLOTS S1		1 x PCI or 1 x PCIe x4 (5 Gb/s)				
POWER SUPPLY INPUT	24VDC (18÷32VDC) isolated					
POWER SUPPLY OPTIONS	UPS with external battery pack Kit for ATX mode power supply					
O.S. CERTIFIED	Microsoft Windows 7 Pro/Ultimate 32/64bit, Microsoft Windows Embedded Standard 7E/7P 32/64 bit (7E not on TFM), Microsoft Windows 10 IoT Enterprise 2016/2019 64bit					
OPERATING TEMPERATURE				-50°C		
				th 24x7 HDD		
APPROVALS			CE, cULus LI	STED (61010)		





→ 1 x RS232/422/485 + 1 x USB 2.0 → 1 x RS232/422/485 isol. + 1 x USB 2.0

 \rightarrow 1 x NETcore X fieldbus board → Wi-Fi/Bluetooth/Modem



@ASEA+

HT3500 / QT3500 [new] Panel IPC fanless based on Intel[®] Kaby Lake[™] U platform



The fanless Panel IPC families HT3500 and QT3500 are based on the seventh generation Core i3, i5, i7 and Celeron of the Intel® Kaby Lake™ U platform. The "all in one" motherboard provides three Gigabit Ethernet ports, that support "Jumbo Frame" and "Wake on Lan" functionalities, four USB 3.0 ports, a serial RS232 interface, a Display Port dual mode video output and a SATA III CFast slot with rear external access, an M.2 connector for an NVMe/ SATA III SSD, one SATA III connector for the installation of

a 2.5" HDD/ SSD, up to 16 GB RAM with one DDR4 SODIMM module and two internal connectors for additional interfaces, including RVL for the remotation of the video and USB signals up to 100m (Remote Video Link). The QT3500 family is available with the new front panels with minimized frame, 16 million colours LED Backlight TFT LCDs from 15.6" to 24", in 4:3 and Wide aspect ratio, with aluminium front panel and a 5 wires resistive touchscreen, or aluminium and glass TrueFlat

Multitouch front panels, with projected capacitive touchscreen. The HT3500 family is available with 16 million colours LED Backlight TFT LCDs from 12.1" to 24", in 4:3, 5:4 and Wide aspect ratio, with aluminium or aluminium True flat front panels, 5 wires resistive touchscreen and an additional USB 2.0 port on front. As an alternative, the systems with 12.1", 15", 17" and 19" LCD can have a Stainless Steel True Flat front panel. All versions with Wide LCDs are also

available with aluminium and glass TrueFlat Multitouch front panels, with projected capacitive touchscreen. HT3500/OT3500 systems have an isolated 24 VDC power supply input and optionally an integrated UPS with external battery pack. The systems are available in three versions, the SL with a

reduced depth, the S0 with the possibility to install additional interfaces and the S1 with a PCI or PCIe x4 slot.



INSIDE

• Highlights

- → UBIQUITY remote assistance software providing remote access to the system
- → Seventh generation Core i3, i5, i7 and Celeron of the Intel® Kaby Lake[™] U 15W platform. → "All in one" motherboard
- \rightarrow Fanless panel IPC with 0°C÷50°C operating temperature
- → 12.1" and 15" LCDs in 4:3 aspect ratio, 17" and 19" LCDs in 5:4 aspect ratio, 12.1", 15.6", 18.5", 21.5" and 24" LCDs in Wide aspect ratio
- → Isolated 24 VDC power supply input
- → Integrated UPS with external battery pack (optional)
- \rightarrow Onboard connector for NETcore X fieldbus boards
- \rightarrow SL version with reduced depth
- \rightarrow S1 version with one PCI or PCIe x4 expansion slot
- \rightarrow CE, cULus LISTED (61010) certifications

Gallery



Position A \rightarrow 1 x RS232 + 1 x USB 2.0

→ 2 x RS232 → 2 x USB 2.0 Position B → 1 x LAN Gigabit \rightarrow 1 x DVI-D

Technical data

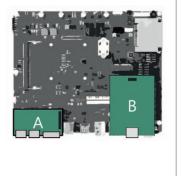
LED backlight TFT LCD LIS 6: W - 1366:/768 L21.* 00.0600 L21.* W - 13200.000 L35.* W - 13200.0000		QT3500	QT3500-TFM	HT3500	HT3500-TF	HT3500-TFX	HT3500-TFM		
FRONT USB - 1 x USB 2.0, front, protected (Type-A) - TOUCHSCREEN Resistive 5 wires P-CAP Multitouch Resistive 5 wires P-CAP Multitouch FRONT PANEL Aluminium True Flat Aluminium True Flat True Flat PROTECTION GRADE Intel* Cerei 7-3000 2.00CHz 64bit, 2 cores / 4 threads, 2MB Smart cache True Flat Aluminium True Flat Aluminium PROCESSOR Intel* Cerei 7-3000 2.00CHz 63bit, 2 cores / 4 threads, 3MB Smart cache Intel* Cerei 7-3000 2.00CHz 63bit, 2 cores / 4 threads, 3MB Smart cache Intel* Cerei 7-3000 2.00CHz 1030CHz 10bit, 2 cores / 4 threads, 3MB Smart cache Intel* Flot Graphics 620 integrated in microprocessor - 6100 MUHz/1.00CHz VIDEO CONTROLLER Intel* PID Graphics 620 integrated in Core i3 processor - 300MHz/1.00CHz Intel* HD Graphics 620 integrated in Core i3 processor - 300MHz/1.00CHz Intel* HD Graphics 620 integrated in Core i3 processor - 300MHz/1.00CHz Intel* HD Graphics 620 integrated in Core i7 processor - 300MHz/1.00CHz Intel* ND Graphics 620 integrated in Core i1 processor - 300MHz/1.00CHz Intel* HD Graphics 620 integrated in Core i1 processor - 300MHz/1.00CHz Intel* HD Graphics 620 integrated in Core i1 processor - 300MHz/1.00CHz Intel* HD Graphics 620 integrated in Core i1 procesors - 300MHz/1.00CHz		15.6" W - 1920x1080 18.5" W - 1366x768 18.5" W - 1920x1080 21.5" W - 1920x1080		12.1" - 1024x768 12.1" W - 1280x800 15.0" - 1024x768 15.6" W - 1366x768	18.5" W - 1366x768 18.5" W - 1920x1080 19" - 1280x1024 21.5" W - 1920x1080 24" W - 1920x1080	12.1" - 1024x768 15.0" - 1024x768 17" - 1280x1024 19" - 1280x1024	15.6" W - 1366x768 15.6" W - 1920x1080 18.5" W - 1366x768 18.5" W - 1920x1080 21.5" W - 1920x1080		
TOUCHSCREEN Resistive 5 wires P-CAP Multitouch FRONT PANEL Aluminium Tue Flat Aluminium Tue Flat Stainless Steel True Flat PROTESTON Aluminium Tue Flat Stainless Steel True Flat True Flat PROTESTON Intel® Core i3-7100U 240GHz 64bit, 2 cores / 2 threads, 2MB Smart cache Intel® Core i3-7100U 240GHz 64bit, 2 cores / 2 threads, 3MB Smart cache Intel® Core i3-700U 2.60GHz 105 000L2 60GHz 105 000Hz, 2 cores / 4 threads, 3MB Smart cache Intel® Core i3-700U 260GHz 105 00Hz 200GHz 10Hz 200GHZ 20HZ 20HZ 20HZ 20HZ 20HZ 20HZ 20HZ 20		Ç	<u>p</u> T			HT			
FRONT PANEL Aluminium True Flat Aluminium True Flat Aluminium True Flat Aluminium PROTECTION GRADE PROCESSOR (soldered) Intel® Ceren 3950U 2.20GHz 64bit, 2 cores / 2 threads, 2MB Smart cache Intel® Cere IS-7200U 2.40GHz 64bit, 2 cores / 4 threads, 3MB Smart cache Intel® Cere IS-7200U 2.40GHz 64bit, 2 cores / 4 threads, 3MB Smart cache Intel® Cere IS-7200U 2.40GHz 63bit, 2 cores / 4 threads, 3MB Smart cache Intel® Cere IS-7200U 2.40GHz 63bit, 2 cores / 4 threads, 3MB Smart cache Intel® Cere IS-7200U 2.40GHz 63bit, 2 cores / 4 threads, 3MB Smart cache Intel® Core IS-700U 2.40GHz 63bit, 2 cores / 4 threads, 3MB Smart cache Intel® Too Partice 1 State 1 and threads, 4MB Smart cache Intel® Too Partice 1 State 1 and the core IS processor S 100MHz/1.00GHz Intel® HD Graphics 620 integrated in Cere IS processor S 100MHz/1.00GHz Intel® HD Graphics 620 integrated in Cere IS processor S 100MHz/1.10GHz Intel® HD Graphics 620 integrated in Cere IS processor S 100MHz/1.10GHz Intel® HD Graphics 620 integrated in Cere IS processor S 100MHz/1.10GHz Intel® HD Graphics 620 integrated in Cere IS processor S 100MHz/1.10GHz Intel® HD Graphics 620 integrated in Cere IS processor S 100MHz/1.10GHz Intel® HD Graphics 620 integrated in Cere IS processor S 100MHz/1.10GHz Intel® HD Graphics 620 integrated in Cere IS processor S 100MHz/1.10GHz Is onboard connector for circl insertion of M .22200 NVMe/SATA III SSD I x onboard connector for C 25' SSD/HD SATA III With Internal Installation kit LAN 3 x LAN 10/100/1000 Mbgs (RA5 - 2 x Intel® 1210-AT, 1 x Intel® 1219-LM) 4 x USB 3.0 rear (Type-A) SERIAL 1 x R5232/422/485 (DBISM) isolated + 1 x USB 2.0 (Type-A) 1 x R5232/422/485 (DBISM) isolated + 1 x USB 2.0 (Type-A) Mortin SM		· · · · · ·	-	1 x USB 2.0, front,			-		
Aluminium Aluminium Ture Plat PROTECTION GRADE IP65 - fontal PROCESSOR (soldered) Intel® Celeon 3965U 2.00CHz Gabit, 2 cons / 4 threads, 3MB Smart cache Intel® Core 13-7300U 2.40CHz (4)SOGHz Turbol 24Bit, 2 cons / 4 threads, 3MB Smart cache Intel® Core 17-7600U 2.80CHz (3.SOGHz Turbol 24Bit, 2 cons / 4 threads, 3MB Smart cache Intel® Core 17-7600U 2.80CHz (3.SOGHz Turbol 24Bit, 2 cons / 4 threads, 3MB Smart cache Intel® Broadwall PCH-LP (Platform Controller Hub - Low Power) - Included into processor chip CHIPSET Intel® Broadwall PCH-LP (Platform Controller Hub - Low Power) - Included into processor - 300MHz/10.0CHz Intel® HD Graphics 620 integrated in Core 13 processors - 300MHz/10.0CHz Intel® HD Graphics 620 integrated in Core 13 processors - 300MHz/10.0CHz Intel® HD Graphics 620 integrated in Core 13 processors - 300MHz/10.0CHz Intel® HD Graphics 620 integrated in Core 13 processors - 300MHz/10.0CHz Intel® HD Graphics 620 integrated in Core 13 processors - 300MHz/10.0CHz Intel® HD Graphics 620 integrated in Core 13 processors - 300MHz/10.0CHz Intel® HD Graphics 620 integrated in Core 13 processors - 300MHz/10.0CHz Intel® HD Graphics 620 integrated in Core 13 processors - 300MHz/10.0CHz System MEMORY - RAM 40B or 86B or 166B (1 to: S0DDIM DDR4 module) MASS STORAGE 1 x botable CFast SATA III slot onboard with external access Support 1 x consoard connector for direct insertion of M.22280 NVMe/SATA III SSD System MEMORY - RAM 3 x LAN 10/10/1000 Mbgs (R45 - 2 x Intel® III SDD 1 x consoard connector for 25' SSD/MBD SATA III with internal installation kit LAN 3 x LAN 10/10/1000 Mbgs (R45 - 1 x In									
PROCESSOR (soldered) Intel® Celeron 3965U 2.306Hz 64bit, 2 cores / 2 threads, 2MB Smart cache Intel® Core 13-700U 2.606Hz (1x both 2 cores / 4 threads, 3MB Smart cache Intel® Core 15-730U 2.606Hz (1x both 2 cores / 4 threads, 3MB Smart cache Intel® Core 15-730U 2.606Hz (1x both 64bit, 2 cores / 4 threads, 3MB Smart cache Intel® Broadwell PCH-LP (Platform Controller Hub - Low Power) - Included into processor chip CHIPSET Intel® Broadwell PCH-LP (Platform Controller Hub - Low Power) - Included into processor - 300MHz/1006Hz Intel® HD Graphics 620 integrated in Core 13 processors - 300MHz/1006Hz Intel® HD Graphics 620 integrated in Core 13 processors - 300MHz/1006Hz Intel® HD Graphics 620 integrated in Core 13 processors - 300MHz/106Hz Intel® HD Graphics 620 integrated in Core 17 processor - 300MHz/106Hz SYSTEM MEMORY - RAM 408 or 868 or 1668 (1 k SODIMM DDR4 module) MASS STORAGE 1 x hootable Cfast SATA III slot onboard with external access S0/S1 1 x hootable Cfast SATA III slot onboard with external access 1 x bootable Cfast SATA III slot onboard with external access 1 x solboard connector for 2.5° SSD/HDD SATA III with internal installation kit 1 x onboard connector for 2.5° SSD/HDD SATA III with internal installation kit 1 x noboard connector for 2.5° SSD/HDD SATA III with internal installation kit 1 x NDP+H ADD-ON INTERFACES (only S0/S1) 1 x R5232/422/480 (BBISM) + 1 x US 8.20 (Type-A) Position B (max 1) 1 x RECore X fieldbus boards for EtherCAT, EtherNet IP, PROFINET, PROFIBUS, CANopen protocols 1 x WLF/Plautooth/Modem adapter Position B (max 1) 1 x RECore X fieldbus boards for EtherCAT, EtherNet IP, PROFINET, PROFIBUS, CANopen protocols 1 x WLF/Plautooth/Modem adapter		Aluminium			Aluminium		True Flat Aluminium		
(soldered) Intel [®] Core i3-7100U 240GHz 64bit, 2 cores / 4 threads, 3MB Smart cache Intel [®] Core i7-7300U 260GHz (3.SOGHz Turbo) 64bit, 2 cores / 4 threads, 4MB Smart cache Intel [®] Core i7-7600U 280GHz (3.SOGHz Turbo) 64bit, 2 cores / 4 threads, 4MB Smart cache CHIPSET Intel [®] Broadwell PCH-LP (Platform Controller Hub - Low Power) • Included into processor chip VIDEO CONTROLLER Intel [®] HD Graphics 520 integrated in Core i5 processors • 300MHz/100GHz Intel [®] HD Graphics 520 integrated in Core i5 processors • 300MHz/110GHz Intel [®] HD Graphics 520 integrated in Core i5 processors • 300MHz/110GHz Intel [®] HD Graphics 520 integrated in Core i5 processors • 300MHz/110GHz SYSTEM MEMORY • RAM 468 or 868 or 1668 (1 x SODIMM DR4 module) MASS STORAGE S1 1 x onboard connector for direct insertion of M.2 2280 NVMe/SATA III SSD SUSTEM MEMORY • RAM 468 or 868 or 1668 (1 x SODIMMD DR4 module) 1 x onboard connector for direct insertion of M.2 2280 NVMe/SATA III SSD SUST 1 x onboard connector for 25' SSD/HDD SATA III stol mistallation kit 1 x onboard connector for 25' SSD/HDD SATA III SSD LAN 3 x LAN 01/100/1000 Mps (R45 - 2 x Intel [®] 120 - LM) 1 x R5232 (DB9M) UBE OUTPUT 1 x R5232/422/485 (DB15M) is loated + 1 x US8 2.0 (Type-A) 1 x R5232 (DB9M) Gontion B (max 1) 1 x R5232 (ZB9M) + 1 x US8 2.0 (Type-A) 1 x R5232 (ZB9M) + 1 x US8 2.0 (Type-A) Mass STORA (max 1)									
VIDEO CONTROLLERIntel® HD Graphics 610 integrated in microprocessor Celeron 3965U • 300MHz/1.00GHz Intel® HD Graphics 620 integrated in Core 15 processors • 300MHz/1.10GHz Intel® HD Graphics 620 integrated in Core 15 processors • 300MHz/1.10GHz Intel® HD Graphics 620 integrated in Core 15 processors • 300MHz/1.10GHz Intel® HD Graphics 620 integrated in Core 17 processor • 300MHz/1.10GHz Intel® HD Graphics 620 integrated in Core 17 processor • 300MHz/1.10GHz Intel® HD Graphics 620 integrated in Core 17 processor • 300MHz/1.10GHz Intel® HD Graphics 620 integrated in Core 17 processor • 300MHz/1.10GHz Intel® HD Graphics 620 integrated in Core 17 processor • 300MHz/1.10GHzSYSTEM MEMORY - RAM4GB or 8GB or 16GB (1 x SODIMM DDR4 module)MASS STORAGES11 x botable CFast SATA III slot onboard with external access 1 x onboard connector for direct insertion of M.2 2280 NVMe/SATA III SSD 1 x onboard connector for 2.5" SSD/HDD SATA III with internal installation kitLAN3 x LAN 10/100/1000 Mbps (R45 - 2 x Intel® 1210-AT1 x Intel® 1219-LM)USB4 x USB 3.0 rear (Type-A)SERIAL1 x R5322/42/485 (DB15M) isolated + 1 x USB 2.0 (Type-A)VIDEO OUTPUT1 x R5232/42/485 (DB15M) isolated + 1 x USB 2.0 (Type-A)(max 1)1 x R5322/42/485 (DB15M) isolated + 1 x USB 2.0 (Type-A)(max 1)1 x NETCore X fieldbus boards for Ether CAT, EtherNet IP. PROFINET, PROFIBUS, CANopen protocols(max 1)1 x NETCore X fieldbus boards for Ether CAT, EtherNet IP. PROFINET, PROFIBUS, CANopen protocols(max 1)1 x NETCore X fieldbus boards for Ether CAT, EtherNet IP. PROFINET, PROFIBUS, CANopen protocols(max 1)1 x NETCore X fieldbus boards for Ether CAT, EtherNet IP. PROFIBUS, CANopen protocols1			Intel [®] Core ntel [®] Core i5-7300U	i3-7100U 2.40GHz 64 J 2.60GHz (3.50GHz T	bit, 2 cores / 4 threads urbo) 64bit, 2 cores / 4	s, 3MB Smart cache 4 threads, 3MB Smart			
Intel® HD Graphics 620 integrated in Core is processors • 300MHz/1.0GHz Intel® HD Graphics 620 integrated in Core is processors • 300MHz/1.0GHz DirecX 12 and OpenGL 4.5 supportSYSTEM MEMORY - RAM4 GB or 86B or 166B (1 x SODIM DDR4 module)MASS STORAGE SL1 x bootable CFast SATA III slot onboard with external access 1 x onboard connector for direct insertion of M.2 2280 NVMe/SATA III SSDSystem MEMORY - RAM3 x LAN 10/100/1000 Mbps (R45 - 2 x Intel® 1210-AT, 1 x Intel® 1219-LM)LAN3 x LAN 10/100/1000 Mbps (R45 - 2 x Intel® 1210-AT, 1 x Intel® 1219-LM)USB4 x USB 3.0 rear (Type-A)SERIAL1 x R5232 (20B9M)VIDEO OUTPUT1 x DCADD-ON INTERFACES (only S0/S1)1 x R5232/422/485 (DB15M) isolated + 1 x USB 2.0 (Type-A)Position A (max 1)1 x R5232/422/485 (DB15M) isolated + 1 x USB 2.0 (Type-A)Position B (max 1)1 x NETCore X fieldbus boards for EtherCAT, EtherNet Video Link (RVL OUT)1 x NETCore X fieldbus boards for EtherCAT, EtherNet Video Link (RVL OUT)1 x NETCore X fieldbus boards for EtherCAT, EtherNet Video Link (RVL OUT)1 x NETCore X fieldbus boards for EtherCAT, EtherNet Video Link (RVL OUT)1 x NETCore X fieldbus boards for EtherCAT, EtherNet Video Link (RVL OUT)1 x NETCore X fieldbus boards for EtherCAT, EtherNet P ROFIBUS, CANopen protocolsSt 1 x PCI or 1 x PCI er 4 (5 Gb/s)POWER SUPPLY INPUTOS. CERTIFIEDOPREATING TOPERATUREO'PERATING TEMPERATUREO'PERATUREO'PERATUREO'PERATUREO'PERATUREO'PERATUREO'PERATURE <th>CHIPSET</th> <th>Int</th> <th>el[®] Broadwell PCH-</th> <th>LP (Platform Control</th> <th>ler Hub - Low Power) •</th> <th>Included into proces</th> <th>sor chip</th>	CHIPSET	Int	el [®] Broadwell PCH-	LP (Platform Control	ler Hub - Low Power) •	Included into proces	sor chip		
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TEMPERATURE 0°- 45°C with 24x7 HDD		Microsoft Windows 10 IoT Enterprise 2016/2019 64bit							
0 - 43 C WILL 24X7 HDD									
APPROVALS CE, cULus LISTED (61010)									
	APPROVALS			CE, cULu	is LISTED (61010)				





Add-On boards

→ 1 x RS232/422/485 + 1 x USB 2.0 → 1 x RS232/422/485 isol. + 1 x USB 2.0



 \rightarrow 1 x RJ45 Remote Video Link (RVL OUT) \rightarrow 1 x NETcore X fieldbus board → Wi-Fi/Bluetooth/Modem

HT3400/QT3400 / HT3600/QT3600 Intel[®] Skylake[™] H and Kaby Lake[™] H based fanless panel IPCs



The fanless Panel IPC families HT3400 and QT3400 are based on the 6th generation Core i3, i5, i7 and Celeron processors of the Intel[®] Skylake[™] H and the HT3600 and OT3600 families are based on the 7th generation Core i3, i5, i7 processors of the Intel® Kaby Lake[™] H platform. The "all in one" motherboard provides four Ethernet 10/100/1000Mbps ports, that support "Jumbo Frame" and "Wake on Lan" functionalities, three USB 3.0 ports, two USB 2.0 port, a serial RS232 interface, a DVI-D video output

and a SATA III CFast slot with rear external access, an mSATA connector for a SATA III SSD, one SATA III connector for 2.5" SSD/HDD, up to 32 GB RAM with two DDR4 SODIMM modules and two internal connectors for additional interfaces, including RVL for the remotation of the video and USB signals up to 100m (Remote Video Link). The QT3400 / QT3600 families are available with the new front panels with minimized frame, 16 million colours LED Backlight TFT LCDs from 15.6" to 24", in 4:3 and Wide aspect

ratio, with aluminium front panel and a 5 wires resistive touchscreen, or aluminium and glass TrueFlat Multitouch front panels, with projected capacitive touchscreen. The HT3400 / HT3600 families are available with 16 million colours LED Backlight TFT LCDs from 12.1" to 24", in 4:3, 5:4 and Wide aspect ratio, with aluminium or aluminium True flat front panels, 5 wires resistive touchscreen and an additional USB 2.0 port on front. As an alternative, the systems with 12.1", 15", 17" and 19" LCD can have a

Stainless Steel True Flat front panel. All versions with Wide LCDs are also available with aluminium and glass TrueFlat Multitouch front panels, with projected capacitive touchscreen.

The systems have an isolated 24 VDC power supply input and optionally an integrated UPS with external battery pack. The systems are available in three versions, the S0 with the possibility to install additional interfaces, the S1 with a PCI or PCIe x4 slot and the D2 with two extractable 2.5" SSDs/ HDDs.



Highlights

- → UBIQUITY remote assistance software providing remote access to the system
- → High performance Intel[®] Skylake[™] H (HT/QT3400) and Kaby Lake[™] H (HT/QT3600) platforms
- → "All in one" motherboard
- \rightarrow Fanless panel IPC with 0°C÷50°C operating temperature
- \rightarrow 12.1" LCDs in 4:3 aspect ratio, 17" and 19" LCDs in 5:4 aspect ratio, 15.6", 18.5", 21.5" and 24" LCDs in Wide aspect ratio
- → Isolated 24 VDC power supply input
- → Integrated UPS with external battery pack (optional)
- → Onboard connectors for NETcore X fieldbus boards
- \rightarrow S1 version with one PCI or PCIe x4 expansion slot
- → CE, cULus LISTED (61010) certifications

Industrial Automation | Industrial PC Solutions

Gallery

Add-On boards



- **Position A** \rightarrow 2 x RS232
- → 2 x USB 2.0
- **Position B** → 1 x LAN Gigabit
- \rightarrow 2 x Diplay Port dual mode
- \rightarrow 1 x NETcore X fieldbus board
- -> Wi-Fi/Bluetooth/Modem

Tachaica			x NETcore X fieldbu /i-Fi/Bluetooth/Mo					
Technica	a data							
	QT3400/3600	QT3400/3600-TFM	HT3400/3600	HT3400/3600-TF	HT3400/3600-TFX	HT3400/3600-TFM		
LED backlight TFT LCD	15.6" V 18.5" V 18.5" V 21.5" V	N - 1366x768 V - 1920x1080 N - 1366x768 V - 1920x1080 V - 1920x1080 V - 1920x1080 - 1920x1080	12.1" - 800x600 12.1" - 1024x768 12.1" W - 1280x800 15.0" - 1024x768 15.6" W - 1366x768 15.6" W - 1920x1080	17" - 1280x1024 18.5" W - 1366x768 18.5" W - 1920x1080 19" - 1280x1024 21.5" W - 1920x1080 24" W - 1920x1080	12.1" - 800x600 12.1" - 1024x768 15.0" - 1024x768 17" - 1280x1024 19" - 1280x1024	12.1" W - 1280×800 15.6" W - 1366×768 15.6" W - 1920×1080 18.5" W - 1920×1080 21.5" W - 1920×1080 21.5" W - 1920×1080 24" W - 1920×1080		
CUT-OUT		QT		Н	T	24 00 - 1920/1080		
FRONT USB		-	1 x USB 2.0, front,	protected (Type-A)		-		
TOUCHSCREEN	Resistive 5 wires	P-CAP Multitouch		Resistive 5 wires		P-CAP Multitouch		
FRONT PANEL	Aluminium	True Flat Aluminium	Aluminium	True Flat Aluminium	True Flat Stainless Steel	True Flat Aluminum		
PROTECTION GRADE				5 - frontal				
PROCESSOR (soldered) xx3400 xx3600		Intel® Core Intel® Core i5-6440 Intel® Core i7-6820 Intel® Core	e i3-6100E 2.70GHz 64 EQ 2.70GHz (3.40GHz T EQ 2.80GHz (3.50GHz T e i3-7100E 2.90GHz 64	bit, 2 cores / 2 threads, bit, 2 cores / 4 threads, urbo) 64bit, 4 cores / 4 urbo) 64bit, 4 cores / 8 bit, 2 cores / 4 threads,	3MB Smart cache threads, 6MB Smart c threads, 8MB Smart c 3MB Smart cache	ache		
			EQ 3.00GHz (3.70GHz 1	urbo) 64bit, 4 cores / 4 urbo) 64bit, 4 cores / 8	threads, 8MB Smart of			
CHIPSET xx3400 xx3600				(Platform Controller Hu (Platform Controller Hu				
VIDEO CONTROLLER	Intel® H	D Graphics 510 integr		`	,	GL 4.4 support		
xx3400	Intel [®] H Intel [®] HD G	Intel® HD Graphics 510 integrated in Celeron processor • 350MHz/950MHz • DirectX 12 and OpenGL 4.4 support Intel® HD Graphics 530 integrated in Core i3 processor • 350MHz/950MHz • DirectX 12 and OpenGL 4.4 support Intel® HD Graphics 530 integrated in Core i5, Core i7processors • 350MHz/1,00GHz • DirectX 12 and OpenGL 4.4 support						
xx3600		Intel® HD Graphics 630 integrated in Core i3 processor • 350MHz/950MHz • DirectX 12 and OpenGL 4.5 support Intel® HD Graphics 630 integrated in Core i5, Core i7processors • 350MHz/1,00GHz • DirectX 12 and OpenGL 4.5 suppor						
SYSTEM MEMORY - RAM		4GB (1 x SODIMM		or 16GB or 32GB (2 x S	SODIMM DDR4 modu	les)		
TPM MASS STORAGE	1 bootable CFa		rd with external access	odule (optional) - 1 x onboard connecto s/HDDs SATA III with int		of mSATA SSD SATA III		
OPTIONS D2		1 X OHDOUTU -		5" SSD/HDD SATA III de				
USB				-A) - 2 x USB 2.0, rear (T	уре-А)			
SERIAL				S232 (DB9M)				
VIDEO OUTPUT ADD-ON INTERFACES				x DVI-D B15M)+ 1 x USB 2.0 (Ty	(DO A)			
ADD-ON INTERFACES		1 x		M) isolated + 1 x USB 2.0 (1)				
Position A				S232 (DB9M)				
(max 1)			2 x USB 2.0 (Type-A) boards for EtherCAT, EtherNet IP, PROFINET, PROFIBUS, CANopen protocols					
		1 x NETcore X fieldbus				rotocols		
				emote Video Link (RVL Remote Video Link (RVL	,			
Position B				+ Video output	001)			
(max 1)				0Mbps (RJ45 - Intel® I2	210)			
		1 x NETcore X fieldbus		therNet IP, PROFINET, P		rotocols		
		1 x Wi-Fi/Bluetooth/Modem adapter						
EXPANSION SLOTS S1	1 x PCI or 1 x PCIe x4 (5 Gb/s)							
POWER SUPPLY INPUT POWER SUPPLY		24VDC (18÷32VDC) isolated						
OPTIONS O.S. CERTIFIED	-	UPS with external battery pack Kit for ATX mode power supply (optional)						
0.5. CERTIFIED xx3400		Microsoft Windows 7 Pro/Ultimate 32/64bit Microsoft Windows Embedded Standard 7E/7P 32/64 bit (7E not on TFM) Microsoft Windows 10 IoT Enterprise 2016/2019 64bit						
xx3600				IoT Enterprise 2016/201	.9 64bit			
OPERATING TEMPERATURE				°C÷50°C HDD or Core i7 proces	CORC			
APPROVALS				s LISTED (61010)	5015			
ALTROTALD			CL, COLU	5 ET31 ED (01010)				

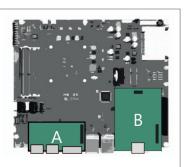
Panel IPC



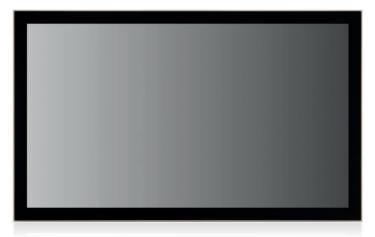
 \rightarrow 1 x RS232/422/485 + 1 x USB 2.0 → 1 x RS232/422/485 isol. + 1 x USB 2.0

 \rightarrow 1 x NETcore X fieldbus board

→ 1/2 x RJ45 Remote Video Link (RVL OUT)



HT5400/5600 / QT5400/5600 [new] Intel[®] Skylake[™] S and Kaby Lake[™] S based highly expandable panel IPCs



The panel IPC families HT5400 and OT5400 are based on the 6th generation Core i3, i5, i7 and Celeron processors of the Intel[®] Skylake[™] S and the HT5600 and QT5600 families are based on the 7th generation Core i3, i5, i7 and Celeron processors of the Intel[®] Kaby Lake[™] S platform. The "all in one" motherboard provides four Ethernet 10/100/1000Mbps ports, that support "Jumbo Frame" and "Wake on Lan" functionalities, four USB 3.0 ports, a serial RS232 interface, a DVI-D video output, a SATA III CFast slot with rear external access, an

M.2 2242/2280 SSD key M connector for a PCIe x4 SSD, two SATA III connectors for 2.5" SSDs/HDDs (optionally on extractable drawers), the possibility to set the mass storage drives in RAID 0, 1 configuration, up to 32 GB RAM with two DDR4 SODIMM modules and two internal connectors for additional interfaces, including RVL for the remotation of the video and USB signals up to 100m (Remote Video Link). The OT5400 / OT5600 families are available with the new front panels with minimized frame, 16 million colours LED

Backlight TFT LCDs from 15.6" to 24", in Wide aspect ratio, with aluminium front panel and a 5 wires resistive touchscreen, or aluminium and glass TrueFlat and glass TrueFlat Multitouch Multitouch front panels, with projected capacitive touchscreen. The HT5400 / HT5600 families are available with 16 million colours LED Backlight TFT LCDs from 15" to 24", in 4:3, 5:4 and Wide aspect ratio, with aluminium or aluminium True flat front panels, 5 wires resistive touchscreen and an additional USB 2.0 port on front. As an alternative, the systems with 15", 17" and

19" LCD can have a Stainless Steel True Flat front panel. All versions with Wide LCDs are also available with aluminium front panels, with projected capacitive touchscreen. The systems have an isolated 24 VDC power supply input or, as an alternative, a 115/230 VAC power supply. The systems are available in three versions, the S0 with the possibility to install additional interfaces, the S1 with a x16 PCIe slot and the S3 with two x8 and a x4 PCIe slots or a x16. a x4 and a x1 PCIe slots.



Highlights

- → UBIQUITY remote assistance software providing remote access to the system
- → High performance Intel[®] Skylake[™] S (HT/QT5400) and Kaby Lake[™] S (HT/QT5600) platforms \rightarrow RAID 0,1 (optional)
- → "All in one" motherboard
- \rightarrow Panel IPC with 0°C÷50°C operating temperature
- \rightarrow 15" LCD in 4:3 aspect ratio, 17" and 19" LCDs in 5:4 aspect ratio, 15.6", 18.5", 21.5" and 24" LCDs in Wide aspect ratio
- → 115/230 VAC or Isolated 24 VDC power supply input
- \rightarrow S1 version with one PCIe x16 expansion slot
- \rightarrow S3 version with one x16, one x4 and one x1 PCIe expansion slots or two x8 and one x4 PCIe expansion slots
- → CE, cULus LISTED (61010) certifications

Gallery

Position A

→ 2 x RS232

Position B

 \rightarrow 2 x USB 2.0

Technical data

	aata							
	QT5400/5600	QT5400/5600-TFM	HT5400/5600	HT5400/5600-TF	HT5400/5600-TFX	HT5400/5600-TFM		
LED backlight TFT LCD		- 1366x768	15.0" - 1024x768	19" - 1280x1024	15.0" - 1024x768	15.6" W - 1366x768		
		- 1920x1080 / - 1366x768	15.6" W - 1366x768 15.6" W - 1920x1080	21.5" W - 1920x1080 24"W - 1920x1080	17" - 1280x1024 19" - 1280x1024	15.6" W - 1920x1080 18.5" W - 1366x768		
		- 1920x1080	17" - 1280x1024	24 00 - 1520/1000	15 - 1200/1024	18.5" W - 1920x1080		
		- 1920x1080	18.5" W - 1366x768			21.5" W - 1920x1080		
	24"W -	1920x1080	18.5" W - 1920x1080			24"W - 1920x1080		
CUT-OUT		QT			HT			
FRONT USB TOUCHSCREEN	Desisting Fundament	-	1 x USB 2.0, front,	protected (Type-A)		- P-CAP Multitouch		
FRONT PANEL	Resistive 5 wires	P-CAP Multitouch True Flat Aluminium	Aluminium	Resistive 5 wires	Stainless Steel True Flat	True Flat Aluminium		
PROTECTION GRADE	Aluminium			65 - frontal	Stallliess Steel If the Flat	Inde Flat Aluminium		
PROCESSOR		Intel® Cele		ores, 2 Cores - 2 thread	s - 2MB smart cache			
(soldered)				2 Cores - 4 threads - 3				
(solucica) xx5400	D Intel® Core™ i5-6500 3.2GHz (3.6GHz Turbo), 4 Cores - 4 threads - 6MB smart cache							
					eads - 8MB smart cache			
				z, 2 cores – 2 threads – 3 2 Cores - 4 threads - 3				
xx5600					eads - 6MB smart cache			
					eads - 8MB smart cache			
CHIPSET				(Platform Controller H	,			
VIDEO CONTROLLER				ed in Celeron G3900, 3 d in i3-6100 / i5-6500,				
xx5400				ated in i7-6700, 350MH				
				d in Celeron G3930TE,				
xx5600		Intel [®] HD	Graphics 630 integrated in i3-7101E / i5-7500, 350/1.10GHz Clock					
			HD Graphics 630 integrated in i7-7700 350/1.15GHz Clock					
SYSTEM MEMORY - RAM		4GB (1 x SOD	IMM DDR4 module) /8GB/16GB/32GB (2 x SODIMM DDR4 modules)					
TPM MASS STORAGE		1 v b	TPM module (optional) ootable CFast SATA III slot on board with external rear access					
MASS STORAGE			2 connector for direct insertion of M.2 2242/2280 SSD key M PCIex4 2 x onboard connector for 2,5" SSDs/HDDs SATA III					
OPTIONS S0			1 x extractable drawer for 2.5" units					
S1/S3			2 x extractabl	2 x extractable drawers for 2.5" units				
RAID CONTROLLER			Integrated into chipset Intel [®] C236					
LAN		4 x LAN	10/100/1000Mbps (RJ45 - 3 x Intel® I210 + 1 x Intel® I219LM)					
USB			3 x USB 3.0, rear (Type-A) - 2 x USB 2.0, rear (Type-A)					
SERIAL			1 x F	RS232 (DB9M)				
VIDEO OUTPUT				1 x DVI-D				
ADD-ON INTERFACES		1 .	1 x RS232/422/485 (DB15M) + 1 x USB 2.0 (Type-A) RS232/422/485 (DB15M) isolated + 1 x USB 2.0 (Type-A)					
(max 1)		17	2 x RS232 (DB9M)					
Position A			2 x USB 2.0 (Type-A) N 10/100/1000Mbps (RJ45 - Intel® I210) + 1 x USB 2.0 (Type-A)					
		1 x LAN						
)00Mbps (RJ45 - Intel® Remote Video Link (RVI				
Desition D				Remote Video Link (RV				
Position B			2 x DP++ Vi	deo output (no audio)	1			
		1 x NETcore X fieldbu			PROFIBUS, CANopen pro	tocols		
EXPANSION SLOTS S1			1 x Wi-Fi/Bluetooth/Modem adapter					
S3		1v P		1 x PCIe x16				
POWER SUPPLY INPUT		1/1		(16 + 1x PCIe x4 + 1x PCIe x1 - 2 x PCIe x8 + 1 x PCIe x4 24VDC (18÷32VDC) isolated - 115/230VAC				
POWER SUPPLY OPTIONS			-					
	Microsoft Windows 10 IoT Enterprise 2019 64bit • Microsoft Windows 10 IoT Enterprise 2016 64bit • Windows 7 Pro// Iltimate 64					s 7 Pro/Ultimate 64bit •		
xx5400	Windows 10 for Enterprise 2019 64bit • Microsoft Windows 10 for Enterprise 2016 64bit • Windows 7 Pro/Offimate 64bit Windows Embedded Standard 7E/7P 64 bit • Microsoft Windows Server 2016/2019 Standard					ard		
xx5600		Microsoft Windows 10			s 10 IoT Enterprise 2016	64bit •		
				Server 2016/2019 Star	ndard			
OPERATING TEMPERATURE				0°C÷50°C 0°C÷45°C with 24x7 HDD				
APPROVALS								
APPROVALS			CE, CULI	CE, cULus LISTED (61010)				

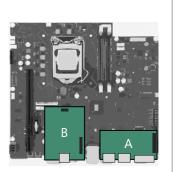




→ 1 x RS232/422/485 + 1 x USB 2.0 → 1 x RS232/422/485 isol. + 1 x USB 2.0

 \rightarrow 1 x NETcore X fieldbus board

→ 1 x LAN Gigabit → 1/2 x RJ45 Remote Video Link (RVL OUT) \rightarrow 2 x Diplay Port dual mode \rightarrow 1 x NETcore X fieldbus board → Wi-Fi/Bluetooth/Modem





Book Mounting IPCs

ASEM recently completed its Box IPCs portfolio with a complete range of book mounting systems, combining performances, design, ergonomics and configurability. Based on ARM Cortex A9 or Intel[®] Apollo Lake[™], Bay Trail[™], Skylake[™] and Kaby Lake[™] platforms, they are supplied with a sturdy aluminium or plastic chassis, highly refined in every aesthetic and ergonomic detail.



BM40 ARM Cortex A9 multicore based Book Mounting IPCs



The Book Mounting BM40 is based on the ARM Cortex A9 1GHz dual core processor (i.MX6 DualLite). The plastic case and the aluminium hooking system ensure a reliable fixing on a standard 35mm DIN rail.

The motherboard provides, on the front, one 10/100/1000 MicroSD memory card, 4GB Mbps and one 100 Mbps Ethernet ports, two USB 2.0 ports, one RS232/485 serial port, a DVI-D video output and the signaling LEDs. The motherboard also provides an

internal slot for a removable pseudo-SLC eMMC memory and 1 GB DDR3 RAM. BM40 has an isolated 24 VDC power supply input.



• Highlights

- → Ubiquity remote assistance software providing remote access to the system
- → ARM Cortex A9 i.MX6 DualLite processor
- \rightarrow Fanless ARM based book mounting IPC with 0°C÷50°C operating temperature
- → Isolated 24 VDC power supply input
- → CE, cULus LISTED (61010) certifications







Technical data

	BM40
O.S. CERTIFIED	Microsoft Windows Embedded Compact 7 Pro with Datalight Reliance Nitro file system
	Embedded Linux distribution based on Yocto Project
PROCESSOR	ARM Cortex A9 1 GHz i.MX6 DualLite
SYSTEM MEMORY - RAM	1 GB with DDR3 soldered
MASS STORAGE	4 GB eMMC Pseudo-SLC (Solid State Disk) 8bit, file system organization 1 x microSD slot internal access (FAT file system)
LAN	1 x 100 Mbps (RJ45); 1 x 10/100/1000 Mbps (RJ45 - Intel 82574L)
USB	2 x USB 2.0 (Type-A)
SERIAL	1 x RS232/485 isolated (DB15M)
BATTERY	1 x CR2032 Removable (internal)
VIDEO OUTPUT	1 x DVI-D
POWER SUPPLY INPUT	24VDC (18÷36VDC) isolated
CASE Installation	For book mounting on DIN rail guide
Material	Aluminium frame and hook, plastic shell
OPERATING TEMPERATURE	0°C÷50°C
APPROVALS	CE, cULus LISTED (61010)



@ASEA+

BM1xx Family

Ultra-compact book mounting IPC based on Intel[®] Apollo Lake[™] platform

[new]



The ultra-compact Book Mounting family fanless IPC BM100 features a robust and elegant aluminium chassis and they are suitable for wall or DIN Industrial IoT scenarios. rail installation for applications

with limited space and that require high computing capacity for the processing of collected data in many BM1xx have an isolated 24

VDC power supply input, also with integrated UPS with external battery pack and they are available with different interfaces.







The Book Mounting BM100 is based on the Intel[®] Atom[™] x5-3930 1.3GHz (1.80GHz Burst) or x7-3950 1.6GHz (2.00GHz Burst) processors of the Intel[®] Apollo Lake[™] System On Chip (SoC) platform. The motherboard provides

BM100

two 10/100/1000Mbps ports, two USB 3.0 ports and a Display Port V1.2 video output or DIN rail installation modes. with external access, a SATA III interface with M.2 key B connector for M.2 size 2242 SSD and 2GB, 4GB or 8GB soldered LP-DDR4 RAM. BM100 has an isolated 24

• Highlights

- → Compact design (100x100x39mm)
- → "All in one" motherboard
- → Intel[®] Apollo Lake[™] SoC platform
- \rightarrow 24 VDC isolated power supply input
- → CE, cULus LISTED (61010) certifications



VDC power supply input and allows several wall mounting

→ UBIQUITY remote assistance software providing remote access to the system

 \rightarrow Fanless book mounting IPC with up to 0°C÷55°C operating temperature

@ASEA+

BM110 [new]

BM120 / BM121 / BM122



The Book Mounting fanless IPCs BM110 are an ultra - compact systems based on Intel® Atom™ x5-3930 1.3GHz (1.8GHz Burst) and x7-E3950 1.6GHz (2.0GHz Burst) processors of the Intel® Apollo Lake[™] System On Chip (SoC) platform. BM110 systems feature a robust and elegant aluminium chassis (100x100x58mm) and allow

book mounting and DIN rail installation mode. The "all in one" motherboard provides two Gigabit Ethernet ports, that support "Jumbo Frame" and "Wake on Lan" functionalities, two USB 3.0 ports, an M.2 2242 key B connector for a SATA III SSD, up to 8GB soldered LP-DDR4 RAM, two digital video input, two digital video output and

a Display port V1.2 video output. BM110 systems have an isolated 24 VDC power supply input and optionally an integrated UPS with external battery pack.



IPCs BM120, BM121 and BM122 are ultra - compact systems based on Intel® Atom[™] x5-3930 1.3GHz (1.8GHz Burst) and x7-E3950 1.6GHz (2.0GHz Burst) processors of the Intel® Apollo Lake[™] System On Chip (SoC) platform. The systems feature a robust and elegant aluminium chassis (100x100x78mm) and allow book mounting and DIN rail

installation mode. The motherboard provides an M.2 2242 key B connector for a SATA III SSD and up to 8GB soldered LP-DDR4 RAM. BM120 system has four Gigabit Ethernet ports, that support "Jumbo Frame" and "Wake on Lan" functionalities, four USB 3.0 ports, a serial RS232/422/485 interface, two digital video input, two digital video output and a Display port V1.2 video output.





• Highlights

- → UBIQUITY remote assistance software providing remote access to the system
- → Compact design (100x100x58mm)
- → "All in one" motherboard
- → Intel[®] Apollo Lake[™] SoC platform
- \rightarrow Fanless book mounting IPC with up to 0°C÷50°C operating temperature
- \rightarrow 24 VDC isolated power supply input
- → Integrated UPS with external battery pack (optional)
- → CE, cULus LISTED (61010) certifications



INSIDE

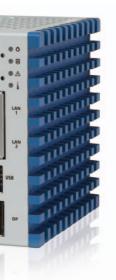
• Highlights

- → UBIQUITY remote assistance software providing remote access to the system
- → Compact design (100x100x78mm)
- → 24 VDC isolated power supply input
- → 4 ports Gigabit Ethernet switch (BM121)

- → CE, cULus LISTED (61010) certifications







BM121 system has two Gigabit Ethernet ports, that support "Jumbo Frame" and "Wake on Lan" functionalities, a four ports Gigabit Ethernet switch, four USB 3.0 ports, two digital video input, two digital video output and a Display port V1.2 video output.

BM122 system has two Gigabit Ethernet ports, that support "Jumbo Frame" and "Wake on Lan" functionalities, two USB 3.0 ports, two digital video

input, two digital video output, a Wi-Fi/Bluetooth interface, a 4G Global modem and a Display port V1.2 video output. BM120, BM121 and BM122 systems have an isolated 24 VDC power supply input and optionally an integrated UPS with external battery pack.

- → Intel[®] Apollo Lake[™] SoC platform
- \rightarrow Fanless book mounting IPC with up to 0°C÷50°C operating temperature
- → Wi-Fi/Bluetooth interface and 4G Global modem (BM122)
- → Integrated UPS with external battery pack (optional)

BM130 / BM131 [new]



The Book Mounting fanless IPCs BM130 and BM131 are ultra - compact systems based on Intel® Atom™ x5-3930 1.3GHz (1.8GHz Burst) and x7-E3950 1.6GHz (2.0GHz Burst) processors of the Intel[®] Apollo Lake[™] System On Chip (SoC) platform. The systems feature a robust and elegant aluminium chassis (100x100x100mm) and allow

book mounting and DIN rail installation mode. The motherboard provides an M.2 2242 key B connector for a SATA III SSD and up to 8GB soldered LP-DDR4 RAM. BM130 system has four Gigabit Ethernet ports, that support "Jumbo Frame" and "Wake on Lan" functionalities, four USB 3.0 ports, a serial RS232/422/485 interface, two

digital video input, two digital video output, a Display port V1.2 video output, a Wi-Fi/ Bluetooth interface and a 4G Global modem. BM131 system has two Gigabit have an isolated 24 VDC power Ethernet ports, that support "Jumbo Frame" and "Wake on Lan" functionalities, a four ports Gigabit Ethernet switch, four USB 3.0 ports, two digital

video input, two digital video

output, and a Display port V1.2 video output, a Wi-Fi/ Bluetooth interface and a 4G Global modem. BM130 and BM131 systems supply input and optionally an integrated UPS with external battery pack.



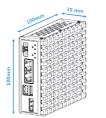
• Highlights

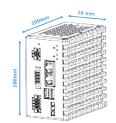
- \rightarrow UBIQUITY remote assistance software providing remote access to the system
- \rightarrow Compact design (100x100x100mm)
- → Intel[®] Apollo Lake[™] SoC platform
- \rightarrow Fanless book mounting IPC with up to 0°C÷50°C operating temperature
- \rightarrow 4 ports Gigabit Ethernet switch (BM131)
- → Wi-Fi/Bluetooth interface and 4G Global modem
- \rightarrow 24 VDC isolated power supply input
- → Integrated UPS with external battery pack (optional)
- → CE, cULus LISTED (61010) certifications

Technical Data

		BM100	BM110	BM120	BM121	BM122	BM130	BM131	
PROCESSOR ((coldorod)		Intel [®] Atom™ x5-	E3930 1.3GHz (1.8	3GHz Burst), 2 cor	es / 2 threads, 2M	IB L2 cache, 14nm		
PROCESSOR	(soluerea)		Intel [®] Atom [™] x7-	E3950 1.6GHz (2.0)GHz Burst), 4 cor	es / 4 threads, 2M	IB L2 cache, 14nm		
CHIPSET			I	ntel® Apollo Lake	- Included into p	rocessor chip (So	C)		
VIDEO CONTR	ROLLER			el [®] HD Graphics 50					
			Inte	el [®] HD Graphics 50)5 integrated in x7	7-E3950, 500/650I	MHz		
SYSTEM MEM	ORY								
	with x5-E3930				GB or 4GB LP-DDF				
	with x7-E3950			4	GB or 8GB LP-DDF	λ4			
MASS STORA	GE		1:	conboard connec	tor of M.2 size 224	12 key B SSD SATA	A III		
	10/100/1000 Mbps LAN port		5 ports el® I210)	4 x RJ45 ports (4 x Intel® I210)		5 ports el® I210)	4 x RJ45 ports (4 x Intel® I210)	2 x RJ45 ports (2 x Intel® I210	
LAN	10/100/1000 Mbps Ethernet switch		-		1 x unmanaged (Intel [®] I210) 4 x RJ45 ports		-	1 x unmanageo (Intel [®] I210) 4 x RJ45 ports	
USB			SB 3.0 ie-A)		SB 3.0 ne-A)	2 x USB 3.0 (Type-A)	4 x U (Typ	SB 3.0 e-A)	
SERIAL			-	1 x RS232/422/485 (DB9M)		-	1 x RS232/422/485 (DB9M)	-	
	Standard	-				IEEE 802.11 a/b/g/n + Bluetooth V4.0 LE/ V3.0+HS/ V2.1+EDR			
	Features	-				Client / Access Point mode (Wi-Fi)			
	Security	-				64/12	8-Abits WEP, WPA,	WPA2	
WI-FI	Rx Sensitivity			-	802.11a: -73dBm / 802.11g: -74dBm / 802.11n(2,4GHz): -72dBm@HT20, -69dBm@HT40 / 802.11n(5GHz): -69dBm@HT20, -68dBm@HT40 (Wi-Fi) <0.1% BER at -70dBm (Bluetooth)				
	Antenna			-		2 x RP-SMA-F			
CELLULAR	Standard	-				6/4G LTE CAT4 Mu os upload / 150Mb			
NETWORK	Antenna			-	1	x SMA-F connected	or		
	SIM	-				1x SIM o	ard socket push-p	ush type	
DIGITAL INPU	т	- 2 x Digital input							
DIGITAL OUTP	TUY	-			2 x Digit	al output			
VIDEO OUTPU	IT			1 x Dis	play Port V1.2 (no	audio)			
		24VDC (18÷32VDC) isolated							
POWER SUPPLY INPUT		Remote power up input Power status output							
POWER SUPPI	LY OPTIONS	-		Inte	egrated UPS with	external battery p	back		
	Installation	Book, wall or DIN rail mounting			Book or DIN	rail mounting			
CASE	Material	mounting	<u> </u>		Aluminium Alloy				
	Dimensions	100x100x39mm	100x100x58mm		100x100x78mm		100x100	x100mm	
O.S. CERTIFIED				I Microsoft Window	s 10 IoT Enterpris	e 2016/2019 64 b	it		
OPERATING T	EMPERATURE				0°÷50°C				
APPROVALS				CE,	cULus LISTED (61)	010)			

BM100



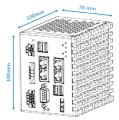


BM110

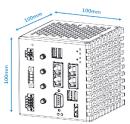




BM12x



BM13x



BM2150

Entry level Intel[®] Bay Trail[™] based fanless book mounting IPCs



The Book Mounting fanless IPC BM2150 is an entrylevel solution that offers an excellent performance/ price ratio. It is based on the Celeron J1900 2GHz quad core 64 bit processor of the Intel[®] Bay Trail[™] System On Chip (SoC) platform.

The "all in one" motherboard provides, on top, two Ethernet with one DDR3 SODIMM 10/100/1000Mbps ports, that module and an internal support "Jumbo Frame" and "Wake on Lan" functionalities, interfaces. one USB 3.0 port, one USB 2.0 BM2150 system has an port, a DVI-D video output and on front a SATA II CFast slot. The motherboard has also an mSATA connector for

SATA II SSD, up to 8 GB RAM connector for additional isolated 24 VDC power supply input and optionally an integrated UPS with external battery pack.



INSIDE

• Highlights

- \rightarrow UBIQUITY remote assistance software providing remote access to the system
- → Support to 32 or 64 bit operating systems
- → "All in one" motherboard
- → High performance Intel[®] Bay Trail[™] SoC platform
- \rightarrow Fanless book mounting IPC with 0°C÷50°C operating temperature
- → Optional DIN rail mounting
- → Isolated 24 VDC power supply input
- → Integrated UPS with external battery pack (optional)
- → Onboard connector for NETcore X fieldbus boards
- \rightarrow CE, cULus LISTED (61010) certifications

Gallery



Position A → 2 x RS232 \rightarrow 1 x USB 2.0 \rightarrow 1 x NETcore X fieldbus board → Wi-Fi/Bluetooth/Modem

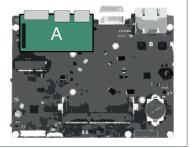
Technical data

	BM2150
PROCESSOR	Intel® Celeron J1900 2.00Ghz (2.42GHz Burst) a 64 bit, 4 cores / 4 threads, 2MB L2 cache, soldered
VIDEO CONTROLLER	Intel® HD Graphics integrated in microprocessor, 688MHz Clock 854MHz Turbo, LVDS 8bit/colour digital interface
SYSTEM MEMORY - RAM	1GB or 2GB or 4GB or 8GB (1 x SODIMM DDR3 module)
MASS STORAGE	1 bootable CFast SATA II slot onboard with front external access 1 x onboard connector for direct insertion of mSATA SSD SATA II
LAN	2 x LAN 10/100/1000Mbps top (RJ45 - 2 x Intel® I210)
USB	1 x USB 3.0 top (Type-A) 1 x USB 2.0 top (Type-A)
BATTERY	1 x CR2032 internal access
VIDEO OUTPUT	1 x DVI-D, top
ADD-ON INTERFACES	1 x RS232/422/485 (DB15M) + 1 x USB 2.0 (Type-A)
(max 1)	1 x RS232/422/485 (DB15M) isolated + 1 x USB 2.0 (Type-A)
	2 x RS232 (DB9M)
	1 x USB 2.0 (Type-A)
	1 x NETcore X fieldbus boards for EtherCAT, EtherNet IP, PROFINET, PROFIBUS, CANopen protocols
	1 x Wi-Fi/Bluetooth/Modem adapter
POWER SUPPLY INPUT	24VDC (18÷32VDC) isolated
POWER SUPPLY OPTION	UPS with external battery pack
	Kit for ATX mode power supply
CASE Installat	on For wall or DIN rail book mounting (optional)
Mate	ial Aluminium alloy 6082/5754/5056, Plastic front door
O.S. CERTIFIED	Microsoft Windows 7 Pro/Ultimate 32/64bit Microsoft Windows Embedded Standard 7E/7P 32/64 bit Microsoft Windows 8.1 Industry Pro 32/64bit Microsoft Windows 10 IoT Enterprise 2016/2019 64bit
OPERATING TEMPERATURE	0°C÷50°C
APPROVALS	CE, cULus LISTED (61010)



Add-On boards

 \rightarrow 1 x RS232/422/485 + 1 x USB 2.0 → 1 x RS232/422/485 isol. + 1 x USB 2.0



BM2200 Intel[®] Bay Trail[™] based fanless book mounting IPCs



The Book Mounting fanless IPCs of the BM2200 family are based on the Celeron J1900 2.0GHz quad core 64 bit processor of the Intel[®] Bay Trail[™] System On Chip (SoC) platform. BM2200 systems are supplied with a sturdy aluminum chassis, highly refined in every aesthetic and ergonomic

2.0 ports, a DVI-I (DVI-D + VGA) video output or, as an alternative, a Remote Video Link connector (RJ45) for the remotation of the video and USB signals up to 100 m; on front, a USB 3.0 port, a slot for a SATA II CFast, a slot for the extractable system battery integrated UPS with external The "all in one" motherboard and the signalling LEDs. The

Ethernet 10/100/1000Mbps

ports that support "Jumbo

Frame" and "Wake on Lan"

functionalities, two USB

motherboard provides also an mSATA connector for a SATA II SSD, a SATA II connector for a 2.5" SSD/HDD, the possibility to install up to 8 GB RAM with one DDR3 SODIMM module and an internal connector for the installation of additional interfaces. BM2200 systems have an isolated 24 VDC power supply input and optionally an

provides, on top, two

detail.



• Highlights

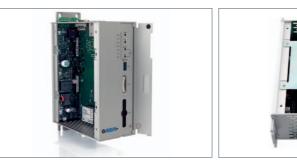
→ UBIQUITY remote assistance software providing remote access to the system

battery pack.

- → Highly refined aluminium chassis
- → Support to 32 or 64 bit operating systems
- \rightarrow "All in one" motherboard
- → High performance Intel[®] Bay Trail[™] SoC platform
- \rightarrow Fanless book mounting IPC with 0°C÷50°C operating temperature
- → Isolated 24 VDC power supply input
- → Integrated UPS with external battery pack (optional)
- → RVL version (Remote Video Link) with remotation of DVI and USB 2.0 signals up to 100m
- \rightarrow CE, cULus LISTED (61010) certifications

Industrial Automation | Industrial PC Solutions

Gallery



Technical data

	BM2200	BM2200 RVL					
PROCESSOR (soldered)	Intel [®] Celeron J1900 2.00Ghz (2.42GHz Burst)) a 64 bit, 4 cores / 4 threads, 2MB L2 cache					
VIDEO CONTROLLER	Intel® HD Graphics integrated in microprocessor, 688MHz Clock 854MHz Turbo, LVDS 8bit/colour digital interface						
SYSTEM MEMORY - RAM	1GB or 2GB or 4GB or 8GB (1 x SODIMM DDR3 module)						
ТРМ	TPM module	e (optional)					
MASS STORAGE	1 x bootable CFast SATA II slot onboa 1 x onboard connector for direct insertion of mSATA SSD SAT/ internal inst	A II or 1 x onboard connector for 2,5" SSD/HDD SATA II with					
LAN	2 x LAN 10/100/1000Mbp	os (RJ45 - 2 x Intel® I210)					
USB	1 x USB 3.0, fr 2 x USB 3.0, tr						
BATTERY	1 x CR2032 Remova	ble from the front					
VIDEO OUTPUT	1 x DVI-I top (DVI-D + VGA with adapter)	1 x RJ45 connector for the DVI-D and USB 2.0 signals remotation up to 100mt					
ADD-ON INTERFACES	1 x RS232/422/485 (DB15M) + 2 x RS232 (DB9M)						
(max 1)	1 x RS232/422/485 (DB15M) isolated + 2 x RS232 (DB9M)						
	1 x RS232/422/485 (DB15M) + 1 x LAN 10/100/1000Mbps (RJ45 - Intel® I210)						
	1 x RS232/422/485 (DB15M) isolated + 1 x LAN 10/100/1000Mbps (RJ45 - Intel® I210)						
POWER SUPPLY INPUT	24VDC (18÷32VDC) isolated						
POWER SUPPLY OPTIONS	UPS with externa	al battery pack					
CASE Installation	Wall book r	mounting					
Material	Aluminium alloy 6	6082/5754/5056					
O.S. CERTIFIED	Microsoft Windows 7 P Microsoft Windows Embedde Microsoft Windows 8.1 Microsoft Windows 10 IoT E	ed Standard 7E/7P 32/64 bit Industry Pro 32/64 bit					
OPERATING	0°C÷5	50°C					
TEMPERATURE	0°C÷45°C wit	h HDD 24x7					
APPROVALS	CE, cULus LIS	TED (61010)					







BM2250 [new]

Entry – level fanless book mouting IPCs based on Intel[®] Apollo Lake[™] platform





The Book Mounting fanless IPC BM2250 is an entrylevel solution that offers an excellent performance/ price ratio. It is based on the Atom[™] x5-3930 1.3GHz (1.80GHz Burst) or x7-3950 1.6GHz (2.00GHz Burst) processors of the Intel® Apollo Lake[™] System on Chip (SoC) platform.

The "all in one" motherboard provides, on top, two Gigabit Ethernet ports, that support "Jumbo Frame" and "Wake on Lan" functionalities, three USB 3.0 ports, a Display Port Dual Mode video output and, on front, a SATA III CFast slot. The motherboard has also a M.2 connector for a SATA III SSD, up to 8 GB LPDDR4 RAM

and an internal connector for additional interfaces. BM2250 system has an isolated 24 VDC power supply input and optionally an integrated UPS with external battery pack.



INSIDE

• Highlights

- → UBIQUITY remote assistance software providing remote access to the system
- → "All in one" motherboard
- → Intel[®] Apollo Lake [™] SoC platform
- \rightarrow Fanless book mounting IPC with 0°C÷50°C operating temperature
- \rightarrow Optional DIN rail mounting
- → Isolated 24 VDC power supply input
- → Integrated UPS with external battery pack (optional)
- → Onboard connector for NETcore X fieldbus boards
- → CE, cULus LISTED (61010) certifications

Gallery



Po	sition A
\rightarrow	1 x RS232/42
\rightarrow	1 x RS232/42
\rightarrow	2 x RS232/42
\rightarrow	2 x RS232/42
\rightarrow	2 x RS232
\rightarrow	1 x LAN Giga
\rightarrow	2 x USB 2.0
\rightarrow	1 x NETcore >
\rightarrow	Wireless/Blue

Technical data

	BIVI2230
PROCESSOR (soldered)	Intel® Atom™ x5-E3930 1.3GHz (1.8GHz Burst), 2 cores / 2 threads, 2MB L2 cache, 14nm Intel® Atom™ x7-E3950 1.6GHz (2.0GHz Burst), 4 cores / 4 threads, 2MB L2 cache, 14nm
CHIPSET	Intel® Apollo Lake - Included into processor chip (SoC)
VIDEO CONTROLLER	"Intel® HD Graphics 500 integrated in x5-E3930, 400/550MHz Intel® HD Graphics 505 integrated in x7-E3950, 500/650MHz
SYSTEM MEMORY RAM (soldered)	
with x5-E3930	4GB LP-DDR4
with x7-E3950	4GB or 8GB LP-DDR4
MASS STORAGE	1 bootable CFast SATA II slot onboard with front external access 1 x onboard connector for M.2 2242 SATAIII SSD
LAN	2 x Gigabit Ethernet top (RJ45 - 2 x Intel® I210-AT)
USB	3 x USB 3.0 top (Type-A)
BATTERY	1 x CR2032 internal access
VIDEO OUTPUT	1 x Display Port V1.2 (no audio)
ADD-ON INTERFACES	1 x RS232/422/485 (DB15M)+ 1 x USB 2.0 (Type-A)
	1 x RS232/422/485 (DB15M) isolated + 1 x USB 2.0 (Type-A)
	2 x RS232/422/485 (DB9M)
	2 x RS232/422/485 (DB9M) isolated
	2 x RS232 (DB9M)
	2 x USB 2.0 (Type-A)
	1 x Gigabit Ethernet (RJ45 - Intel® I210) + 1 x USB 2.0 (Type-A)
	1 x NETcore X fieldbus boards for EtherCAT, EtherNet IP, PROFINET, PROFIBUS, CANopen protocols
	1 x Wireless/Bluetooth/Modem adapter
POWER SUPPLY INPUT	24VDC (18÷32VDC) isolated
POWER SUPPLY OPTIONS	UPS with external battery pack
	Kit for ATX mode power supply
CASE Installation	For wall or DIN rail book mounting (optional)
Material	Aluminium alloy 6082/5754/5056, Plastic front door
O.S. CERTIFIED	Microsoft Windows 10 IoT Enterprise 2016/2019 64bit
OPERATING TEMPERATURE	0°C÷50°C
APPROVALS	CE, cULus LISTED (61010)

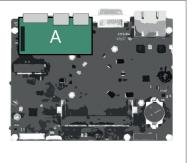


Add-On boards

22/485 + 1 x USB 2.0 22/485 isol. + 1 x USB 2.0 22/485 22/485 isol.

abit + 1 x USB 2.0

X fieldbus board etooth/Modem



BM3300 / BM3500

Intel[®] Skylake[™] U and Kaby Lake[™] U based fanless book mounting IPCs





The fanless Book Mounting IPC family BM3300 is based on the 6th generation Core i3, i5, i7 and Celeron dual core 15W processors of the Intel[®] Skylake[™] U and the BM3500 family is based on the 7th generation Core i3, i5, i7 and Celeron dual core 15W 3.0 ports and one DVI-D processors of the Intel[®] Kaby video output or, as an Lake[™] U platform. The systems are supplied with Link connector (RJ45) for a sturdy aluminum chassis, highly refined in every

aesthetic and ergonomic detail. The "all in one" motherboard provides, on top, three Ethernet 10/100/1000Mbps ports that support "Jumbo Frame" and "Wake on Lan" functionalities, two USB alternative, a Remote Video the remotation of the video and USB signals up to 100

m; on front, a USB 3.0 port, a SATA III CFast slot, a slot for the extractable system battery and the signalling LEDs. The motherboard has also an mSATA connector for a SATA III SSD, one SATA III connector for a 2.5" SSD/ HDD, up to 16 GB RAM with one DDR4 SODIMM module and an internal connector for additional interfaces. The systems have an isolated 24 VDC power supply input

an UP

pag

nd on	tionally	an i	ntoar	bate	

iu optionally an integrated	
PS with external battery	
ack.	

Gallery

Add-On boards



Position A \rightarrow 2 x RS232 → 2 x USB 2.0 \rightarrow 1 x NETcore X fieldbus board

Technical data

		BM3300/BM3500	BM3300 RVL/BM3500 RVL
PROCESSORS (soldered)	BM3300	Intel [®] Celeron 3955U 2.00GHz 64bit, 2 Intel [®] Core i3-6100U 2.30GHz 64bit, 2 Intel [®] Core i5-6300U 2.40GHz (3.00GHz Turbo Intel [®] Core i7-6600U 2.60GHz (3.40GHz Turbo	2 cores / 4 threads, 3MB Smart cache) 64bit, 2 cores / 4 threads, 3MB Smart cache
	BM3500	Intel® Celeron 3965U 2.20GHz 64bit, 2 Intel® Core i3-7100U 2.40GHz 64bit, 2 Intel® Core i5-7300U 2.60GHz (3.50GHz Turbo Intel® Core i7-7600U 2.80GHz (3.90GHz Turbo	2 cores / 4 threads, 3MB Smart cache) 64bit, 2 cores / 4 threads, 3MB Smart cache
CHIPSET	BM3300	Intel [®] Skylake U PCH (Platform Controller Hul	o) for BM3300 - Included into processor chip
	BM3500	Intel [®] Kaby Lake U PCH (Platform Controller Hu	ub) for BM3500 • Included into processor chip
VIDEO CONTROLI	LER BM3300	Intel® HD Graphics 510 integrated in Celeron processor • Intel® HD Graphics 520 integrated in Core i3, Core i5 process Intel® HD Graphics 520 integrated in Core i7 processor •	sors • 300MHz/1GHz • DirectX 12 and OpenGL 4.4 support
	BM3500	Intel [®] HD Graphics 620 integrated in Core i3 processors Intel [®] HD Graphics 620 integrated in Core i5 processors Intel [®] HD Graphics 620 integrated in Core i7 processor	300MHz/1.1GHz • DirectX 12 and OpenGL 4.5 support
SYSTEM MEMORY - RAM		4GB or 8GB or 16GB (1 x SODIMM DDR4 module)	
ТРМ		TPM module (optional)	
MASS STORAGE		1 bootable CFast SATA III slot onb 1 x onboard connector for direct 1 x onboard connector for 2,5" SSD/HE	insertion of mSATA SSD SATA III
LAN		3 x LAN 10/100/1000Mbps (RJ45 -	2 x Intel® I210, 1 x Intel® I219LM)
USB		1 x USB 3.0, front (Type-A) 2 x USB 3.0, top (Type-A)	
BATTERY		1 x CR2032 Removable front access	
VIDEO OUTPUT		1 x DVI-D	1 x RJ45 connector for the DVI-D and USB 2.0 signals emotation up to 100 m
ADD-ON INTERFACES		1 x RS232/422/485 (DB15M) + 1 x USB 2.0 (Type-A)	
		1 x RS232/422/485 (DB15M) isolated + 1 x USB 2.0 (Type-A)	
Position A (max 1)		2 x RS232 (DB9M)	
		2 x USB 2.0 (Type-A)	
		1 x LAN 10/100/1000Mbps (RJ45 - Intel® I210) + 1 x USB 2.0 (Type-A)	
		1 x NETcore X fieldbus boards for EtherCAT, EtherNet IP, PROFINET, PROFIBUS, CANopen protocols	
POWER SUPPLY		24VDC (18÷32VDC) isolated	
POWER SUPPLY		UPS with external battery pack	
CASE Ir	nstallation	Wall book mounting	
	Material	Aluminium alloy 6082/5754/5056	
O.S. CERTIFIED	BM3300	Microsoft Windows 7 Pro/Ultimate 32/64bit Microsoft Windows Embedded Standard 7E/7P 32/64 bit Microsoft Windows 8.1 Industry Pro 32/64bit Microsoft Windows 10 IoT Enterprise 2016/2019 64bit	
	BM3500	Microsoft Windows 10 IoT I	Enterprise 2016/2019 64bit
OPERATING		0°C÷50°C	
TEMPERATURE		0°C÷45°C wit	h HDD 24x7
APPROVALS		CE, cULus LIS	TED (61010)





• Highlights

- → UBIQUITY remote assistance software providing remote access to the system
- → Highly refined aluminium chassis
- → "All in one" motherboard
- → Low consumption Intel[®] Skylake[™] U (BM3300) and Kaby Lake[™] U (BM3500) platforms
- \rightarrow Fanless book mounting IPC with 0°C÷50°C operating temperature
- → Isolated 24 VDC power supply input
- → Onboard connector for NETcore X fieldbus boards
- → Integrated UPS with external battery pack (optional)
- → RVL version (Remote Video Link) with remotation of DVI and USB 2.0 signals up to 100 m
- \rightarrow CE, cULus LISTED (61010) certifications



 \rightarrow 1 x RS232/422/485 + 1 x USB 2.0 → 1 x RS232/422/485 isol. + 1 x USB 2.0



@ASEA+

BM3400 / BM3600

Intel[®] Skylake[™] H and Kaby Lake[™] H based fanless book mounting IPCs



The fanless Book Mounting IPC family BM3400 is based on the 6th generation Core i3, i5, i7 and Celeron of the Intel® Skylake[™] H and the BM3600 family is based on the 7th generation Core i3, i5, i7 of the output; on front, a USB 3.0 Intel[®] Kaby Lake[™] H platform. The systems are supplied with a sturdy aluminum chassis, highly refined in every aesthetic and ergonomic detail.

The "all in one" motherboard provides, on top, four Ethernet for a SATA III SSD, two SATA

10/100/1000Mbps ports, that support "Jumbo Frame" and "Wake on Lan" functionalities, two USB 3.0 ports, two USB 2.0 ports, a serial RS232 interface and one DVI-D video DDR4 SODIMM modules and port, a SATA III CFast slot, a slot for the extractable system battery, the signalling LEDs and optionally two slots for extractable storage units drawers. The motherboard has also an mSATA connector

III connector for 2.5" SSDs/ HDDs, the possibility to set the mass storage devices in RAID 0, 1 configuration, up to 32 GB RAM with two two internal connectors for additional interfaces, including slots. the remotation of the video and USB signals up to 100m (Remote Video Link). BM3400 and BM3600 systems temperature with Core i7 have an isolated 24 VDC power supply input and optionally an integrated UPS

with external battery pack. The systems are available in two versions, the S0 with the possibility to install additional interfaces, the S2 and the S3 with respectively two and three PCI or PCIe expansion

Optionally a forced ventilation kit is available to ensure 0°C÷50°C operating processor or expansions cards with a maximum total consumption of 20W.



• Highlights

- → UBIQUITY remote assistance software providing remote access to the system
- \rightarrow Highly refined aluminium chassis
- → Extractable drawers for 2.5" storage devices
- → RAID 0,1
- \rightarrow Up to 2 Remote Video Link remotation of DVI and USB 2.0 signals up to 100m
- → "All in one" motherboard
- → High performance Intel[®] Skylake[™] H and Kaby Lake[™] H platforms
- \rightarrow Fanless book mounting IPC with 0°C÷50°C operating temperature
- → Isolated 24 VDC power supply input
- → Onboard connector for NETcore X fieldbus boards
- → Integrated UPS with external battery pack (optional)
- \rightarrow S2 version with two PCI or PCIe 4x expansion slots
- → CE, cULus LISTED (61010) certifications

Gallery

Add-On boards



Position A		
→ 1 x RS232/422		
→ 1 x RS232/422		
→ 2 x RS232		
→ 2 x USB 2.0		
\rightarrow 1 x NETcore X		
Position B		
→ 1 x RJ45 Remo		

Technical data

		BM3400/BM3600
PROCESSORS		Intel [®] Celeron G3900E 2.40GHz 64bit, 2 cores / 2 threads, 2MB Smart cache
	BM3400	Intel [®] Core i3-6100E 2.70GHz 64bit, 2 cores / 4 threads, 3MB Smart cache
	DIVI3400	Intel® Core i5-6440EQ 2.70GHz (3.40GHz Turbo) 64bit, 4 cores / 4 threads, 6MB Smart cache
		Intel® Core i7-6820EQ 2.80GHz (3.50GHz Turbo) 64bit, 4 cores / 8 threads, 8MB Smart cache
	BM3600	Intel [®] Core i3-7100E 2.90GHz 64bit, 2 cores / 4 threads, 3MB Smart cache Intel [®] Core i5-7440EQ 2.90GHz (3.60GHz Turbo) 64bit, 4 cores / 4 threads, 6MB Smart cache
	BIVI3600	Intel [®] Core i7-7820EQ 2.90GHz (3.00GHz Turbo) 64bit, 4 cores / 4 threads, 6MB Smart cache Intel [®] Core i7-7820EQ 3.00GHz (3.70GHz Turbo) 64bit, 4 cores / 8 threads, 8MB Smart cache
CHIPSET	BM3400	Intel® HM170 PCH (Platform Controller Hub)
	BM3600	Intel® HM175 PCH (Platform Controller Hub)
S2/S3 versions with 2		Intel [®] CM236 PHC (Platform Controller Hub)
VIDEO CONTROLLER	x PCIe X4	Intel® HD Graphics 510 integrated in Celeron processor • 350MHz/950MHz • DirectX 12 and OpenGL 4.4 support
	BM3400	Intel® HD Graphics 530 integrated in Core i3 processor • 350MHz/950MHz • DirectX 12 and OpenGL 4.4 support Intel® HD Graphics 530 integrated in Core i5, Core i7 processors • 350MHz/1,00GHz • DirectX 12 and OpenGL 4.4 support
	BM3600	Intel® HD Graphics 630 integrated in Core i3 processor • 350MHz/950MHz • DirectX 12 and OpenGL 4.5 support Intel® HD Graphics 630 integrated in Core i5, Core i7processors • 350MHz/1,00GHz • DirectX 12 and OpenGL 4.5 support
SYSTEM MEMORY - R	AM	4GB (1 x SODIMM DDR4 module) or 8GB or 16GB or 32GB (2 x SODIMM DDR4 modules)
ТРМ		TPM module (optional)
MASS STORAGE		1 x bootable CFast SATA III slot onboard with external access
		1 x onboard connector for direct insertion of mSATA SSD SATA III
	S 0	w/o RVL: onboard connectors for 1 x SSD/HDD 2.5" SATA III with internal installation kit or max 2 x SSDs/HDDs 2.5" SATA III with front extractable drawers
		with RVL: onboard connector for 1 x SSD/HDD 2.5" SATA III with internal installation kit or with front extractable drawer
		1 x bootable CFast SATA III slot onboard with external access
	S2/S3	1 x onboard connector for direct insertion of mSATA SSD SATA III
		2 x onboard connectors for SSDs/HDDs 2.5" SATA III with internal installation kit or with front extractable drawers
LAN		4 x LAN 10/100/1000Mbps top (RJ45 - 3 x Intel® I210 + 1 x Intel® I219LM)
USB		1 x USB 3.0 front (Type-A)
		2 x USB 2.0 top (Type-A) + 2 x USB 3.0 top (Type-A)
SERIAL		1 x RS232 (DB9M)
BATTERY		1 x CR2032 Removable front access
VIDEO OUTPUT		1 x DVI-D, top 1 or 2 x RJ45 connectors Remote Video Link (DVI-D and USB 2.0 signals remotation up to 100 m, optional)
ADD-ON INTERFACES	S	1 x RS232/422/485 (DB15M) + 1 x USB 2.0 (Type-A)
	-	1 x RS232/422/485 (DB15M) isolated + 1 x USB 2.0 (Type-A)
n	osition A	2 x RS232 (DB9M)
P		2 x USB 2.0 (Type-A)
	(max 1)	1 x NETcore X fieldbus boards for EtherCAT, EtherNet IP, PROFINET, PROFIBUS, CANopen protocols
D	osition B	1 x connector Remote Video Link (RJ45 - RVL OUT)
	(max 1)	2 x connectors Remote Video Link (RJ45 - RVL OUT)
EXPANSION SLOTS	(max 1) S2	2 x PCIe x4 or 1 x PCI + 1 x PCIe x4, max 10W total
	S3	2 x PCIe x4 + 1 x PCIe x1, max 10W total
VENTILATION (option		Forced ventilation kit for 0°C÷50°C operating temperature with Core i7 processorsor expansion card with max 20W total
POWER SUPPLY INPL	IT	24VDC (18÷32VDC) isolated
POWER SUPPLY OPT		UPS with external battery pack
POWER SUPPLY OPIN		Kit for ATX mode power supply
CASE In:	stallation	For book mounting
	Material	Aluminium Alloy 6082/5754/5056
O.S. CERTIFIED		Microsoft Windows 7 Pro/Ultimate 32/64bit
	BM3400	Microsoft Windows Embedded Standard 7E/7P 32/64 bit Microsoft Windows 10 IoT Enterprise 2016/2019 64bit
	BM3600	Microsoft Windows 10 IoT Enterprise 2016/2019 64bit
OPERATING TEMPER	ATURE	without forced ventilation: 0°C÷50°C, 0°C÷45°C with HDD 24x7 or Core i7
		with forced ventilation: 0°C÷50°C, 0°C÷45°C with HDD 24x7
APPROVALS		CE, cULus LISTED (61010)

Book Mounting IPC



2/485 + 1 x USB 2.0 2/485 isol. + 1 x USB 2.0

fieldbus board

ote Video Link (RVL OUT) → 2 x RJ45 Remote Video Link (RVL OUT)



Box IPCs

ASEM provides a full range of Box IPCs in terms of configurability, dimensions and performances. They are based on Celeron, Core[™] i3, i5, i7 dual and quad core processors of the Intel[®] Bay Trail[™], Broadwell[™], Skylake[™] and Kaby Lake[™] platforms, and they are suitable for wall or DIN rail mounting.



PB2150 Intel[®] Bay Trail[™] based fanless box IPCs



The fanless box IPC family PB2150 is an entry-level performance/price ratio. It is based on the Celeron J1900 2GHz guad core 64 bit processor of the Intel[®] Bay Trail[™] System On Chip (SoC) platform. The "all in one" motherboard provides two Ethernet . 10/100/1000Mbps ports, that

support "Jumbo Frame" and "Wake on Lan" functionalities, system that offers an excellent a USB 3.0 port, a USB 2.0 port, a DVI-D video output and a SATA II CFast slot with external battery pack. The systems are access, an mSATA connector for SATA II SSD, up to 8 GB RAM with one DDR3 SODIMM the S0 with the possibility to module and an internal connector for additional interfaces.

PB2150 systems have an isolated 24 VDC power supply input and optionally an integrated UPS with external available in two versions, the SL with a reduced depth and install additional interfaces.



UBIQUITY

INSIDE

• Highlights

- → UBIQUITY remote assistance software providing remote access to the system
- → Support to 32 or 64 bit operating systems
- \rightarrow "All in one" motherboard
- → High performance Intel[®] Bay Trail[™] SoC platform
- \rightarrow Fanless box IPC with 0°C÷50°C operating temperature
- → Isolated 24 VDC power supply input
- → Onboard connector for NETcore X fieldbus boards
- → Integrated UPS with external battery pack (optional)
- \rightarrow SL version with reduced depth
- \rightarrow CE, cULus LISTED (61010) certifications

Gallery

Add-On boards



Position A → 2 x RS232

→ 1/2 x USB 2.0 \rightarrow 1 x LAN Gigabit + 1 x USB 2.0

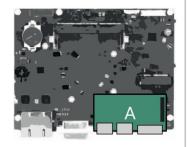
Technical data

	PB2150		
PROCESSOR	Intel® Celeron® Processor J1900 2.00Ghz (2.42GHz Burst) a 64 bit, 4 cores / 4 threads, 2MB L2, 22nm technology		
VIDEO CONTROLLER	Intel® HD Graphics integrated in microprocessor, 688MHz Clock 854MHz Turbo, LVDS 8bit/colour digital interface		
SYSTEM MEMORY - RAM	1GB or 2GB or 4GB or 8GB (1 x SODIM DDR3 module)		
MASS STORAGE	1 bootable CFast SATA II slot onboard with external access 1 x onboard connector for direct insertion of mSATA SSD SATA II		
LAN	2 x LAN 10/100/1000Mbps (RJ45 - 2 x Intel® I210)		
USB	1 x USB 3.0 rear (Type-A) 1 x USB 2.0 rear (Type-A)		
VIDEO OUTPUT	1 x DVI-D		
ADD-ON INTERFACES	1 x RS232/422/485 (DB15M) + 1 x USB 2.0 (Type-A)		
(only for S0, max 1)	1 x RS232/422/485 (DB15M) isolated + 1 x USB 2.0 (Type-A)		
	2 x RS232 (DB9M)		
	1 x USB 2.0 (Type-A)		
	2 x USB 2.0 (Type-A)		
	1 x LAN 10/100/1000Mbps (RJ45 - Intel®I210) + 1 x USB 2.0		
	1 x NETcore X fieldbus boards for EtherCAT, EtherNet IP, PROFINET, PROFIBUS, CANopen protocols		
	1 x Wi-Fi/Bluetooth/Modem adapter		
POWER SUPPLY INPUT	24VDC (18÷32VDC) isolated		
POWER SUPPLY OPTIONS	UPS with external battery pack Kit for ATX mode power supply		
O.S. CERTIFIED	Microsoft Windows 7 Pro/Ultimate 32/64 bit, Microsoft Windows Embedded Standard 7E/7P 32/64 bit, Microsoft Windows 8.1 Industry Pro 32/64 bit, Microsoft Windows 10 IoT Enterprise 2016/2019 64 bit		
OPERATING TEMPERATURE	0°C÷50°C		
APPROVALS	CE, cULus LISTED (61010)		



→ 1 x RS232/422/485 + 1 x USB 2.0 → 1 x RS232/422/485 isol. + 1 x USB 2.0

 \rightarrow 1 x NETcore X fieldbus board → Wi-Fi/Bluetooth/Modem



PB2200 Intel[®] Bay Trail[™] based fanless box IPCs



The fanless box IPC family PB2200 is based on the Celeron J1900 2GHz quad core 64 bit processor of the Intel[®] Bay Trail[™] System On Chip (SoC) platform. The "all in one" motherboard provides two Ethernet 10/100/1000Mbps ports, that support "Jumbo Frame" and "Wake on Lan" functionalities, one USB 3.0 port, two USB 2.0

ports, a serial RS232 interface, PB2200 systems have an a DVI-I (DVI-D + VGA) video output and a SATA II CFast slot with external access, an mSATA connector for SATA II SSD, one SATA II connector for the installation of 2.5" HDD/ SSD, up to 8 GB RAM with one a reduced depth, the S0 DDR3 SODIMM module and two internal connectors for additional interfaces.

isolated 24 VDC power supply input and optionally an integrated UPS with external battery pack. The systems are available in three versions, the SL with with the possibility to install additional interfaces and the S1 with a PCI or PCIe x1 slot.



• Highlights

- → UBIQUITY remote assistance software providing remote access to the system
- → Support to 32 or 64 bit operating systems
- → "All in one" motherboard
- → High performance Intel[®] Bay Trail[™] SoC platform
- \rightarrow Fanless box IPC with 0°C÷50°C operating temperature
- → Isolated 24 VDC power supply input
- → Onboard connector for NETcore X fieldbus boards
- → Integrated UPS with external battery pack (optional)
- \rightarrow SL version with reduced depth
- \rightarrow S1 version with one PCI or PCIe x1 expansion slot
- → CE, cULus LISTED (508) certifications

Gallery



Position A



→ 2 x RS232 → 2 x USB 2.0 **Position B** → 1 x LAN Gigabit \rightarrow 1 x NETcore X fieldbus board

Technical data

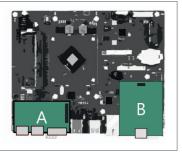
	PB2200			
PROCESSOR	Intel® Celeron J1900 2.0Ghz (2.42Ghz Burst) 64 bit, 4 cores / 4 threads, 2MB L2 cache, soldered			
VIDEO CONTROLLER	Intel® HD Graphics integrated in microprocessor, 688MHz Clock 854MHz Turbo, LVDS 8bit/colour digital interface			
SYSTEM MEMORY - RAM	1GB or 2GB or 4GB or 8GB (1 x SODIMM DDR3 module)			
MASS STORAGE 1 bootable CFast SATA II slot onboard with external access SL/S0/S1 1 x onboard connector for direct insertion of mSATA SSD SATA II				
S0/S1	1 x bootable CFast SATA II slot on board with external access 1 x onboard connector for 2,5" SSD/HDD 24x7 SATA II with internal installation kit			
LAN	2 x LAN 10/100/1000Mbps (RJ45 - 2 x Intel® I210)			
USB	1 x USB 3.0 rear (Type-A) 2 x USB 2.0 rear (Type-A)			
SERIAL	1 x RS232 (DB9M)			
VIDEO OUTPUT	1 x DVI-I (DVI-D + VGA with adapter)			
ADD-ON INTERFACES	1 x RS232/422/485 (DB15M)+ 1 x USB 2.0 (Type-A)			
(only for S0/S1) Position A	1 x RS232/422/485 (DB15M) isolated + 1 x USB 2.0 (Type-A)			
(max 1)	2 x RS232 (DB9M)			
	2 x USB 2.0 (Type-A)			
Position B	1 x LAN 10/100/1000Mbps (RJ45 - Intel® I210)			
(max 1)	1 x NETcore X fieldbus boards for EtherCAT, EtherNet IP, PROFINET, PROFIBUS, CANopen protocols			
	1 x Wi-Fi/Bluetooth/Modem adapter			
EXPANSION SLOTS S1	1 x PCI / PCIe x1			
POWER SUPPLY INPUT	24VDC (18÷32VDC) isolated			
POWER SUPPLY OPTIONS	UPS with external battery pack Kit for ATX mode power supply			
O.S. CERTIFIED	Microsoft Windows 7 Pro/Ultimate 32/64 bit Microsoft Windows Embedded Standard 7E/7P 32/64 bit Microsoft Windows 8.1 Industry Pro 32/64 bit Microsoft Windows 10 IoT Enterprise 2016/2019 64 bit			
OPERATING	0°C÷50°C			
TEMPERATURE	0°C÷45°C with 24x7 HDD			
APPROVALS	CE, cULus LISTED (508)			





→ 1 x RS232/422/485 + 1 x USB 2.0 → 1 x RS232/422/485 isol. + 1 x USB 2.0

→ Wi-Fi/Bluetooth/Modem



@ASEA+

PB2250 [new]

Entry-level compact box IPCs based on Intel[®] Apollo Lake[™] platform



The fanless Box IPC family PB2250 is based on the Intel® Atom[™] x5-3930 1.3GHz (1.80GHz Burst) or x7-3950 1.6GHz (2.00GHz Burst) processors of the Intel® Apollo Lake[™] System on Chip (SoC) platform. The "all in one" motherboard provides two Gigabit Ethernet

ports, that support "Jumbo Frame" and "Wake on Lan" functionalities, three USB 3.0 ports, a Display Port dual mode integrated UPS with external video output, a SATA III CFast slot with rear external access, an M.2 connector for a SATA III SSD, up to 8 GB RAM LPDDR4 and one internal connector for additional interfaces.

PB2250 systems have an isolated 24 VDC power supply input and optionally an battery pack. The systems are available in two versions, the SL with a reduced depth and the S0 with the possibility to install additional interfaces.



• Highlights

- → UBIQUITY remote assistance software providing remote access to the system
- → Intel® Apollo Lake[™] SoC platform
- → "All in one" motherboard
- \rightarrow Fanless box IPC with 0°C÷50°C operating temperature
- → Isolated 24 VDC power supply input
- → Integrated UPS with external battery pack (optional)
- → Onboard connector for NETcore X fieldbus boards
- \rightarrow SL version with reduced depth
- → CE, cULus LISTED (61010) certifications

Gallery

Add-On boards



Position A
→ 1 x RS232/42
→ 1 x RS232/42
→ 2 x RS232/42
→ 2 x RS232/42
→ 2 x RS232
→ 1 x LAN Gigal
→ 2 x USB 2.0
→ 1 x NETcore X
→ Wireless/Blue

Technical data

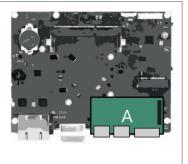
	FD223V		
PROCESSOR	Intel® Atom™ x5-E3930 1.3GHz (1.8GHz Burst), 2 cores / 2 threads, 2MB L2 cache, 14nm Intel® Atom™ x7-E3950 1.6GHz (2.0GHz Burst), 4 cores / 4 threads, 2MB L2 cache, 14nm		
CHIPSET	Intel® Apollo Lake - Included into processor chip (SoC)		
VIDEO CONTROLLER	Intel® HD Graphics 500 integrated in x5-E3930, 400/550MHz Intel® HD Graphics 505 integrated in x7-E3950, 500/650MHz		
SYSTEM MEMORY RAM (SOLDERED) with x5-E3950	4GB LP-DDR4		
with x7-E3950	4GB or 8GB LP-DDR4		
MASS STORAGE	"1 x bootable CFast SATA III slot onboard with external access 1 x onboard connector for direct insertion of M.2 SATA III SSD"		
LAN	2 x LAN 10/100/1000Mbps (RJ45 - 2 x Intel® I210)		
USB	3 x USB 3.0 rear (Type-A)		
VIDEO OUTPUT	1 x Display Port V1.2		
ADD-ON INTERFACES	1 x RS232/422/485 (DB15M)+ 1 x USB 2.0 (Type-A)		
(only for S0, max 1)	1 x RS232/422/485 (DB15M) isolated + 1 x USB 2.0 (Type-A)		
	2 x RS232/422/485 (DB9M)		
	2 x RS232/422/485 (DB9M) isolated		
	2 x RS232 (DB9M)		
	2 x USB 2.0 (Type-A)		
	1 x LAN 10/100/1000Mbps (RJ45 - Intel® I210) + 1 x USB 2.0		
	1 x NETcore X fieldbus boards for EtherCAT, EtherNet IP, PROFINET, PROFIBUS, CANopen protocols		
	1 x Wireless/Bluetooth/Modem adapter		
POWER SUPPLY INPUT	24VDC (18÷32VDC) isolated		
POWER SUPPLY OPTIONS	"UPS with external battery pack Kit for ATX mode power supply"		
O.S. CERTIFIED	Microsoft Windows 10 IoT Enterprise 2016/2019 64 bit		
OPERATING TEMPERATURE	0°C÷50°C		
APPROVALS	CE, cULus LISTED (61010)		



22/485 + 1 x USB 2.0 22/485 isol. + 1 x USB 2.0 22/485 22/485 isol.

abit + $1 \times USB 2.0$

fieldbus board etooth/Modem



PB2250



The fanless box IPC family PB3200 is based on the fifth generation Core i3, i5, i7 and Celeron of the Intel® Broadwell™ U platform. The "all in one" motherboard provides three Ethernet 10/100/1000Mbps ports, that support "Jumbo Frame" and "Wake on Lan" functionalities, two USB 3.0 ports, one USB 2.0 port, a serial RS232

interface, a DVI-I (DVI-D + VGA) video output and a SATA isolated 24 VDC power supply III CFast slot with external access, an mSATA connector for SATA III SSD, one SATA III connector for the installation of 2.5" HDD/SSD, up to 16 GB RAM with one DDR3 SODIMM a reduced depth, the SO module and two internal connectors for additional interfaces.

PB3200 systems have an input and optionally an integrated UPS with external battery pack. The systems are available in three versions, the SL with with the possibility to install additional interfaces and the S1 with a PCI or PCIe x4 slot.



INSIDE

• Highlights

- → UBIQUITY remote assistance software providing remote access to the system
- → "All in one" motherboard
- → 15W processors Intel[®] Broadwell[™] U platform
- \rightarrow Fanless box IPC with 0°C÷50°C operating temperature
- → Isolated 24 VDC power supply input
- → Onboard connector for NETcore X fieldbus boards
- → Integrated UPS with external battery pack (optional)
- \rightarrow SL version with reduced depth
- \rightarrow S1 version with one PCI or PCIe x4 expansion slot
- → CE, cULus LISTED (61010) certifications

Gallery

Add-On boards



-	→ 1 x RS232/42
	→ 1 x RS232/42
-	→ 2 x RS232
-	→ 2 x USB 2.0
F	Position B
	Position B → 1 x LAN Giga
-	
-	→ 1 x LAN Giga

Position A

Technical data

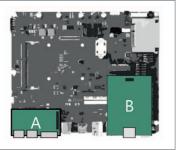
	PB3200			
PROCESSORS	Intel® Celeron 3765U 1,9Ghz, 2 cores - 2 threads - 2MB smart cache - 15W Intel® Core™ i3-5010U 2,1Ghz, 2 cores - 4 threads - 3MB smart cache - 15W Intel® Core™ i5-5350U 1,8Ghz (2,9GHz Turbo), 2 cores - 4 threads - 3MB smart cache - 15W Intel® Core™ i7-5650U 2,2Ghz (3,1GHz Turbo), 2 cores - 4 threads - 4MB smart cache - 15W			
CHIPSET	Intel® Broadwell PCH-LP (Platform Controller Hub - Low Power) - Included into processor chip			
VIDEO CONTROLLER	Intel® HD Graphics integrated in microprocessor Celeron 3765U, 850MHz Clock Intel® HD Graphics 5500 integrated in microprocessor i3, 900MHz Clock Intel® HD Graphics 6000 integrated in microprocessor i5, i7, 1GHz Clock with LVDS 8bit/colour digital interface			
SYSTEM MEMORY - RAM	2GB or 4GB or 8GB or 16GB (1 x SODIMM DDR3 module)			
MASS STORAGE SL/S0/S1	1 x bootable CFast SATA II slot onboard with external access 1 x onboard connector for direct insertion of mSATA SSD SATA III			
S0/S1	1 x bootable CFast SATA II slot onboard with external access 1 x onboard connector for 2.5" SSD/HDD SATA III with internal installation kit			
LAN	3 x Ethernet 10/100/1000 Mbps (RJ45 - 2 x Intel® I210-AT, 1 x Intel® I218-LM)			
USB	2 x USB 3.0 (Type-A) 1 x USB 2.0 (Type-A)			
SERIAL	1 x RS232 (DB9M)			
VIDEO OUTPUT	1 x DVI-I			
ADD-ON INTERFACES	1 x RS232/422/485 (DB15M)+ 1 x USB 2.0 (Type-A)			
(only S0/S1) Position A	1 x RS232/422/485 (DB15M) isolated + 1 x USB 2.0 (Type-A)			
(max 1)	2 x RS232 (DB9M)			
	2 x USB 2.0 (Type-A)			
Position B	1 x LAN 10/100/1000Mbps (RJ45 - Intel® I210)			
(max 1)	1 x NETcore X fieldbus boards for EtherCAT, EtherNet IP, PROFINET, PROFIBUS, CANopen protocols			
	1 x Wi-Fi/Bluetooth/Modem adapter			
EXPANSION SLOTS S1	1 x PCI or 1 x PCIe x4			
POWER SUPPLY INPUT	24VDC (18÷32VDC) isolated			
POWER SUPPLY OPTIONS	UPS with external battery pack Kit for ATX mode power supply			
O.S. CERTIFIED	Microsoft Windows 7 Pro/Ultimate 32/64 bit Microsoft Windows Embedded Standard 7E/7P 32/64 bit Microsoft Windows 10 IoT Enterprise 2016/2019 64 bit			
OPERATING	0°C÷50°C			
TEMPERATURE	0°C÷45°C with 24x7 HDD			
APPROVALS	CE, cULus LISTED (61010)			





22/485 + 1 x USB 2.0 22/485 isol. + 1 x USB 2.0

abit X fieldbus board oth/Modem



@ASEA+

PB3500 [new]

Fanless Box IPCs based on Intel[®] Kaby Lake[™] U platform



The fanless box IPC family PB3500 is based on the seventh generation Core i3, i5, i7 and Celeron of the Intel® Kaby Lake[™] U platform. The "all in one" motherboard provides three Gigabit Ethernet installation of a 2.5" HDD/ SSD, ports, that support "Jumbo Frame" and "Wake on Lan" functionalities, four USB 3.0 ports, a serial RS232 interface, additional interfaces, DVI-D,

a Display Port dual mode video output and a SATA III CFast slot with external access, an M.2 connector for an NVMe/SATA III SSD, one SATA III connector for the up to 16 GB RAM with one DDR4 SODIMM module and two internal connectors for

USB, Ethernet, Fieldbus and RVL for the remotation of the video and USB signals up to 100m (Remote Video Link). PB3500 systems have an isolated 24 VDC power supply input and optionally an integrated UPS with external battery pack. The systems are available in three versions, the SL with a

reduced depth, the S0 with the possibility to install additional interfaces and the S1 with a PCI or PCIe x4 slot.



INSIDE

• Highlights

- → UBIQUITY remote assistance software providing remote access to the system
- → 15W seventh generation Core i3, i5, i7 and Celeron processors of the Intel® Kaby Lake[™] U platform.
- → "All in one" motherboard
- \rightarrow Fanless box IPC with 0°C÷50°C operating temperature
- → Isolated 24 VDC power supply input
- → Integrated UPS with external battery pack (optional)
- → Onboard connector for NETcore X fieldbus boards
- \rightarrow SL version with reduced depth
- \rightarrow S1 version with one PCI or PCIe x4 expansion slot
- → CE, cULus LISTED (61010) certifications

Gallery





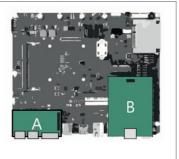
Position A
→ 1 x RS232/42
→ 1 x RS232/42
→ 1 x RS232 + 1
→ 2 x RS232
→ 2 x USB 2.0
Position B
→ 1 x LAN Giga
\rightarrow 1 x DVI-D

Technical data

	PB3500				
PROCESSOR (soldered)	Intel [®] Celeron 3965U 2.20GHz 64bit, 2 cores / 2 threads, 2MB Smart cache Intel [®] Core i3-7100U 2.40GHz 64bit, 2 cores / 4 threads, 3MB Smart cache Intel [®] Core i5-7300U 2.60GHz (3.50GHz Turbo) 64bit, 2 cores / 4 threads, 3MB Smart cache Intel [®] Core i7-7600U 2.80GHz (3.90GHz Turbo) 64bit, 2 cores / 4 threads, 4MB Smart cache				
CHIPSET	Intel® Broadwell PCH-LP (Platform Controller Hub - Low Power) • Included into processor chip				
VIDEO CONTROLLER	Intel® HD Graphics 610 integrated in microprocessor Celeron 3965U • 300MHz/900MHz Intel® HD Graphics 620 integrated in Core i3 processors • 300MHz/1.00GHz Intel® HD Graphics 620 integrated in Core i5 processors • 300MHz/1.10GHz Intel® HD Graphics 620 integrated in Core i7 processor • 300MHz/1.15GHz DirectX 12 and OpenGL 4.5 support				
SYSTEM MEMORY - RAM	4GB or 8GB or 16GB (1 x SODIMM DDR4 module)				
MASS STORAGE	1 x bootable CFast SATA III slot onboard with external access 1 x onboard connector for direct insertion of M.2 2280 NVMe/SATA III SSD				
S0/S1	1 x bootable CFast SATA III slot onboard with external access 1 x onboard connector for direct insertion of M.2 2280 NVMe/SATA III SSD 1 x onboard connector for 2.5" SSD/HDD SATA III with internal installation kit				
LAN	3 x LAN 10/100/1000 Mbps (RJ45 - 2 x Intel® I210-AT, 1 x Intel® I219-LM)				
USB	4 x USB 3.0 rear (Type-A)				
SERIAL	1 x RS232 (DB9M)				
VIDEO OUTPUT	1 x DP++				
ADD-ON INTERFACES	1 x RS232/422/485 (DB15M) + 1 x USB 2.0 (Type-A)				
(only \$0/\$1)	1 x RS232/422/485 (DB15M) isolated + 1 x USB 2.0 (Type-A)				
Position A	1 x RS232 (DB9M) + 1 x USB 2.0 (Type-A)				
(max 1)	2 x RS232 (DB9M)				
	2 x USB 2.0 (Type-A)				
	1 x LAN 10/100/1000Mbps (RJ45 - Intel® I210)				
	1 x DVI-D				
Position B (max 1)	1 x RJ45 connector Remote Video Link (RVL OUT)				
(11/2X 1)	1 x NETcore X fieldbus boards for EtherCAT, EtherNet IP, PROFINET, PROFIBUS, CANopen protocols				
	1 x Wi-Fi/Bluetooth/Modem adapter				
EXPANSION SLOTS S1	1 x PCI or 1 x PCIe x4 (5 Gb/s)				
POWER SUPPLY INPUT	24VDC (18÷32VDC) isolated				
POWER SUPPLY OPTIONS	UPS with external battery pack Kit for ATX mode power supply				
O.S. CERTIFIED	Microsoft Windows 10 IoT Enterprise 2016/2019 64bit				
OPERATING	0°÷50°C				
TEMPERATURE	0°- 45°C with 24x7 HDD				
APPROVALS	CE, cULus LISTED (61010)				



22/485 + 1 x USB 2.0 22/485 isol. + 1 x USB 2.0 1 x USB 2.0



abit

 \rightarrow 1 x RJ45 Remote Video Link (RVL OUT) \rightarrow 1 x NETcore X fieldbus board → Wi-Fi/Bluetooth/Modem

@ASEA+

PB3400 / PB3600

Intel[®] Skylake[™] H and Kaby Lake[™] H based fanless box IPCs



The fanless Box IPC family PB3400 is based on the 6th generation Core i3, i5, i7 and Celeron processors of the Intel[®] Skylake[™] H platform and the PB3600 family is based on the 7th generation Core i3, i5, i7 processors of the Intel[®] Kaby Lake[™] H platform.

The "all in one" motherboard provides four Ethernet 10/100/1000Mbps ports, that support "Jumbo Frame" and "Wake on Lan" functionalities,

three USB 3.0 ports, two USB 2.0 port, a serial RS232 interface, a DVI-D video output and a SATA III CFast slot with external access, an mSATA connector for a SATA III SSD, one SATA III connector for 2.5" SSDs/HDDs, up to 32 GB RAM with two DDR4 SODIMM modules and two internal connectors for additional interfaces, including HDDs. RVL for the remotation of the video and USB signals up to 100m (Remote Video Link).

The systems have an isolated 24 VDC power supply input and optionally an integrated UPS with external battery pack. The systems are available in three versions, the S0 with the possibility to install additional interfaces, the S1 with a PCI or

PCIe x4 slot and the D2 with two extractable 2.5" SSDs/



• Highlights

- → UBIQUITY remote assistance software providing remote access to the system
- → "All in one" motherboard
- → High performance Intel[®] Skylake[™] H (PB3400) and Kaby Lake[™] H (PB3600) platforms
- \rightarrow Fanless box IPC with 0°C÷50°C operating temperature
- → Isolated 24 VDC power supply input
- → Onboard connectors for NETcore X fieldbus boards
- → Integrated UPS with external battery pack (optional)
- \rightarrow S1 version with one PCI or PCIe x4 expansion slot
- \rightarrow CE, cULus LISTED (61010) certifications

Gallery

Add-On boards



Position A

→ 2 x RS232

- → 2 x USB 2.0
- **Position B**
- \rightarrow 1 x LAN Gigabit

Technical data

		PB3400/PB3600			
PROCESSORS (soldered) PB3400		Intel [®] Celeron G3900E 2.40GHz 64bit, 2 cores / 2 threads, 2MB Smart cache Intel [®] Core i3-6100E 2.70GHz 64bit, 2 cores / 4 threads, 3MB Smart cache Intel [®] Core i5-6440EQ 2.70GHz (3.40GHz Turbo) 64bit, 4 cores / 4 threads, 6MB Smart cache Intel [®] Core i7-6820EQ 2.80GHz (3.50GHz Turbo) 64bit, 4 cores / 8 threads, 8MB Smart cache			
PB3600		Intel [®] Core i3-7100E 2.90GHz 64bit, 2 cores / 4 threads, 3MB Smart cache Intel [®] Core i5-7440EQ 2.90GHz (3.60GHz Turbo) 64bit, 4 cores / 4 threads, 6MB Smart cache Intel [®] Core i7-7820EQ 3.00GHz (3.70GHz Turbo) 64bit, 4 cores / 8 threads, 8MB Smart cache			
CHIPSET PB3400		Intel [®] HM170 PCH (Platform Controller Hub)			
PB3600		Intel [®] HM175 PCH (Platform Controller Hub)			
VIDEO CONTROLLER PB3400		Intel® HD Graphics 510 integrated in Celeron processor • 350MHz/950MHz • DirectX 12 and OpenGL 4.4 support Intel® HD Graphics 530 integrated in Core i3 processor • 350MHz/950MHz • DirectX 12 and OpenGL 4.4 support Intel® HD Graphics 530 integrated in Core i5, Core i7 processors • 350MHz/1,00GHz • DirectX 12 and OpenGL 4.4 support			
	PB3600	Intel® HD Graphics 630 integrated in Core i3 processor • 350MHz/950MHz • DirectX 12 and OpenGL 4.5 support Intel® HD Graphics 630 integrated in Core i5, Core i7 processors • 350MHz/1,00GHz • DirectX 12 and OpenGL 4.5 support			
SYSTEM MEMORY	′ - RAM	4GB (1 x SODIMM DDR4 module) or 8GB or 16GB or 32GB (2 x SODIMM DDR4 modules)			
ТРМ		TPM module (optional)			
MASS STORAGE		1 bootable CFast SATA III slot onboard with external access 1 x onboard connector for direct insertion of mSATA SSD SATA III 1 x onboard connector for 2,5" SSD/HDD SATA III with internal installation kit			
OPTIONS	D2	Up to 2 extractable 2.5" SSD/HDD SATA III devices			
LAN		4 x LAN 10/100/1000Mbps (RJ45 - 3 x Intel® I210 + 1 x Intel® I219LM)			
USB 3 x USB 3.0, rear (Type-A) 2 x USB 2.0, rear (Type-A)					
SERIAL		1 x RS232 (DB9M)			
VIDEO OUTPUT		1 x DVI-D			
ADD-ON INTERF	ACES	1 x RS232/422/485 (DB15M)+ 1 x USB 2.0 (Type-A)			
	Position A	1 x RS232/422/485 (DB15M) isolated + 1 x USB 2.0 (Type-A)			
(max 1)		2 x RS232 (DB9M)			
		2 x USB 2.0 (Type-A)			
		1 x NETcore X fieldbus boards for EtherCAT, EtherNet IP, PROFINET, PROFIBUS, CANopen protocols			
		1 x connector Remote Video Link (RJ45 - RVL OUT)			
		2 x connectors Remote Video Link (RJ45 - RVL OUT)			
	Position B (max 1)	1 x LAN 10/100/1000Mbps (Intel® I210)			
	(1 x NETcore X fieldbus boards for EtherCAT, EtherNet IP, PROFINET, PROFIBUS, CANopen protocols			
		1 x Wi-Fi/Bluetooth/Modem adapter			
EXPANSION SLO	TS S1	1 x PCI or 1 x PCIe x4 (5 Gb/s)			
POWER SUPPLY I	NPUT	24VDC (18÷32VDC) isolated			
POWER SUPPLY (OPTIONS	NS UPS with external battery pack Kit for ATX mode power supply			
O.S. CERTIFIED	PB3400	Microsoft Windows 7 Pro/Ultimate 32/64bit Microsoft Windows Embedded Standard 7E/7P 32/64 bit Microsoft Windows 10 IoT Enterprise 2016/2019 64bit			
	PB3600	Microsoft Windows 10 IoT Enterprise 2016/2019 64bit			
OPERATING		0°C÷50°C			
TEMPERATURE		0°C÷45°C with 24x7 or Core i7 processors			
APPROVALS CE, cULus LISTED (61010)					

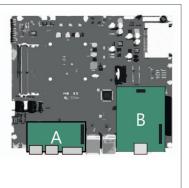




→ 1 x RS232/422/485 + 1 x USB 2.0 → 1 x RS232/422/485 isol. + 1 x USB 2.0

 \rightarrow 1 x NETcore X fieldbus board

→ 1/2 x RJ45 Remote Video Link (RVL OUT) \rightarrow 2 x Diplay Port dual mode \rightarrow 1 x NETcore X fieldbus board → Wi-Fi/Bluetooth/Modem



PB5400 / PB5600

Intel[®] Skylake[™] S and Kaby Lake[™] S based highly expandable box IPCs



The box IPC family PB5400 is based on the 6th generation Core i3, i5, i7 and Celeron processors of the Intel[®] Skylake[™] S and the PB5600 family is based on the 7th generation Core i3, i5, i7 and Celeron processors of the Intel[®] Kaby Lake[™] S platform. The "all in one" motherboard provides four Ethernet 10/100/1000Mbps ports, that support "Jumbo Frame" and "Wake on Lan" functionalities, four USB 3.0 ports, a serial

RS232 interface, a DVI-D video output, a SATA III CFast slot with external access, an M.2 2242/2280 SSD key M connector for a PCIe x4 SSD, two SATA III connectors for 2.5" SSDs/HDDs (optionally on extractable drawers), the possibility to set the mass storage drives in RAID 0, 1 configuration, up to 32 GB RAM with two DDR4 SODIMM modules and two internal connectors for additional interfaces, including RVL for

the remotation of the video and USB signals up to 100m (Remote Video Link). The systems have an isolated 24 VDC power supply input or, as an alternative, a 115/230 VAC power supply. The systems are available in three versions, the S0 with the possibility to install additional interfaces, the S1 with a x16 PCIe slot and the S3 with two x8 and a x4 PCIe slots or a x16, a x4 and a x1 PCIe slots



INSIDE

• Highlights

- → UBIQUITY remote assistance software providing remote access to the system
- → High performance Intel[®] Skylake[™] S (HT/QT5400) and Kaby Lake[™] S (HT/QT5600) platforms
- → RAID 0,1 (optional, S3 version)
- → "All in one" motherboard
- \rightarrow Box IPC with 0°C÷50°C operating temperature
- → 115/230 VAC or Isolated 24 VDC power supply input
- \rightarrow S1 version with one PCIe x16 expansion slot
- \rightarrow S3 version with one x16, one x4 and one x1 PCIe expansion slots or two x8 and one x4 PCIe expansion slots
- → CE, cULus LISTED (61010) certifications

Gallery

Add-On boards



Position A



- → 2 x RS232
- → 2 x USB 2.0
 - \rightarrow 1 x NETcore X fieldbus board
 - **Position B**
- → 1 x LAN Gigabit
- \rightarrow 2 x Diplay Port dual mode

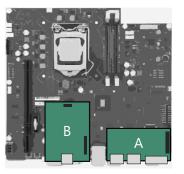
Technical data

PROCESSOR		Intel [®] Celeron G3900 2.8G
(soldered)	PB5400	Intel® Core™ i3-6100 3 Intel® Core™ i5-6500 3.2GHz (
		Intel [®] Core™ i7-6700 3.4GHz
		Intel [®] Celeron G3930TE
	PB5600	Intel [®] Core™ i3-7101E
	1 23000	Intel® Core™ i5-7500 3.4Ghz (Intel® Core™ i7-7700 3.6Ghz (
CHIPSET		Intel® C2
VIDEO CONTROL	I ED	Intel [®] HD Graphics 510
VIDEO CONTROL	PB5400	Intel [®] HD Graphics 530 ir
	1 00 400	Intel [®] HD Graphics 530
		Intel [®] HD Graphics 610 in
	PB5600	Intel® HD Graphics 630 in Intel® HD Graphics 6
SYSTEM MEMOR	Y - RAM	4GB (1 x SODIMM DDR4 mo
ТРМ		
MASS STORAGE		1 x bootable CFast
		1 x onboard connector for a
		2 x onboard
OPTIONS	S0	1 x ex
	S1/S3	2 x ex
RAID CONTROL	LER	Integ
LAN		4 x LAN 10/100/1000N
USB		
SERIAL		
VIDEO OUTPUT		
ADD-ON INTERI	FACES	1 x RS232/42
(max 1)		1 x RS232/422/48
	Position A	
	-	1 x LAN 10/100/1000N
		1 x LAN 10
	-	1 x RJ45 con
	Position B	2 x RJ45 con
	FUSICION D	2 x D
	-	1 x NETcore X fieldbus boards for Eth
		1 x Wi
EXPANSION SLO	OTS S1	1.00
	S3	1x PCI
POWER SUPPLY	INPUT	24
POWER SUPPLY	OPTIONS	Kit for A
O.S. CERTIFIED	PB5400	Microsoft Windows 10 IoT Enterprise 2019 64 Ultimate 32/64bit • Windows Embedded Stan
	PB5600	Microsoft Windows 10 IoT Enterprise 2019 64bit
OPERATING		
TEMPERATURE		(
APPROVALS		(



→ 1 x RS232/422/485 + 1 x USB 2.0 → 1 x RS232/422/485 isol. + 1 x USB 2.0

 \rightarrow 1/2 x RJ45 Remote Video Link (RVL OUT) \rightarrow 1 x NETcore X fieldbus board → Wi-Fi/Bluetooth/Modem



PB5400 / PB56 GHz, 2 cores, 2 Cores - 2 threads - 2MB smart cache 3.7GHz, 2 Cores - 4 threads - 3MB smart cache (3.6GHz Turbo), 4 Cores - 4 threads - 6MB smart cache (4.0GHz Turbo), 4 Cores - 8 threads - 8MB smart cache E 2.7Ghz, 2 cores – 2 threads – 2MB smart cache 3.9Ghz, 2 Cores - 4 threads - 3MB smart cache (3.8GHz Turbo), 4 Cores - 4 threads - 6MB smart cache (4.2GHz Turbo), 4 Cores - 8 threads - 8MB smart cache 236 PCH (Platform Controller Hub)) integrated in Celeron G3900, 350/950MHz Clock integrated in i3-6100 / i5-6500, 350/1.05GHz Clock 30 integrated in i7-6700, 350MHz/1.15GHz Clock ntegrated in Celeron G3930TE, 350/950MHz Clock ntegrated in i3-7101E / i5-7500, 350/1.10GHz Clock 630 integrated in i7-7700 350/1.15GHz Clock odule) /8GB/16GB/32GB (2 x SODIMM DDR4 modules) TPM module (optional) t SATA III slot on board with external access direct insertion of M.2 2242/2280 SSD key M PCIex4 connector for 2,5" SSD/HDD SATA III extractable drawer for 2.5" units tractable drawers for 2.5" units grated into chipset Intel[®] C236 Mbps (RJ45 - 3 x Intel[®] I210 + 1 x Intel[®] I219LM) 3 x USB 3.0, rear (Type-A) 2 x USB 2.0, rear (Type-A) 1 x RS232 (DB9M) 1 x DVI-D 22/485 (DB15M)+ 1 x USB 2.0 (Type-A) 85 (DB15M) isolated + 1 x USB 2.0 (Type-A) 2 x RS232 (DB9M) 2 x USB 2.0 (Type-A) Mbps (RJ45 - Intel[®] I210) + 1 x USB 2.0 (Type-A) 0/100/1000Mbps (RJ45 - Intel® I210) nnector Remote Video Link (RVL OUT) nnectors Remote Video Link (RVL OUT) DP++ Video output (no audio) herCAT, EtherNet IP, PROFINET, PROFIBUS, CANopen protocols 'i-Fi/Bluetooth/Modem adapter 1 x PCIe x16 Ie x16 + 1x PCIe x4 + 1x PCIe x1 2 x PCIe x8 + 1 x PCIe x4 4VDC (18÷32VDC) isolated 115/230VAC TX mode power supply (optional) 4bit • Microsoft Windows 10 IoT Enterprise 2016 64bit • Windows 7 Pro/ ndard 7E/7P 32/64 bit • Microsoft Windows Server 2016/2019 Standard it • Microsoft Windows 10 IoT Enterprise 2016 64bit • Microsoft Windows Server 2016/2019 Standard 0°C÷50°C 0°C÷45°C with 24x7 HDD CE, cULus LISTED (61010)

Arm Mounting IPCs

The Arm Mounting IPCs are compact, fanless, ergonomic and easy to install systems with a stylish design, that are easy to install and compatible with the most common mounting standards.





VK3200 Intel[®] Broadwell[™] U fanless arm mounting IPCs



The fanless Arm Mounting IPC family VK3200 is based on the fifth generation Core i3, i5, i7 and Celeron of the Intel® Broadwell[™] U platform. They are made of a Full IP65 cast aluminium chassis, powder coated with antiscratch treatment compatible with the most used installation standards. The front button area is available in Hard-Wired or Fieldbus (EtherCAT Slave) versions and it is totally configurable.

It allows to install light indicators, buttons, lever switches, keylock switches, encoders, an emergency stop button and USB, Ethernet or RFID interfaces (described in the "Configurations and Options" section). The "all in one" motherboard provides two USB 3.0 ports with rear external protected access and, inside the chassis, three Ethernet 10/100/1000Mbps ports, that support "Jumbo Frame" and

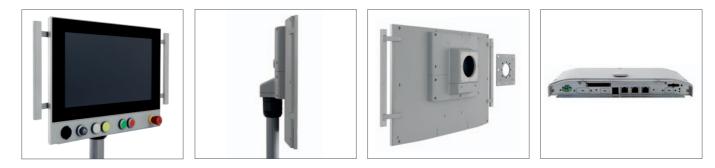
"Wake on Lan" functionalities, two USB 2.0 port, a SATA III CFast slot, an mSATA connector for SATA III SSD and up to 8 GB RAM with one input. DDR3 SODIMM module. The VK3200 family is available with 16 million colours LED Backlight TFT LCDs from 15.6" to 24", in Wide aspect ratio, with aluminium True flat front panels and 5 wires resistive touchscreen or with aluminium and glass TrueFlat Multitouch front panels

and projected capacitive touchscreen. VK3200 systems have an isolated 24 VDC power supply

• Highlights

- → UBIQUITY remote assistance software providing remote access to the system
- → Full IP65 chassis
- → Button area with up to 15 Ø22 elements, Hard-Wired or Fieldbus versions (EtherCAT Slave)
- \rightarrow "All in one" motherboard
- → Intel[®] Broadwell[™] U platform
- → Fanless arm mounting IPC with 0°C÷50°C operating temperature
- \rightarrow 15.6", 18.5", 21.5" and 24" LCDs in Wide aspect ratio
- → Isolated 24 VDC power supply input
- → CE, ULus LISTED (61010) certifications

Gallery



Technical data

	VK3200-TF	VK3200-TFM				
LED backlight TFT LCD	15.6" W - 1366x768 15.6" W - 1920x1080 18.5" W - 1366x768 18.5" W - 1920x1080 21.5" W- 1920x1080	15.6" W - 1366x768 15.6" W - 1920x1080 18.5" W - 1920x1080 18.5" W - 1920x1080 21.5" W - 1920x1080 24" W - 1920x1080				
TOUCHSCREEN	Resistive 5 wires	P-CAP Multitouch				
FRONT PANEL	True Flat	Aluminum				
PROTECTION GRADE	Full	IP65				
PROCESSOR	Intel® Core™ i3-5010U 2,1Ghz, 2 core Intel® Core™ i5-5350U 1,8Ghz (2,9GHz Turbo)	Intel® Celeron 3765U 1,9Ghz, 2 cores - 2 threads - 2MB smart cache - 15W Intel® Core™ i3-5010U 2,1Ghz, 2 cores - 4 threads - 3MB smart cache - 15W Intel® Core™ i5-5350U 1,8Ghz (2,9GHz Turbo), 2 cores - 4 threads - 3MB smart cache - 15W Intel® Core™ i7-5650U 2,2Ghz (3,1GHz Turbo), 2 cores - 4 threads - 4MB smart cache - 15W				
CHIPSET	Intel [®] Broadwell PCH-LP (Platform Controller H	lub - Low Power) • Included into processor chip				
VIDEO CONTROLLER	Intel® HD Graphics 5500 integrated Intel® HD Graphics 6000 integrated	Intel® HD Graphics integrated in microprocessor Celeron 3765U, 850MHz Clock Intel® HD Graphics 5500 integrated in microprocessor i3, 900MHz Clock Intel® HD Graphics 6000 integrated in microprocessor i5, i7, 1GHz Clock with LVDS 8bit/color digital interface				
SYSTEM MEMORY - RAM	2GB or 4GB or 8GB or 16GB (1 x SODIMM DDR3 module)					
MASS STORAGE	1 bootable CFast SATA III slot onboard with internal access 1 x onboard connector for direct insertion of mSATA SSD SATA III					
LAN	3 x LAN 10/100/1000Mbps (2 x Intel® I210-AT, 1 x Intel® I218-LM)					
USB	2 x USB 3.0, external, rear, protected, IP65 (Type-A) 2 x USB 2.0, internal (Type-A)					
ADD-ON INTERFACES	1 x RS232/422/485 (DB15M)					
Position A (max 1)	1 x RS232/422/485 (DB15M) isolated					
Position B	1 x NETcore X fieldbus boards for EtherNet I	1 x NETcore X fieldbus boards for EtherNet IP, PROFINET, PROFIBUS, CANopen protocols				
(max 1)	1 x Wi-Fi/Bluetooth adapter					
CASE Installation		For VESA 75/100 or for pole / suspension arm mounting system compatible with RITTAL CP40/ROLEC TARAPLUS/ HASEKE ULT KUPPLUNG 48				
Material	Aluminium allo	oy EN AB46400				
Colour	Anti-scratchable painted - RAL 9006					
Accessories	Side handles, perimetral handle, keyboard holder kit					
BUTTONS AREA (optional)	See "Configurations & Options" section at the end of this brochure					
POWER SUPPLY INPUT	24VDC (18÷32VDC) isolated					
	Kit for ATX mode power supply (optional, on button area)					
O.S. CERTIFIED	Microsoft Windows 7 Pro/Ultimate 32/64bit Microsoft Windows Embedded Standard 7E/7P 32/64 bit Microsoft Windows 10 IoT Enterprise 2016/2019 64 bit					
OPERATING TEMPERATURE	0°C÷	- 50°C				
APPROVALS	CE, ULus	s (61010)				



@ASEA+

VK3500 [new]

Arm Mounting fanless IPC based on Intel[®] Kaby Lake[™] U platform



The fanless Arm Mounting IPC family VK3500 is based on the seventh generation Core[™] i3, i5, i7 and Celeron® processors of the Intel® Kaby Lake™ U at 15W platform.

VK3500 is made of a Full IP65 cast aluminium chassis, powder coated with anti-scratch treatment compatible with the most used installation standards. The front button area is available in Hard-

Wired version and it is totally configurable. It allows to install light indicators, buttons, lever switches, keylock switches, encoders, an emergency stop button and USB, Ethernet or RFID interfaces (described in the "Configurations and Options" section). The "all in one" motherboard provides three Gigabit Ethernet ports, that support "Jumbo Frame" and "Wake on Lan"

functionalities, two USB 3.0 port, a SATA III CFast slot, an M.2 connector for NVMe/SATA III SSD, up to 16 GB RAM with one DDR4 SODIMM module and two internal connectors for additional interfaces. The VK3500 family is available with the new minimized frame in aluminium and glass TrueFlat Multitouch, projected capacitive touchscreen, with 16 million colours LED Backlight TFT LCDs

from 15.6" to 24", in Wide aspect ratio.

VK3500 systems have an isolated 24 VDC power supply input.

Gallery



Technical data

	VK3500-TFM			
LED backlight TFT LCD	15.6" W - 1366x768 15.6" W - 1920x1080 18.5" W - 1366x768 18.5" W - 1920x1080 21.5" W - 1920x1080 24" W - 1920x1080"			
TOUCHSCREEN	P-CAP multitouch			
FRONT PANEL	True Flat Aluminium			
PROTECTION GRADE	Full IP65			
PROCESSOR	Intel® Celeron 3965U 2.20GHz 64bit, 2 cores / 2 threads, 2MB Smart cache Intel® Core i3-7100U 2.40GHz 64bit, 2 cores / 4 threads, 3MB Smart cache Intel® Core i5-7300U 2.60GHz (3.50GHz Turbo) 64bit, 2 cores / 4 threads, 3MB Smart cache Intel® Core i7-7600U 2.80GHz (3.90GHz Turbo) 64bit, 2 cores / 4 threads, 4MB Smart cache			
CHIPSET	Intel® Kaby Lake PCH-LP (Platform Controller Hub - Low Power) • Included into processor chip			
VIDEO CONTROLLER	Intel® HD Graphics 610 integrated in microprocessor Celeron 3965U • 300MHz/900MHz Intel® HD Graphics 620 integrated in Core i3 processors • 300MHz/1.00GHz Intel® HD Graphics 620 integrated in Core i5 processors • 300MHz/1.10GHz Intel® HD Graphics 620 integrated in Core i7 processor • 300MHz/1.15GHz DirectX 12 and OpenGL 4.5 support"			
SYSTEM MEMORY - RAM	4GB or 8GB or 16GB (1 x SODIMM DDR4 module)			
MASS STORAGE	1 x bootable CFast SATA III slot onboard with external access 1 x onboard connector for direct insertion of M.2 2280 NVMe PCIe x2			
LAN	3 x LAN 10/100/1000 Mbps (RJ45 - 2 x Intel® I210-AT, 1 x Intel® I219-LM)			
USB	3 x USB 2.0 rear (Type-A)			
ADD-ON INTERFACES Position A (max 1)	1 x RS232/422/485 (DB15M)			
	1 x RS232/422/485 (DB15M) isolated			
	1 x LAN 10/100/1000 Mbps (RJ45 - Intel® I210)			
	2 x USB 3.0 (Type-A)			
Position B (max 1)	1 x NETcore X fieldbus boards for EtherNet IP, PROFINET, PROFIBUS, CANopen protocols			
	1 x Wireless/Bluetooth adapter			
CASE Installation	For VESA 75/100 or for pole/suspension arm mounting system compatible with RITTAL CP40/ROLEC TARAPLUS/HASEKE ULT KUPPLUNG 48			
Material	Aluminium alloy AN AB46400			
Colour	Anti-scratchable painted - RAL 9006			
Accessories	es Side handles, perimetral handle, keyboard holder kit			
BUTTONS AREA (optional)	See "Configurations & Options" section at the end of the brochure			
POWER SUPPLY INPUT	24VDC (18÷32VDC) isolated			
POWER SUPPLY OPTIONS	Kit for ATX mode power supply			
O.S. CERTIFIED	Microsoft Windows 10 IoT Enterprise 2016/2019 64bit			
OPERATING TEMPERATURE	0°C÷50°C			
APPROVALS	CE, ULus LISTED (61010)			



• Highlights

- → UBIQUITY remote assistance software providing remote access to the system
- → Arm Mounting fanless IPC with 0°C÷50°C operating temperature
- → Full IP65 chassis
- \rightarrow Button area with up to 15 Ø22 elements, Hard-Wired
- → "All in one" motherboard
- → Intel[®] Kaby Lake[™] U platform
- → 15.6", 18.5", 21.5" and 24" LCDs in Wide aspect ratio
- → Isolated 24 VDC power supply input
- → CE, ULus LISTED (61010) certifications







VPC2200 Intel[®] Bay Trail[™] fanless arm mounting IPCs



The fanless Arm Mounting IPC are available, both with family VPC2200 is based on the Celeron J1900 2GHz quad core 64 bit processor of the Intel[®] Bay Trail[™] System On Chip (SoC) platform. They are made of a Full IP65 cast aluminium chassis, powder coated with antiscratch treatment and it is compatible with VESA, Rolec Taraplus and Rittal CP-40 standards. A keyboard and two side modules

predisposition to install light indicators, buttons, lever switches, keylock switches and an emergency stop button. The "all in one" motherboard provides, inside the chassis, two Ethernet 10/100/1000Mbps ports, that support "Jumbo Frame" and "Wake on Lan" functionalities, one USB 3.0 port, two USB 2.0 front. ports, a serial RS232 interface, VPC2200 systems have an a DVI-I (DVI-D + VGA) video

output, a SATA II CFast slot, an input and the VPC2200-E mSATA connector for SATA II SSD and up to 8 GB RAM with slot for the installation of one DDR3 SODIMM module. The VPC2200 family is boards. available with 16 million colours LED Backlight TFT 15" LCD in 4:3 aspect ratio, with aluminium front panel, 5 wires resistive touchscreen and two additional USB 2.0 ports on isolated 24 VDC power supply

version integrates a MiniPCI ASEM NETcore[®] X fieldbus

Gallery



Technical data

		VPC2200	VPC2200-E	
LED backlight T	IFT LCD	15.0" - 1024x768		
TOUCHSCREEN		Resistive 5 wires		
FRONT PANEL		Aluminium alloy with polycarbonate foil Pantone 429C colour		
PROTECTION G	RADE	IP65 f	rontal	
PROCESSOR		Intel [®] Celeron J1900 2.0Ghz, 4 cores	/ 4 threads, 2MB L2 cache, soldered	
VIDEO CONTRO	LLER	Intel [®] HD Graphics integrated in microprocessor, 688MH:	z Clock 854MHz Turbo, LVDS 8bit/colour digital interface	
SYSTEM MEMO	RY - RAM	1GB or 2GB or 4GB or 8GB (1 x SODIMM DDR3 module)	
MASS STORAG	E	1 x SSD mSATA/2.5" SATA II	1 x SSD mSATA/2.5" SATA II	
		1 bootable CFast SATA II slot onboard, internal access		
LAN		2 x LAN 10/100/1000Mbps (2 x Intel® I210)	2 x LAN 10/100/1000Mbps (2 x Intel® I210)	
		1 x LAN 10/100/1000Mbps (1 x Intel® I210) (optional)		
USB		2 x USB 2.0 external front, protected (Type-A) 1 x USB 3.0 internal (Type-A) 2 x USB 2.0 internal (Type-A)		
SERIAL		1 x RS232	2 (DB9M)	
EXPANSION SLOTS		- 1 x MiniPCI dedicated to ASEM fieldbuses boards		
VIDEO OUTPUT	Г	1 x DVI-I (DVI-D +	VGA with adapter)	
CASE In	stallation	For pole or suspension arm mounting system compatik	ole with VESA 75/100 RITTAL CP40 ROLEC TARAPLUS	
	Material	Ste	eel	
	Colour	Anti-scratchable	painted RAL 7035	
BUTTONS & LE (optional)	DS	Side modules for emergency stop but	ton, buttons, lights, keys and switches	
KEYBOARD (op	tional)	US-international layout keyboard module with 86 keys	s and antiglare protection also with emergency button	
POWER SUPPLY	Y INPUT	24VDC (18÷32	2VDC) isolated	
O.S. CERTIFIED		Microsoft Windows 7 Pro/Ultimate 32/64bit Microsoft Windows Embedded Standard 7E/7P 32/64 bit Microsoft Windows 8.1 Industry Pro 32/64bit Microsoft Windows 10 IoT Enterprise 2016/2019 64 bit		
OPERATING TEMPERATURE		0°C÷	45°C	
APPROVALS		C	E	



Highlights

- → UBIQUITY remote assistance software providing remote access to the system → Pole or Arm Mounting system, compatible with VESA 75-100, RITTAL CP40, ROLEC
- TARAPLUS
- \rightarrow Two side button areas for Ø22 elements (optional)
- → Keyboard module (optional)
- → "All in one" motherboard
- → High performance Intel[®] Bay Trail[™] SoC platform
- → Fanless arm mounting IPC with 0-45° C operating temperature
- → 15" LCD in 4:3 aspect ratio
- → Isolated 24 VDC power supply input
- \rightarrow CE certification

Industrial Automation | Industrial PC Solutions



Rack IPCs

19" 4U rack solutions with a wide range of configurations, motherboards, expansion slots and Intel[®] Xeon[™] and Core[™] i3, i5, i7 dual, quad and exa core processors up to Intel[®] Coffee Lake[™] platform.



PR4048 / PR4148 Intel[®] Skylake[™] based rack IPCs

PR4049 / PR4149 Intel[®] Kaby Lake[™] based rack IPCs

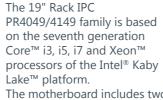


The 19" Rack IPC PR4048/4148 family is based on the sixth generation Core™ i3, i5, i7 and Xeon processors of the Intel[®] Skylake[™] platform.

Ethernet 10/100/1000Mbps ports that support "Jumbo Frame" and "Wake on Lan" functionalities, four USB 3.0 ports, four USB 2.0 ports, one

RS232 serial interface, two DisplayPort and a DVI-D video PR4048/4148 systems are outputs; on the front, two USB 3.0 ports. The motherboard also has an mSATA connector for a SATA III SSD, six SATA The motherboard includes two III connectors for 2.5" or 3.5" units (also on extractable drawers), the possibility to set the mass storage drives in RAID 0, 1, 5, 10 configuration and up to 64 GB RAM with

four DDR4 DIMM modules. provided with 110/230 VAC power supply and are available in two versions, PR4048 with up to two 500W redundant power supplies and PR4148, with reduced depth chassis.



Ethernet 10/100/1000Mbps ports that support "Jumbo Frame" and "Wake on Lan" functionalities, four USB 3.0 ports, four USB 2.0 ports, one and up to 64 GB RAM with

RS232 serial interface, two four DDR4 DIMM modules. DisplayPort and a DVI-D video PR4049/4149 systems are outputs; on the front, two USB provided with 110/230 3.0 ports. The motherboard VAC power supply and are also has an mSATA connector available in two versions, for a SATA III SSD, six SATA PR4049 with up to two 500W The motherboard includes two III connectors for 2.5" or 3.5" redundant power supplies and units (also on extractable PR4149, with reduced depth drawers), the possibility to chassis. set the mass storage drives in

Highlights

- \rightarrow "Heavy-duty" motherboard for 24/7 industrial applications
- → Extractable drawers for 2.5" or 3.5" mass storages
- → Intel[®] Skylake[™] dual and quad core platform
- → Rack IPC with 0-40° operating temperature
- → 110/230 VAC power supply input
- → PR4148 version with compact cabinet

• Highlights

RAID 0, 1, 5, 10 configuration

- \rightarrow Rack IPC with 0-40° operating temperature \rightarrow 110/230 VAC power supply input
- → PR4149 version with compact cabinet





 \rightarrow "Heavy-duty" motherboard for 24/7 industrial applications → Extractable drawers for 2.5" or 3.5" mass storages → Intel[®] Kaby Lake[™] dual and quad core platform

PR4050 / PR4150 Intel[®] Coffee Lake[™] based rack IPCs



family is based on the eighth generation Core™ i3, i5, i7 and Xeon[™] processors of the also has an M.2 2280 Ethernet 10/100/1000Mbps ports that support "Jumbo Frame" and "Wake on Lan" functionalities, four USB 3.0 ports, four USB 2.0 ports, one 10 configuration and up to RS232 serial interface, two

The 19" rack IPC PR4050/4150 DisplayPort and a DVI-D video DIMM modules. outputs; on the front, two USB PR4050/4150 systems are 3.0 ports. The motherboard Intel[®] Coffee Lake[™] platform. connector for a SATA III/PCIe The motherboard includes two x4 SSD, six SATA III connectors PR4050 with up to two 500W for 2.5" or 3.5" units (also on extractable drawers), the possibility to set the mass storage drives in RAID 0, 1, 5, 64 GB RAM with four DDR4

provided with 110/230 VAC power supply and are available in two versions, redundant power supplies and PR4150, with reduced depth chassis.

Highlights

- → "Heavy-duty" motherboard for 24/7 industrial applications
- → Extractable drawers for 2.5" or 3.5" mass storages
- → Intel[®] Coffee Lake[™] dual, quad and exa core platform
- → Rack IPC with 0-40° operating temperature
- \rightarrow 110/230 VAC power supply input
- → PR4150 version with compact cabinet

	PR4048	PR4148	PR4049	PR4149	PR4050	PR4150
19" RACK CABINET	long	short	long	short	long	short
NOTHERBOARD			446-S2 (Fujitsu)			3446-S (Fujitsu)
PROCESSOR), 3,7 GHz, 2 cores / 4 14nm technology	Intel [®] Core [™] i3-7100, 3,9GHz, 2 cores / 4 threads, 3MB L2, 14nm technology			 3,6 GHz • 4 cores • 4 54bit • 14nm technology
		2.7GHz (3.3GHz Turbo),		,4GHz (3,8GHz Turbo), 4		3,0 GHz (4,1 GHz Turbo)
		IB L2, 14nm technology		3 L2, 14nm technology	• 6 cores • 6 threads • 9	MB cache = 64bit = 14nn nology
		8,3 GHz (3,9 GHz Turbo), IB L2, 14nm technology			• 6 cores • 12 threads	3,2 GHz (4,6 GHz Turbo) • 12MB cache • 64bit •
						chnology
		8,4 GHz (4,0 GHz Turbo), IB L2, 14nm technology		,6GHz (4,2GHz Turbo), 4 3 L2, 14nm technology	Turbo) • 4 cores • 4 thre	4G = 3,4 GHz (4,5 GHz eads = 8MB cache = 64bit echnology
	Turbo), 4 cores / 4 th	5 V5, 3,3 GHz (3,7 GHz ireads, 8MB L2, 14nm iology	Turbo), 4 cores / 4 th	5 V6, 3,3GHz (3,7GHz ireads, 8MB L2, 14nm iology	Turbo) = 6 cores = 12 t	6G • 3,7 GHz (4,7 GHz hreads • 12MB cache • Socket LGA1151
	Turbo), 4 cores / 8 th	5 V5, 3,6 GHz (4,0 GHz ireads, 8MB L2, 14nm iology	Turbo), 4 cores / 8 th	5 V6, 3,8GHz (4,2GHz ireads, 8MB L2, 14nm iology	-	
CHIPSET	Cechi		xpress Chipset	lology	Intel [®] C246 E	xpress Chipset
O.S. CERTIFIED	Microsoft Windows 1	0 IoT Enterprise 64 bit,		Microsoft Windows 1	0 IoT Enterprise 64 bit	
	bit, Microsoft Window Windows Server 201	3.1 Industry Pro 32/64 s 7 32/64 bit, Microsoft L2 R2 64 bit Standard tion			Server 2016 Standard Server 2019 Standard	
VIDEO CONTROLLER		30 integrated in Core				cs 630 integrato nei
CONTROLLER	i3-6100 processors	s, 350MHz/1,05GHz		5-7500 processors, /1,10GHz	· ·	i5• 350MHz/1,10GHz
	Intel [®] HD Graphic	s 530 integrated in	550141112	1,100112		cs 630 integrato nel 7 • 350MHz/1,2GHz
	Core i5-6600, Core	i7-6700 processors,	Intel® HD Graphics 6	30 integrated in Core	•	nics P630 integrato
		/1,15GHz		and Xeon processors,		keon™ E-2124G ∎
		cs P530 integrated s, 400MHz/1,15GHz				/1,15GHz
		penGL 4.4 support			processore Xeon™ E	s P630 integrato nel -2176G • 350MHz/1,2 Hz
VIDEO LIBRARY	DirextX 12 and O	penGL 4.4 support		DirextX 12 and O	penGL 4.5 support	
SUPPORT SYSTEM MEMORY			4GB / 8GB / 16GB /	32GB / 64GB DDR4		
EXPANSION SLOTS		2 x PCI full size (32	bit, 33MHz, Rev.2.3)	32007 0400 00104	2 x PCI full size (32	bit, 33MHz, Rev.2.3)
	2 x PCIe x16 (16 lane 1 x PCIe x8		s, Gen3, 4 lanes, Gen3) (1 lane, Gen3) ;, Gen3, 1 lane, Gen3)		1 x PCIe x16 (1 x PCIe x16 (2 x PCIe x8 (16 lanes, Gen3) (4 lanes, Gen3) 1 lane, Gen3) 1 lane, Gen3) 1 lanes, Gen3)
DRIVE BAY	3 x 5,25" external	3 x 5,25" external	3 x 5,25" external	3 x 5,25" external	3 x 5,25" external	3 x 5,25" external
	1 x 3,5" external + 2 x 3,5" internal	1 x 3,5" external + 3 x 3,5" internal	1 x 3,5" external + 2 x 3,5" internal	1 x 3,5" external + 3 x 3,5" internal	1 x 3,5" external + 2 x 3,5" internal	1 x 3,5" external + 3 x 3,5" internal
SPECIAL FEATURES		,	24/7 0	peration	,	,
DRIVE INTERFACES		1 x mSATA III 6Gbit/s	s - 6 x SATA III 6Gbit/s		1 x M.2 2280 PCIe x4	- 6 x SATA III 6Gbit/s
MASS STORAGE		up to 4 x HDDs 3,5	" SATA III without or wit	h extractable drawer in	a 5,25" bay (max 3)	
		up to 4 x SSDs 2,5	" SATA III without or wi	th extractable drawer in	a 3,5" bay (max 2)	
RAID			RAID 0, 1, 5,	10 on SATA III		
OPTICAL DRIVE				/D-RW		
LAN	2 x LAN 10/100/1000Mbps (1 x Intel® I210AT, 1 x Intel® I219LM)					
USB		4 x USB 3 0 rear	(Type-A) - 4 x USB 2.0 r		3.0 front (Type-A)	
SERIAL						
KEYBOARD &	1 x DVD-RW 2 x PS/2 (K/M)					
MOUSE VIDEO OUTPUT						
				olayPort		
AUDIO		Realtek A	LC671, 5.1-channel, Hig		ec, S/PDIF	
ADDITIONAL			2 (DB9M)			232 (DB9M)
INTERFACES		2 x USB 2.0 for	internal dongle		1 x USB 2.0 + 1 x USB	3.0 for internal dongle
POWER SUPPLY INPUT	230VAC 400/650W	230VAC 400/650W	230VAC 400/650W	230VAC 400/650W	230VAC 400/650W	230VAC 400/650W
	230VAC 2 x 500W		230VAC 2 x 500W		230VAC 2 x 500W	
DIMENSIONS w-h-d	48.3 x 17.8 x 50.3 cm	48.3 x 17.8 x 46.5 cm	48.3 x 17.8 x 50.3 cm	48.3 x 17.8 x 46.5 cm	48.3 x 17.8 x 50.3 cm	48.3 x 17.8 x 46.5 cm
OPERATING TEMPERATURE				h 24x7 HDD standard HDD		
APPROVALS						
AL TROVALS			(





Industrial Monitors

The panel Industrial Monitors are available with LCDs from 8.4" to 24", with 4:3, 5:4 or Wide format, and six front panels, with IP66 protection grade. Arm Mounting Monitors are compact, fanless, ergonomic and easy to install solutions, compatible with the most common mounting standards and are available with 15.6", 18.5", 21.5" and 24" TFT LCDs in a full IP65 aluminium chassis.



@ASEA+

MH/MHR100 / MQ/MQR100 Panel Mounting industrial monitors



The panel monitor family MQ100/MQR100 is available with the new front panels with minimized frame, 16 million colours LED Backlight TFT LCDs from 10.1" to 24", in 4:3 and Wide aspect ratio, with aluminium front panel and a 5 wires resistive touchscreen, or aluminium and glass TrueFlat Multitouch front panels, with projected capacitive touchscreen. Alternatively, the family MH100/MHR100 is available with 16 million colours LED

Backlight TFT LCDs from 8.4" to 24", in 4:3, 5:4 and Wide aspect ratio, with aluminium or aluminium True flat front panels, 5 wires resistive touchscreen and an additional USB 2.0 port on front. As an alternative, the systems with 12.1", 15", 17" and 19" LCD can have a Stainless Steel True Flat front panel. All version with Wide LCDs are also available with aluminium and glass TrueFlat Multitouch front panels, with projected capacitive touchscreen.

MH100 and MQ100 versions have a VGA and a DVI-D standard input, while MHR100 and MOR100 versions integrate the remotation technology for DVI and USB 2.0 signals that allows the connection of the IPC within 100 meters with a Cat 5e SF/ UTP or CAT6A S/FTP cable.

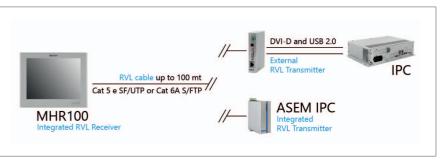
• Highlights

- → Industrial Monitor with 0°C÷50°C operating temperature
- → 8.4", 10.4", 12.1" and 15" LCDs in 4:3 aspect ratio, 17" and 19" LCDs in 5:4 aspect ratio, 10.1", 12.1", 15.6", 18.5", 21.5" and 24" LCDs in Wide aspect ratio
- → Isolated 24 VDC power supply input or 110/230 VAC power supply (optional)
- → MHR100 and MQR100 version with remotation of DVI and USB 2.0 signals up to 100m
- → CE, cULus LISTED certifications

Gallery



Remotation



	MQ100 MQR100	MQ100-TFM MQR100-TFM	MH100 MHR100	MH100-TF MHR100-TF	MH100-TFX MHR100-TFX	MH100-TFM MHR100-TFM
LED backlight TFT LCD	12.1" W 15.0" - 1024 15.6" W 15.6" W 18.5" W 18.5" W 21.5" W	- 1280x800 - 1280x800 4x768 (no TFM) - 1366x768 - 1920x1080 - 1366x768 - 1920x1080 - 1920x1080 1920x1080	10.1" W 10.4" 12.1" 12.1" 12.5" W 15.6" W 15.6" W 15.6" W 17" - 18.5" W 18.5" W 19" - 21.5" W	- 800x600 / - 1280x800 - 800x600 - 800x600 - 1024x768 / - 1280x800 - 1024x768 / - 1366x768 - 1920x1080 1280x1024 / - 1366x768 - 1920x1080 1280x1024 - 1920x1080	12.1" - 800x600 12.1" - 1024x768 15.0" - 1024x768 17" - 1280x1024 19" - 1280x1024	10.1" W - 1280x800 12.1" W - 1280x800 15.6" W - 1366x768 15.6" W - 1920x1080 18.5" W - 1366x768 18.5" W - 1366x768 18.5" W - 1920x1080 21.5" W - 1920x1080 24"W - 1920x1080
CUT-OUT		QT			HT	
FRONT USB		-	1 x USB 2.0, fror	t, protected (Type-A)		-
TOUCHSCREEN	Resistive 5 wires	P-CAP Multitouch		Resistive 5 wire	-	P-CAP Multitouch
FRONT PANEL	Aluminium	True Flat Aluminium	Aluminium	True Flat Aluminium	True Flat Stainless Steel	True Flat Aluminium
PROTECTION GRADE				IP65 - frontal		
VIDEO INPUT _{MH/MQ}				1 x DVI-D 1 x VGA		
MHR/MQR			1 x R.	J45 (remotation cable)		
USB			2 x l	JSB 2.0, rear (Type-A)		
USB only MH/MQ		1 x USB 2.0 HUB input, rear				
REMOTATION MHR/MQR	Remotation of DVI-D and USB 2.0 signals up to 100mt with Cat 5e SF/UTP cable or Cat 6A S/FTP cable					
POWER SUPPLY			24VD	C (18÷32VDC) isolated		
INPUT			24VDC (0	optional, only on MH/N	/IQ)	
	110V/230VAC (optional)					
OPERATING TEMPERATURE				0° ÷ +50°C		
APPROVALS			CE,	cULus LISTED (508)		



MH/MHR200 / MQ/MQR200 [new] Panel Mounting industrial monitors



The panel monitor family MQ200/MQR200 is available with the new front panels with minimized frame, with 16 million colours LED Backlight TFT LCDs from 12.1" to 24", in Wide aspect ratio, with aluminium front panel and a 5 panels, 5 wires resistive wires resistive touchscreen, or aluminium and glass TrueFlat Multitouch front panels, with projected capacitive touchscreen.

Alternatively, the family MH200/MHR200 is available with 16 million colours LED Backlight TFT LCDs from 12.1" to 24", in 4:3, 5:4 and Wide aspect ratio, with aluminium or aluminium True flat front touchscreen and an additional USB 2.0 port on front. As an alternative, the systems with 12.1", 15", 17" and 19" LCD can have a Stainless Steel

True Flat front panel. All versions with Wide LCDs are also available with aluminium and glass TrueFlat Multitouch front panels, with projected capacitive touchscreen. The monitors have an isolated 24 VDC power supply CAT6A S/FTP cable. Both input or, as an alternative, a 110/230 VAC power supply. MH200 and MQ200 versions have a Display Port and a DVI-D video input, while

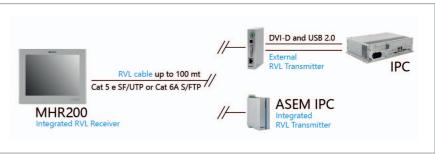
MHR200 and MQR200 versions integrate the remotation technology for DVI-D and USB 2.0 signals that allows the connection of the IPC within 100 meters with a Cat 5e SF/UTP or versions include three USB 2.0 ports on the I/O shield and, as an option, an additional USB 2.0 port.

Highlights

- → Industrial Monitor with 0°C÷50°C operating temperature
- → 12.1" and 15" LCDs in 4:3 aspect ratio, 17" and 19" LCDs in 5:4 aspect ratio, 12.1", 15.6", 18.5", 21.5" and 24" LCDs in Wide aspect ratio
- → Three USB 2.0 ports on the I/O shield and one additional USB 2.0 port (option)
- → Isolated 24 VDC power supply input or 110/230 VAC power supply (optional)
- → MHR200 and MQR200 version with remotation of DVI and USB 2.0 signals up to 100m
- → CE, cULus LISTED (61010) certifications

Gallery





	MQ200 / MQR200	MQ200-TFM / MQR200-TFM	MH200 / MHR200	MH200-TF /MHR200-TF
LED backlight TFT LCD	15.6" V 15.6" W 18.5" V 18.5" W 21.5" W	V - 1280x800 V - 1366x768 - 1920x1080 V - 1366x768 V - 1320x1080 V - 1920x1080 - 1920x1080	12.1" - 80 12.1" - 102 15.0" - 102 17" - 1280 19" - 1280	24x768 24x768 0x1024
CUT-OUT		QT	HT	
FRONT USB		-	1 x USB 2.0, front, pr	
TOUCHSCREEN	Resistive 5 wires	P-CAP Multitouch	Resistive 5 wires	
FRONT PANEL	Aluminium	True Flat Aluminium	Aluminium	True Flat Aluminium
PROTECTION GRADE		IP65 - frontal		
REMOTATION MHR/MQR	Remotation of DVI-D and USB 2.0 signals up to 100mt with Cat 5e SF/UTP cable or Cat 6A S/FTP cable			
VIDEO INPUT MH/MQ	1 x DP 1 x DVI-D			
MHR/MQR	1 x RJ45 (remotation cable)			
USB	3 x USB 2.0, rear (Type-A)			
	1 x USB 2.0 (Type -A optional)			
UBS only MH/MQ	1 x USB 2.0 HUB input, rear Type B			
POWER SUPPLY INPUT	24VDC (18÷32VDC) isolated 110V/230VAC (90÷264VAC, optional) isolated, autoranging			
OPERATING TEMPERATURE	0°÷50°C			
APPROVALS			CE, cULus LISTED (61010)	



MV100/MV200 - MVR100/MVR200 [new] VESA Mounting industrial monitors

The VESA mounting monitors or with aluminium and of the MV100/MVR100 and MV200/MV200R families are made of steel sheet chassis with anti-scratch powder coating, compatible with VESA 100 installation standard. They are available with 16 million colours LED Backlight TFT LCDs from 15.6" to 21.5", in Wide aspect ratio with aluminium front panels and 5 wires resistive touchscreen

glass TrueFlat Multitouch front panels and projected capacitive touchscreen. The monitors have an IP54 protection grade and an isolated 24 VDC power supply input. The MV100 and MV200 versions have a DVI-D and a VGA video input, while the MVR100 and MVR200 versions integrate the

remotation technology for DVI and USB 2.0 signals that allows the connection of the IPC within 100 meters with a Cat 5e SF/UTP or CAT6A S/ FTP cable. MV100/MVR100 versions include two USB 2.0 ports on the I/O shield, while MV200/MVR200 versions include three USB 2.0 ports. All versions have two USB 2.0 ports with external access, protected by a rubber cap.

• Highlights

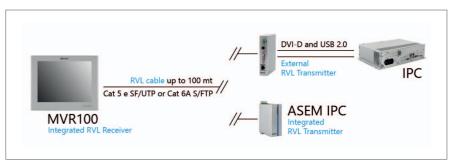
- \rightarrow VESA Mounting Monitor with 0°C÷50°C operating temperature
- → Protection grade IP54
- → 15.6", 18.5" and 21.5" LCDs in Wide aspect ratio
- → Isolated 24 VDC power supply input
- → MVR100/MVR200 versions with remotation of DVI and USB 2.0 signals up to 100m
- → CE, cULus LISTED (61010) certifications

Gallery





Remotation



	MV100/MV200	MV100/MV200 -TFM	MVR100/MVR200	MVR100/MVR200-TFM		
LED backlight TFT LCI		15.6" W - 15.6" W - 18.5" W - 18.5" W - 21.5" W - 1	1366x768 1920x1080 1366x768 1920x1080			
TOUCHSCREEN	Resistive 5 wires	P-CAP multitouch	Resistive 5 wires	P-CAP multitouch		
FRONT PANEL	Aluminium	True Flat Aluminium	Aluminium	True Flat Aluminium		
PROTECTION GRADE IP54			54			
CASE Installati	on	For VESA 100 mounting system				
Mater	ial	Steel sheet metal				
Colo	our	r Anti-scratchable painted - RAL 9006				
REMOTATION	- Remotation of DVI-D and USB 2.0 signals up with Cat 5e SF/UTP cable or Cat 6A S/FTF			USB 2.0 signals up to 100mt ole or Cat 6A S/FTP cable		
VIDEO INPUT		MV100: 1xDVI-D, 1xVGA MV200: 1xDP, 1x DVI-D MV100R/MV200R: 1 x RJ45 (remotation cable)				
REAR ACCESS	MV100: 2 x USB 2.0 (Type A) -	1 x USB 2.0 HUB input, Type B	MV200: 3 x USB 2.0 (Type A) -	1 x USB 2.0 HUB input, Type B		
INTERFACES		MV100R: 2 x USB 2.0 (Type A) • MV200R: 3 x USB 2.0 (Type A)				
EXTERNAL ACCESS INTERFACES		2 x USB 2.0 with protection cap				
POWER SUPPLY INPU	г	24VDC (18÷32	VDC) isolated			
OPERATING TEMPERATURE		0°÷50°C				
APPROVALS		CE, ULus LISTED	(61010) pending			



MK100 / MKR100 Arm Mounting industrial monitors



The arm mounting monitors of the MK100/MKR100 family are made of a Full IP65 cast aluminium chassis, powder coated with anti-scratch treatment, compatible with the most used installation standards. The front button area is available in Hard-Wired or Fieldbus (EtherCAT Slave) versions and it is totally configurable. It allows to install light indicators, buttons, lever switches, keylock switches, encoders,

an emergency stop button and USB, Ethernet or RFID interfaces (described in the "Configurations and Options" section). They are available with 16 million colours LED Backlight TFT LCDs from 15.6" to 24", in Wide aspect ratio with aluminium True flat front panels and 5 wires resistive touchscreen or with aluminium and glass TrueFlat Multitouch front panels and projected capacitive

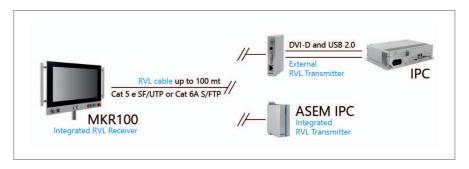
touchscreen. MK100/MKR100 monitors have an isolated 24 VDC power supply input. MK100 versions have a VGA and a DVI-D standard input. MKR100 versions integrate the remotation technology for DVI and USB 2.0 signals that allows the connection of the IPC within 100 meters with a Cat 5e SF/UTP or CAT6A S/FTP cable.

- Highlights
- → Full IP65 chassis
- → Button area with up to 15 Ø22 elements, Hard-Wired or Fieldbus versions (EtherCAT Slave)
- \rightarrow Arm Mounting Monitor with 0°C÷50°C operating temperature
- \rightarrow 15.6", 18.5", 21.5" and 24" LCDs in Wide aspect ratio
- → Isolated 24 VDC power supply input
- → MKR100 version with remotation of DVI and USB 2.0 signals up to 100m
- → CE, ULus LISTED (61010) certifications

Gallery



Remotation



		MK100-TF	MK100-TFM	MKR100-TF	MKR100-TFM	
LED back	light TFT LCD	15.6" W - 1366x768 15.6" W - 1920x1080 18.5"W - 1366x768 18.5"W - 1920x1080 21.5" W- 1920x1080	15.6" W - 1366x768 15.6" W - 1920x1080 18.5"W - 1366x768 18.5"W - 1920x1080 21.5" W - 1920x1080 24" W - 1920x1080	15.6" W - 1366x768 15.6" W - 1920x1080 18.5"W - 1366x768 18.5"W - 1920x1080 21.5" W- 1920x1080	15.6" W - 1366x768 15.6" W - 1920x1080 18.5"W - 1366x768 18.5"W - 1920x1080 21.5" W - 1920x1080 24" W - 1920x1080	
TOUCHS	CREEN	Resistive 5 wires	P-CAP Multitouch	Resistive 5 wires	P-CAP Multitouch	
FRONT P	ANEL	True Flat Aluminium	True Flat Aluminium	True Flat Aluminium	True Flat Aluminium	
PROTECT	ION GRADE		Full	IP65		
CASE	Installation	For VESA 75/100 or for pole / suspension arm mounting. system compatible with RITTAL CP40 / ROLEC TARAPLUS / HASEKE HLT KUPPLUNG 48				
	Material	Aluminium alloy EN AB46400				
	Colour	Anti-scratchable painted - RAL 9006				
	Accessories		Side handles, perimetral handle, keyboard holder kit			
BUTTONS (optional		See "Configurations & Options" section at the end of the brochure			re	
REMOTAT	ION	-		Remotation of DVI-E up to 100mt with Cat 5e SF/U) and USB 2.0 signals TP cable or Cat 6A S/FTP cable	
VIDEO IN	IPUT	1 x VGA 1 x RJ45 (remotation cable) 1 x DVI-D			otation cable)	
USB INPU	JT	2 x USB 2.0 rear (type -A)				
REAL INT ACCESS I	TERNAL NTERFACES	2 x USB 2.0 (Type A)				
POWER S	SUPPLY INPUT		24VDC (18÷32VDC) isolated			
OPERATII		0°C÷50°C				
APPROV	ALS		CE, ULus LIS	STED (61010)		



MK200 / MKR200 [new] **ARM Mounting Industrial Monitor**



The arm mounting monitors of the MK200/MKR200 family are made of a Full IP65 cast aluminium chassis, powder coated with anti-scratch treatment, compatible with the most used installation standards. The front button area is available in Hard-Wired version and it is totally configurable. It allows to install light indicators, buttons, lever

switches, keylock switches, encoders, an emergency stop button and USB, Ethernet or RFID interfaces. MK200/MKR200 monitors are available with the new front panels with minimized frame, in aluminium and glass True Flat Multitouch and projected capacitive touchscreen, with 16 DVI and USB 2.0 signals that million colours LED Backlight TFT LCDs from 15.6" to 24", in IPC within 100 meters with a

Wide aspect ratio. MK200/MKR200 monitors have an isolated 24 VDC power three USB 2.0 ports on the I/O supply input. MK200 versions have a Display Port video input and a DVI-D video input, while MKR100 versions integrate the remotation technology for allows the connection of the

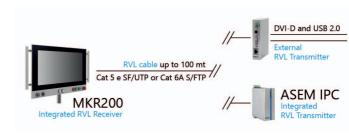
Cat 5e SF/UTP or CAT6A S/FTP cable. Both versions include shield.

- Highlights → Full IP65 chassis
- → Button area with up to 15 Ø22 elements, Hard-Wired
- \rightarrow Arm Mounting Monitor with 0°C÷50°C operating temperature
- → Three USB 2.0 ports on the I/O shield.
- \rightarrow 15.6", 18.5", 21.5" and 24" LCDs in Wide aspect ratio
- → Isolated 24 VDC power supply input
- → MKR200 version with remotation of DVI and USB 2.0 signals up to 100m
- → CE, ULus LISTED (61010) certifications)

Gallery



Remotation



Technical data

		МК200	MKR200-TFM		
LED backlight TFT LCD		15.6" W - 1366x768 15.6" W - 1920x1080 18.5" W - 1366x768			
		18.5" W - 1920x1080			
		21.5" W - 19 24" W - 192			
тоисные	CREEN	P-CAP mu	ltitouch		
FRONT P	ANEL	True Flat Al	uminium		
PROTECT	ION GRADE	Full IF	265		
CASE	Installation	For VESA 75/100 or for pole/suspension arm mounting system compatible with RITTAL CP40/ROLEC TARAPLUS/HASEKE U KUPPLUNG 48			
	Material	Aluminium alloy AN AB46400			
	Colour	Anti-scratchable painted - RAL 9006			
	Accessories	Side handles, perimetral ha	ndle, keyboard holder kit		
BUTTONS (optional)		See "Configurations & Options" se	ction at the end of the brochure		
REMOTAT	TION				
VIDEO IN	IPUT	1 x Display Port 1 x DVI-D	1 x RJ45 (remotation cable)		
USB		2 x USB 2.0 rear (Type-A)			
REAL INT ACCESS II	TERNAL NTERFACES	3 x USB 2.0 rear (Type-A) 1 x USB 2.0 HUB input (Type-B) only MK200			
POWER S	SUPPLY INPUT	24VDC (18÷32VDC) isolated			
OPERATIN TEMPERA		0°C÷50°C			
APPROVA	ALS	CE, ULus LISTED (6	51010) pending		





MX200 / MXR200 [new] Stainless Steel ARM Mounting Industrial Monitor



The arm mounting monitors of the MX200/MXR200 are specifically developed for food & beverage, pharma & chemical applications and they feature a stainless steel (AISI 304I) chassis, 6- hole "VESA 100" mounting with M5 screws. A mechanical adapter is available for arm mounting compatible with Ø 48 mm tubes for TOP and BOTTOM solutions. Monitors have slopping surfaces to sloping surfaces

to avoid dust accumulation, hygienic screws with underhead gasket and blue silicone gaskets.

Protection grade is full IP69K for the version without button area and USB with external access, or Full IP65 for the button area version. The front button area is available in Hard-Wired version and it is customerconfigurable when ordering. It allows to install light indicators, buttons, lever switches,

keylock switches, encoders, an emergency stop button and USB, Ethernet or RFID interfaces.

MX200/MXR200 monitors are available with True Flat stainless steel front panel and 5 wires resistive touchscreen, with 16 million colours LED Backlight TFT LCDs 18" in Wide aspect ratio. MX200/MXR200 monitors have an isolated 24 VDC power supply input. MX200 monitors have a

Display Port video input and a DVI-D video input, while MXR200 versions integrate the remotation technology for DVI and USB 2.0 signals that allows the connection of the IPC within 100 meters with a Cat 5e SF/UTP or CAT6A S/FTP cable.

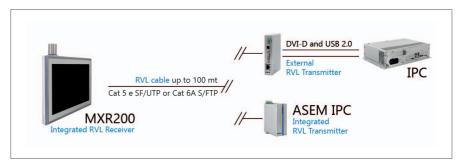
• Highlights

- → Arm Mounting monitor with 0°C÷50°C operating temperature
- → Stainless Steel chassis with Full IP69K protection grade
- → Configurable Hard-wired Button area
- → Three USB 2.0 ports on the I/O shield.
- \rightarrow 18.5" LCDs in Wide aspect ratio
- → Isolated 24 VDC power supply input
- → MXR200 version with remotation of DVI and USB 2.0 signals up to 100m
- → CE, ULus LISTED (61010) certifications

Gallery



Remotation



Technical data

	MX200-TFX	MXR200-TFX		
LED backlight TFT LCD	18.5" W - 1366x768 18.5" W - 1920x1080"			
TOUCHSCREEN	Resistive 5 wires			
FRONT PANEL	True Flat Stair	nless Steel		
PROTECTION GRADE	Full IP69K (without button Full IP67 (without button Full IP65 (with	area, with 2 x USB 3.0)		
CASE Installation	With customised ASEM 10x10 attachment w	vith 6M5 screws in stainless steel AISI 304		
Material	Stainless Stee	el AISI 304L		
materia				
BUTTONS AREA (optional)	See "Configurations & Options" section at the end of the brochure			
REMOTATION	-	Remotation of DVI-D and USB 2.0 signals up to 100mt with Cat 5e SF/UTP cable or Cat 6A S/FTP cable		
VIDEO INPUT	1 x DVI-D 1x Display Port 1 x RJ45 (remotation cable)			
USB	3 x USB 2.0, internal, rear (Type-A)			
	only MX200: 1x USB 2.0 HUB input rear, Type B			
POWER SUPPLY INPUT	24VDC (18÷36VDC) isolated			
REAL EXTERNAL ACCESS	2 x USB 2.0 with protection cap			
OPERATING TEMPERATURE	0°C÷50°C			
APPROVALS	CE, ULus LIST	ED (61010)		



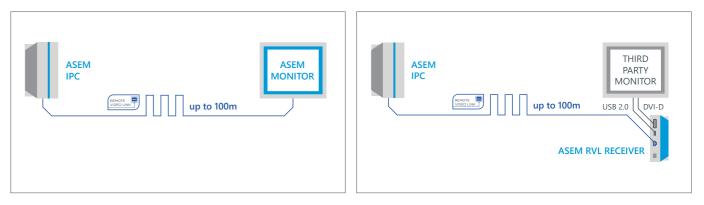
Video remotation solutions

Configurations & Options

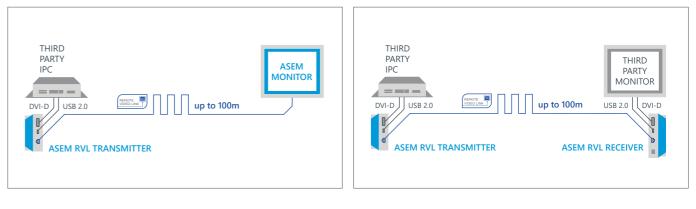
Remote Video Link (RVL) is the ASEM solution for the remotation of DVI-D and **USB** signals

The solution is composed by the RVL Receiver, the RVL Transmitter and a simple Cat. 6A S/FTP or Cat. 5e SF/UTP Ethernet cable and allows to connect a monitor up

Integrated Receiver and Transmitter



Integrated Receiver and external Transmitter External Receiver and Transmitter



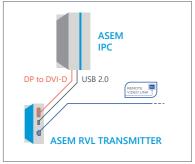
To connect IPCs with a dual mode Display Port to the DVI-D input of the external transmitter, an adapter cable is available as an option.



to 100 meters far from the IPC. The RVL Receivers and Transmitters are integrated in several ASEM Industrial PCs and monitors or can be supplied as external modules

to create long distance connections between PCs and monitors manufactured by ASEM or by other suppliers.

External Receiver and integrated Transmitter



Fieldbuses boards

NETcore[®] X

NETcore[®]X fieldbus boards are the link between the IPC and the I/O devices on field and enable control and visualization applications to receive data from the field according to the industrial fieldbuses available.

To be integrated on all ASEM systems, different formats are available, according to the systems they are addressed to.

Wireless modules



Wifi and mobile modules

Wireless modules allow ASEM systems to be accessible from a remote position, without a cable connection. According to specific needs, Wi-Fi adaptersfor local connection and/or 2G/3G/4G-LTE modems (for internet connection in covered areas) can be used.









NETcore[®] X Industrial Ethernet

NETcore[®] X Profibus

NETcore[®] X CANopen

Dual CAN-RAW

Board	Protocols	HT/QT/PB/BM	VK3200	PCI/APCI	MiniPCI / MiniAPCI
NETcore X PROFIBUS	Profibus DP Master/Slave, MPI	✓	\checkmark	\checkmark	✓
NETcore X CANopen	CANopen Master/Slave	✓	\checkmark	√	√
NETcore X Industrial Ethernet	EtherCAT Master/Slave	✓	-	\checkmark	\checkmark
	PROFINET IO Controller/Device	✓	\checkmark	\checkmark	√
	Ethernet/IP Scanner/Adapter	✓	\checkmark	\checkmark	✓
CAN RAW	CANopen Master in combination with CODESYS (2 x isolated channels also with 512kB NVRAM)	-	-	\checkmark	\checkmark
NVRAM	512kB static RAM for SoftPLC	-	-	-	\checkmark
ETHERNET	EtherCAT Master in combination with CODESYS	-	-	\checkmark	\checkmark

NETcore[®]X and proprietary application

A DLL library is available for developing applications under with CODESYS is automatic Win32 or WinCE operating systems. All DLL programming code to implement the languages such as C, C++ or .NET are available.

NETcore[®]X with CODESYS

Using NETcore[®]X fieldbus boards, the integration and does not require any communication stack.

NETcore®X with

PremiumHMI Premium HMI uses NETcore®X boards with SIEMENS MPI and PROFIBUS Slave protocols, using a dedicated communication driver.





WiFi / Bluetooth adapter and 2G/3G/4G modem

Carrier for RT40

		Panel ARM based IPCs	Panel IPCs / Box IPCs	Arm Mounting IPCs	
WI-FI +	Standard	IEEE 802.11 b/g/n IEEE 802.11 a/b/g/n + Bluetooth		th V4.0 LE/ V3.0+HS/ V2.1+EDR	
BLUETOOTH Features		Client mode	Client / Access point mode (Wi-Fi)		
	Security	WEP, TKIP, AES, WPA and WPA2	64/128-Abits WEP, WPA, WPA2 (Wi-Fi)		
	Rx Sensitivity	802.11b -80dBm@8%, 802.11g -70dBm@10%, 802.11n -64dBm@10%	-69dBm@HT40 / 802.11n(5GHz): -69	n / 802.11n(2,4GHz): -72dBm@HT20, 9dBm@HT20, -68dBm@HT40 (Wi-Fi) 9dBm (Bluetooth)	
	Antenna	1 x RP-SMA-F 2 x RP-SMA-F		-SMA-F	
			CAT4 Multiband / 150Mbps download	-	
	Antenna	1 x SMA-F	connector	-	
	SIM	1x SIM card socke	1x SIM card socket push-push type		
SUPPORTED O.S.		Windows CE Linux Yocto (2.2.1)	Microsoft V	Windows 7 Vindows 8.1 Vindows 10	



Several formats are available, according to the systems that will include the device/s.



Carrier for HT Series



Carrier per VK

UPS INTEGRATED in IPCs

ASEM has developed an integrated UPS (Uninterruptible Power Supply) system for its **IPCs to prevent sudden** shutdowns, resulting in data loss or damage, following an unexpected loss of the primary power supply.

by the ASEM R&D team and includes:

 \rightarrow A hardware section capable of switching in negligible time (in the order of microseconds) the power source from the primary voltage to the battery and vice versa; \rightarrow A configurable hardware

section to monitor the battery status and manage the charge and discharge phases;

 \rightarrow A microcontroller-based control section that manages the system states and it interfaces with the PC; → A high-level, Windowsbased, user-configurable software section that diagnoses system and battery pack status and it manages shutdown. The architecture is common to all systems and it is

customised by configuring specific parameters according to the type of use and consumption to optimise battery life.

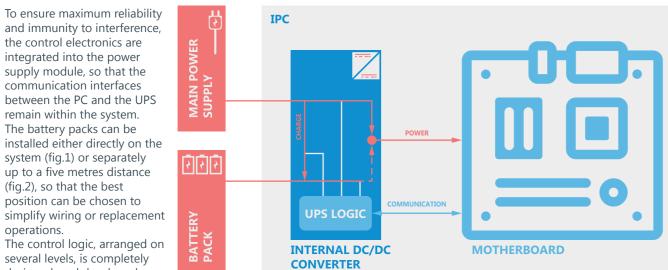


Software

The operation of UPS systems is managed by high-level software, developed for the Windows environment, divided into two parts: \rightarrow a service responsible for monitoring supply voltage and the battery status and managing a possible shutdown;

• Highlights

and immunity to interference, the control electronics are integrated into the power supply module, so that the communication interfaces between the PC and the UPS remain within the system. The battery packs can be installed either directly on the system (fig.1) or separately up to a five metres distance (fig.2), so that the best position can be chosen to simplify wiring or replacement operations. The control logic, arranged on several levels, is completely designed, and developed





Lead-acid batteries

Lead-acid cell battery packs, compared to more modern technologies, have significant size and dimensions, but they are able to provide high peak currents and can operate in a wide temperature range (far beyond the 0 - 50 °C

guaranteed for the systems). ASEM battery packs consist of 6 elements for a nominal voltage of 12 V and they can provide a maximum of 100 W for approximately 2 minutes. They also incorporate a temperature sensor and a protection circuit that

Nickel metal hydride batteries

Battery packs with Ni-MH cells are characterised by their smaller size compared to lead-acid batteries and by lower self-discharge during storage.

ASEM battery packs consist of 10 cells with a nominal voltage of 12 V and can provide a maximum of 60 W for approximately 10 minutes. They also integrate a temperature sensor, a protection circuit that



 \rightarrow a graphic application usable to configure the behaviour in the event of a primary voltage failure and to check the diagnostics.

In addition, to preserve the battery from abnormal degradation and to avoid sudden shutdowns, if a voltage lower than the

minimum is measured during

the discharge phase, a regular system shutdown is commanded regardless of the parameters set.

→ Configurable switch-off range from 10 seconds to 10 minutes

- → Information about remaining autonomy calculated on real system consumption
- → Real-time battery status diagnostics
- → Log functions with data historicization
- → Integration with user application

interrupts the connection if the current is too high or the voltage too low.



interrupts the connection if the current is too high or the voltage too low, and a switch to disconnect the battery during transport.



Front panels

True Flat technology

ASEM realizes the True Flat front panel through a special manufacturing process which takes place in a clean room to avoid environmental contamination such as dust or attached on the Aluminium airborne microbes.

In this process, using an Optically Clear Adhesive (OCA) a thin polyester film is glued on the touchscreen, then the two components are front panel.







Stainless Steel True Flat Front Panel

Steel True Flat front panels without USB port on the front are particularly used in pharmaceutical and food & beverage industries.

Panel IPCs with Stainless







Glass Multitouch technology

All Panel IPC and monitor families are available with the new generation of Multitouch front panels in 7", 10.1", 12.1", 15.6", 18.5", 21.5" and 24" screen sizes with Wide aspect surface in a completely ratio.

Glass projected Capacitive Touchscreen Technology allows mobile gestures such as zoom, swipe and rotate (even with work gloves), now

increasingly adopted in the factory automation. Multitouch front panels are made of a robust aluminium frame and a tempered glass true-flat design that gives maximum resistance to environmental influences and facilitates cleaning.



IP69K stainless steel front panel

The new stainless-steel front panels with an IP69K protection degree are specifically developed for food & beverage, pharma & chemical applications. They

are equipped with hygienic silicone gaskets and the strudy front film is specially designed to withstand water washing with high-pressure.









Configurable button area for Arm Mounting IPCs and Monitors

The button area of the VK3200 and MK100/ MKR100 Arm Mounting systems is totally configurable at the order, depending on customer's requirements, and allows front access for further modifications and/or integrations.

Connections

The single elements of the button area can be connected in two ways: hard wired or via fieldbus.

Hard wiring

With the hard wired connection it is possible to install up to eight elements (excluding the USB, Ethernet and RFID interfaces), whose wiring is brought to two clamps, accessible from the back.

Fieldbus button area

The implemented fieldbus standard is EtherCAT. The quantity of elements that is possible to install on the systems with fieldbus button area depends on the display size: up to 9 with the 15.6" LCD, up to 11 with the 18,5" LCD, up to 13 with the 21,5" LCD and up to 15 with the 24" LCD, including USB, Ethernet, RFID interfaces and the emergency stop button.



Front access to the wiring of the button area



The button area of the MX monitor is totally configurable at the order, depending on customer's requirements and allows front access for further modifications and/or integrations.

Connections

The single elements of the button area can be connected in hard wired version and it is possible to install led indicators, push buttons, keylock switch and levers and an emergency stop button.



Wiew of the rear clamps of a hard wired button area

View of the rear connectors of a Fieldbus button area

Elements for VK and MK/MKR

A wide range of elements is available to compose the button area of the Arm Mounting systems.

LED indicators \rightarrow LED lit (5 colours available)

Push buttons

→ unlit \rightarrow LED lit (5 colours available) \rightarrow with custom exchangeable symbol

 \rightarrow for ATX mode power up

Emergency stop button \rightarrow with rotating unlock movement → double contact

Keylock switch and levers \rightarrow with key

→ keyless LED lit \rightarrow with 2 or 3 positions

Buzzer

Incremental Encoder



- → Ethernet port
- **RFID** On Ø 22 element → LF (125 kHz) → HF (13,56 MHz)



Elements for MX/MXR

Button area customer-configurable

Ø22 elements

LED indicators

→ 5 colours available (red, yellow, green, blue, white)

Keylock switch and levers

 \rightarrow with key → keyless LED lit \rightarrow with 2 or 3 positions, with or without restraint

Push buttons

→ Unlit → LED lit (5 colours available:

red, yellow, green, blue, white)

Ø 30 stainless steel, low profile

LED indicators → 5 colours available (red, yellow, green, blue, white))

Keylock switch and levers

 \rightarrow with key → keyless LED lit \rightarrow with 2 or 3 positions, with or without restraint

Push buttons

→ Unlit LED lit (5 colours available: red, yellow, green, blue, white)

Emergency stop button

→ Stainless steel head \rightarrow with rotating unlock movement





Button area MX family







Mechanical accessories for VK and MK systems

Side handles

Kit composed of two aluminium side handles is available for simplifying system moving.





Perimetral handle

A perimetral handle to simplify system movements and protect the operator from accidental impacts.





Keyboard holder kit

Keyboard holder kit, including a cable hole on the rear cover, with a rubber wire holder.





Arm mounting



Top arm mounting

VK and MK/MKR families

The Arm Mounting chassis is compatible with the most common installation standards, such as RITTAL CP40, ROLEC TARAPLUS, HASEKE ULT KUPPLUNG 48.

MX/MXR200 families

MX200 and MXR200 have a M5 six screws coupling arranged in a 100x100mm square. Optionally, a specific coupling is supplied, compatible with 48mm round support arm and suitable for top or bottom mouting.

VESA Standard

MV/MVR Families

MV/MVR chassis provide for VESA 100 standard

VK and MK/MKR Families

VK IPCs and MK/MKR Industrial Monitors provide for a chassis with VESA 100/75 coupling



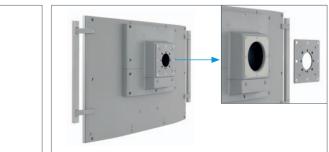
VESA 100 on MV/MVR





Bottom arm mouting





VESA 75 / VESA 100 on VK and MK/MKR



Technical support & Services

Technical support and service

Customer oriented philosophy

Providing a meticulous attention and a complete pre and post sales service is the foundational concept of our costumer oriented service. All internal processes aim to ensure an excellent

product quality and a higher degree of flexibility, in order to be responsive to the everchanging market needs. To ensure product and process quality, ASEM has adopted the standard UNI EN ISO 9001:2008 for its quality management system.

Customer care

The customer care service is led by a team of technical specialists that answer with immediacy and clarity to customers' needs, not only by telephone and via the Internet, but also with on-site visits and technical training courses. To optimize the process of support and repair of systems and to minimize response time, ASEM offers some effective services:

"HELP DESK PHONE"

SERVICE can be accessed calling +39/0432/967250, from Monday to Friday from 09:00 to 12:30 and from 14:00 to 17:30 A qualified technician This easy and quick tool provides initial assistance, or starts the procedure for repairing or replacing the product (Return Material Authorization). Based on needs and the type of support services, you can send required, the call may be turned to the most suitable ASEM specialist.

Technical support

ASEM offers an excellent service of hardware and software consulting and assistance. It also includes a prompt and efficient system service assistance with the creation of ad-hoc operating system images, which allows to shrink the memory space needed for the installation of the operating systems (Microsoft Windows[®] CE,

Windows® XP and Windows® XP Embedded, Windows® 7, Windows[®] 7 Embedded, Microsoft Windows, Windows 8.1, Windows 10 2016, Windows 10 IoT Enterprise 2016, Linux and OS real time) maintaining only the necessary components for the proper functioning of the industrial PCs and the integration with the main applicative software.



"HELP DESK ONLINE" SERVICE allows access to the ASEM customer care service directly online, through the company website www.asem.it. allows to request technical assistance for any repair service, with real-time monitoring of the request status. In addition to these any request for hardware, firmware and software support to the e-mail address suptec@asem.it.



æ A5E ™•	€ <mark>A5EM•</mark>



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